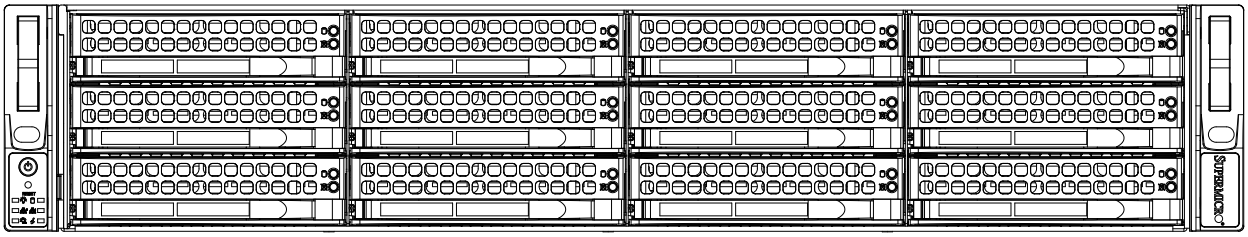
SuperStorage
6029P-E1CR16T



USER'S MANUAL

Revision 1.0d

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Manual Revision 1.0d

Release Date: December 13, 2019

Preface

About this Manual

This manual is written for professional system integrators and PC technicians. It provides information for the installation and use of the SuperStorage 6029P-E1CR16T. Installation and maintenance should be performed by experienced technicians only.

Please refer to the 6029P-E1CR16T specifications page on our website for updates on supported memory, processors and operating systems (http://www.supermicro.com).

Notes

For your system to work properly, please follow the links below to download all necessary drivers/utilities and the user's manual for your server.

- Supermicro product manuals: http://www.supermicro.com/support/manuals/
- Product drivers and utilities: http://www.supermicro.com
- Product safety info: http://www.supermicro.com/about/policies/safety_information.cfm

If you have any questions, please contact our support team at:
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Warnings

Special attention should be given to the following symbols used in this manual.

Warning! Indicates important information given to prevent equipment/property damage or personal injury.

Warning! Indicates high voltage may be encountered when performing a procedure.

Contents

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Chapter 1

Introduction

1.1 Overview

This chapter provides a brief outline of the functions and features of the 6029P-E1CR16T. The 6029P-E1CR16T is based on the X11DPH-T motherboard and the SC829HE1C4-R1K62LPB chassis.

In addition to the motherboard and chassis, several important parts that are included with the system are listed below.

Main Parts List		
Description	**Part Number**	**Quantity**
Black hot-swap 3.5" HDD trays	MCP-220-00075-0B	12
Air shroud	MCP-310-82901-0B	1
80x80x38-mm, 10.5K RPM middle fans	FAN-0158L4	4
81-cm 30AWG SATA S-S cable	CBL-0481L	2
81-cm,28AWG SGPIO,2X4F TO 2X4F, P2.54 round cable	CBL-CDAT-0841	1
Internal Mini-SAS HD to Mini-SAS HD 50cm,30AWG,12Gb/S cable	CBL-SAST-0532	2
2-Port 12Gbps backplane for 2x2.5" SAS/SATA HDD/SSD	BPN-SAS3-826TQ-B2B	1
12-Port 2U backplane with expander support up to 8 x 3.5	BPN-SAS3-826EL1-N4	1
4-Port 12Gbps backplane for 4x3.5" Internal SAS3/SATA3 HDD/SSD	BPN-SAS3-829HA-A4	1
1U proprietary 96-mm wide passive CPU heatsink platform equipped with a narrow retention mechanism	SNK-P0067PSWB	1
2U passive CPU heatsink equipped with a narrow retention mechanism	SNK-P0068PS	1
Standard I/O shield for X9 socket R server motherboard with gasket.	MCP-260-00042-0N	1
Add-on card	AOC-S3108L-H8IR-16DD-P	1
Rail set	MCP-290-00053-0N-01	1

1.2 Unpacking the System

Inspect the box the SuperServer 6029P-E1CR16T was shipped in and note if it was damaged in any way. If any equipment appears damaged, please file a damage claim with the carrier who delivered it.

Decide on a suitable location for the rack unit that will hold the server. It should be situated in a clean, dust-free area that is well ventilated. Avoid areas where heat, electrical noise and electromagnetic fields are generated. It will also require a grounded AC power outlet nearby. Be sure to read the precautions and considerations noted in Appendix B.

1.3 System Features

The following table provides you with an overview of the main features of the 6029P-E1CR16T. Please refer to Appendix C for additional specifications.

System Features
Motherboard
X11DPH-T
Chassis
SC829HE1C4-R1K62LPB
CPU
Dual Intel® Xeon® 81xx/61xx/51xx/41xx/31xx and 82xx/62xx/52xx/42xx/32xx series processors *
Socket Type
Socket P
Memory
Sixteen DIMM slots support up to 4 TB of Registered DIMM (RDIMM), Load Reduced DIMM (LRDIMM), 3D LRDIMM or Non-Volatile DIMM (NV-DIMM) DDR4 2933/2666 Mhz speed ECC memory. Up to 2 TB Intel Optane DC Persistent Memory in memory mode (Cascade Lake only).
Chipset
Intel C622 chipset
Expansion Slots
Four PCI-Express 3.0 x8 slots supported by CPU1 (Slots 1, 3, 6, 7) Three PCI-Express 3.0 x16 slots supported by CPU2 (Slots 2, 4, 5)
Hard Drives
16 hot-swap 3.5" hard drives
Power
Two redundant 1600 Watt power supplies (PWS-1K62A-1R)
Form Factor
2U rackmount
Dimensions
(WxHxD) 17.2 x 3.5 x 25.5 in. (437 x 89 x 647-mm)

1.4 Server Chassis Features

Control Panel

The switches and LEDs located on the control panel are described below. See Chapter 4 for details on the control panel connections.

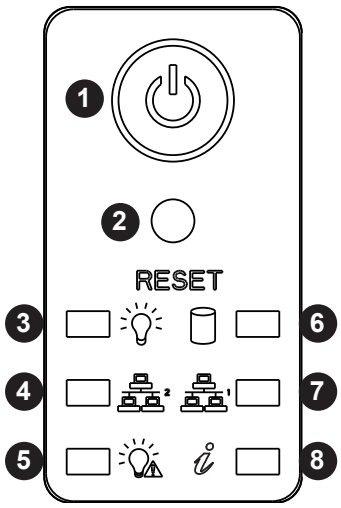


Figure 1-1. Control Panel View

Control Panel Features		
Item	**Feature**	**Description**
1	Power Button	The power button is used to apply or remove power to the server. Turning off system power with this button removes the main power but maintains standby power. To perform many maintenance tasks, you must also unplug system before servicing
2	Reset Button	Used to reboot the system.
3	Power LED	Indicates power is being supplied to the system power supply. This LED should normally be illuminated when the system is operating.
4	NIC2	Indicates network activity on LAN port 2 when flashing
5	Power Fail LED	Indicates a power supply module has failed. The second power supply module will take the load and keep the system running but the failed module will need to be replaced. Refer to Chapter 6 for details on replacing the power supply. This LED should be off when the system is operating normally.
6	NIC2	Indicates network activity on LAN port 2 when flashing
7	NIC1	Indicates network activity on LAN port 1 when flashing
8	Information LED	See the table below for the status shown by this LED.

Information LED	
Status	**Description**
Continuously on and red	An overheat condition has occurred. (This may be caused by cable congestion.)
Blinking red (1 Hz)	Fan failure: check for an inoperative fan.
Blinking red (0.25 Hz)	Power failure: check for an inoperative power supply.
Solid blue	UID has been activated locally to locate the server in a rack environment.
Blinking blue (300 msec)	UID has been activated using IPMI to locate the server in a rack environment.

Front Features

The SC829HE1C4-R1K62LPB is a 2U chassis See the illustration below for the features included on the front of the chassis.

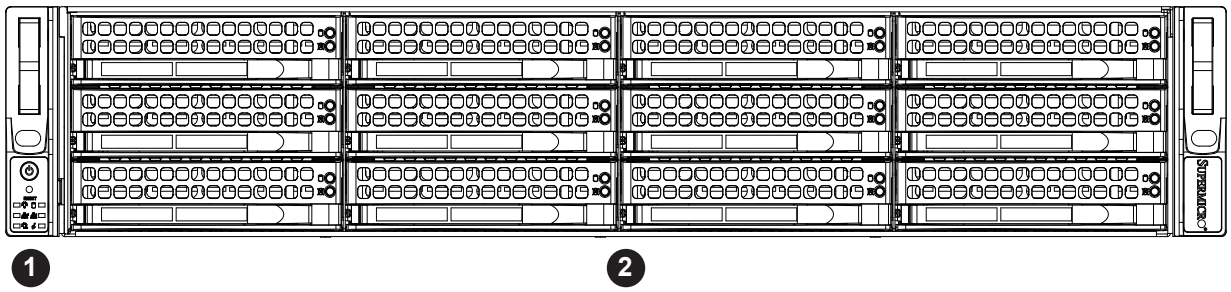


Figure 1-2. Chassis Front View

Front Chassis Features		
Item	**Feature**	**Description**
1	Control Panel	Control panel (see previous page for details)
2	Hard Drive Carriers (12)	Up to twelve drive bays for hot-swap hard drives in drive carriers are available.

Rear Features

The illustration below shows the features included on the rear of the chassis.

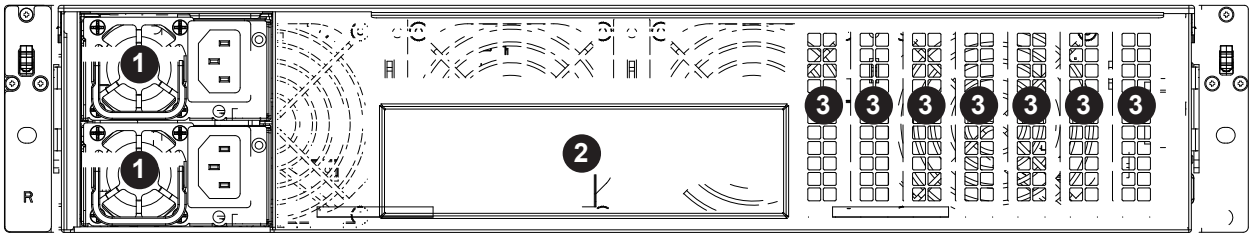


Figure 1-3. Chassis Rear View

Rear Chassis Features		
Item	**Feature**	**Description**
1	Power Supply Module	1600W power supply (redundant, with two power modules)
2	I/O Ports	I/O ports (see Section 4.3 for details)
3	PCI Slots (7)	Seven low-profile PCI slots are available for add-on cards

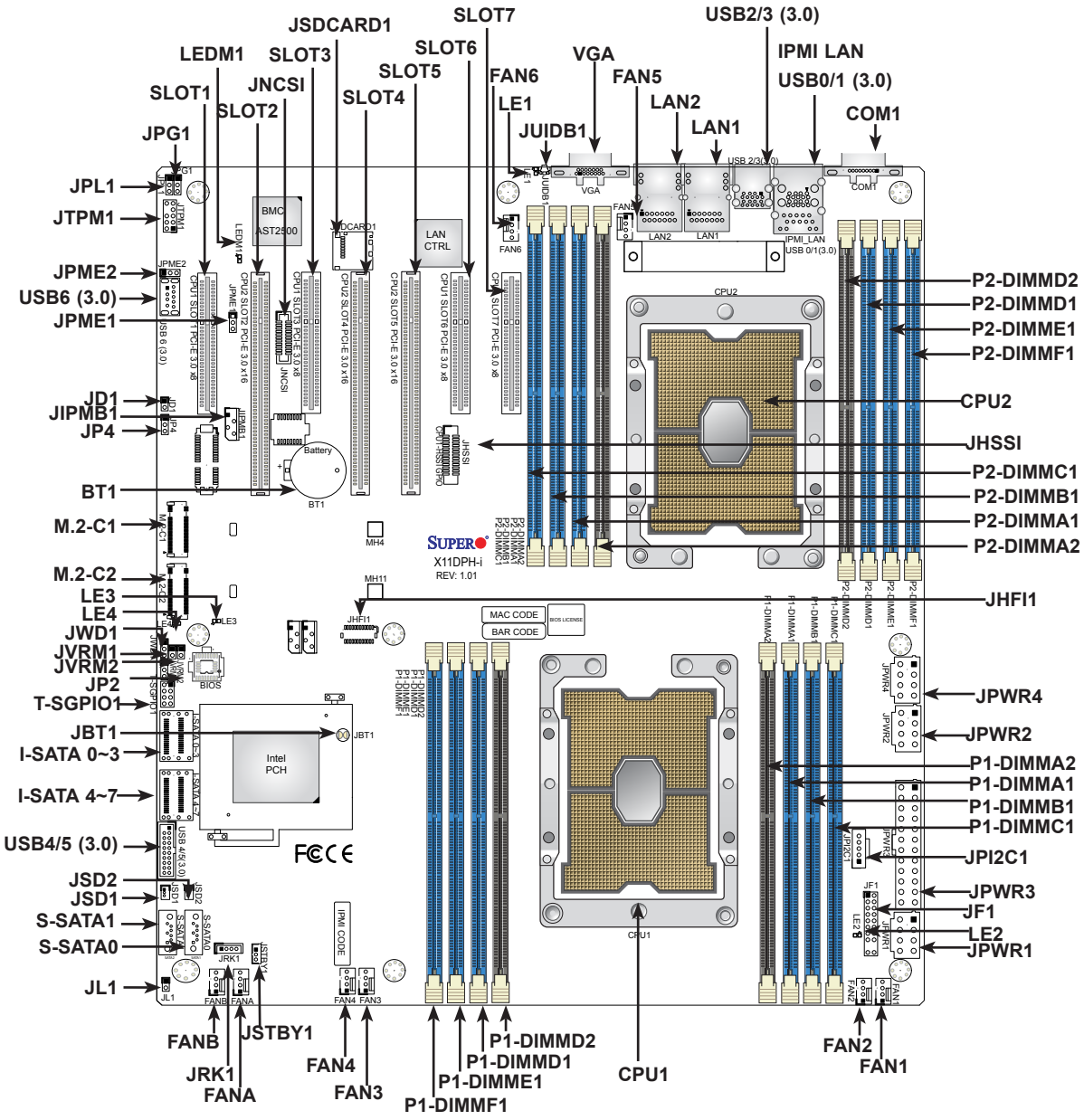


Figure 1-4. Motherboard Layout

Notes:

- Components not documented are for internal testing only.
- "▪" indicates the location of pin 1.

Quick Reference Table

Jumper	Description	Default Setting
JBT1	CMOS Clear	Open (Normal)
JPG1	VGA Enable	Pins 1-2 (Enabled)
JPL1	LAN1/LAN2 Enable	Pins 1-2 (Enabled)
JPME1	ME Recovery	Pins 1-2 (Normal)
JPME2	ME Manufacturing Mode	Pins 1-2 (Normal)
JVRM1	VRM SMB Clock (to BMC or PCH)	Closed (Normal: SMB Clock to BMC)
JVRM2	VRM SMB Data (to BMC or PCH)	Closed (Normal: SMB Clock to BMC)
JWD1	Watch Dog Timer Enable	Pins 1-2 (Reset)

Connector	Description
BT1	Onboard CMOS battery
COM1	COM port
FAN1~6, FANA/FANB	System/cooling fan headers
IPMI_LAN	Dedicated IPMI LAN port
I-SATA0~3, I-SATA4~7	SATA 3.0 Ports supported by the Intel PCH
JD1	Speaker header
JF1	Front control panel header
JHFI1	Host Fabric Interface (HFI) sideband connection header used for HFI carrier card
JHSSI	High-Speed Serial Interface (HSSI) card header
JIPMB1	4-pin external I^2C Header (for an IPMI card)
JL1	Chassis intrusion header
JNCSI	Network Controller Sideband Interface (NCSI) header
JPI^{2}C1	Power I^2C System Management Bus (SMBus) header
JPWR1, JPWR2, JPWR4	8-pin power supply connectors
JPWR3	24-pin ATX main power supply connector
JRK1	Intel RAID key for NVMe SSD
JSD1, JSD2	SATA DOM (Device-on-Module) power connectors
JSDCARD1	Micro SD card slot
JSTBY1	Standby power header
JTPM1	Trusted Platform Module (TPM)/Port 80 connector
JUIDB1	Unit Identifier (UID) switch
LAN1, LAN2	10GbE LAN ports
M.2-C1, M.2-C2	M.2 slots
MH4, MH11	M.2 mounting holes
(CPU1) SLOT1, SLOT3, SLOT6, SLOT7	PCI-Express 3.0 x8 slots supported by CPU1

Connector	Description
(CPU2) SLOT2, SLOT4, SLOT5	PCI-Express 3.0 x16 slots supported by CPU2
S-SATA0, S-SATA1	Powered SATA 3.0 ports with support of Supermicro SuperDOM (Disk-On-Module)
T-SGPIO1	Serial Link General Purpose I/O (SGPIO) port
USB0/1, USB2/3	Universal Serial Bus (USB) 3.0 ports
USB4/5	Internal USB 3.0 header for front access
USB6	Type A USB 3.0 header for front access
VGA	VGA port

LED	Description	Status
LE1	Unit Identifier (UID) LED	Solid Blue: Unit Identified
LE2	Onboard power LED	Solid Green: Power On
LEDM1	BMC Heartbeat LED	Blinking Green: BMC normal

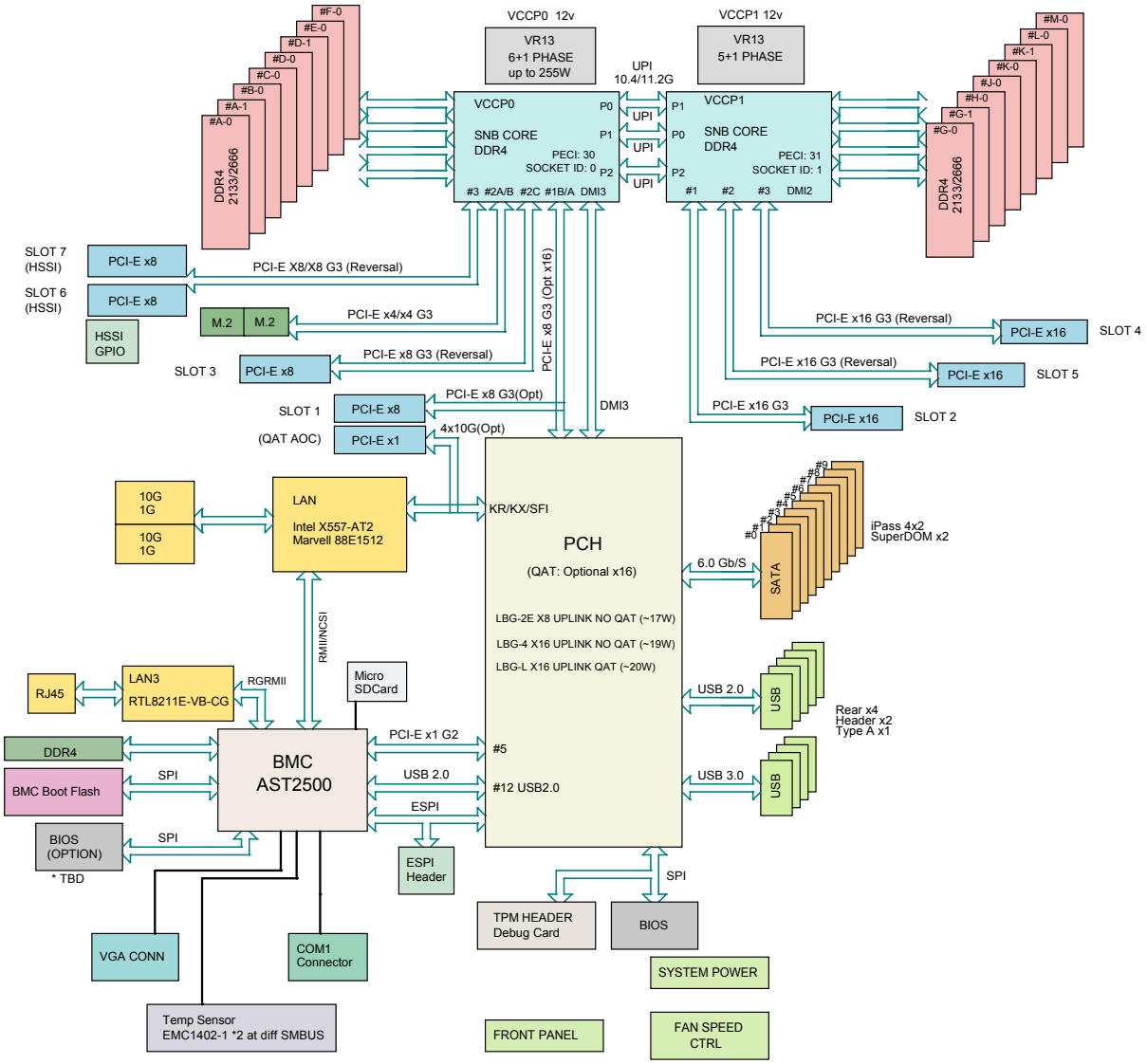


Figure 1-5. Intel C622 Chipset: System Block Diagram

Note: This is a general block diagram and may not exactly represent the features on your motherboard. See the System Specifications appendix for the actual specifications of your motherboard.

Chapter 2

Server Installation

2.1 Overview

This chapter provides advice and instructions for mounting your system in a server rack. If your system is not already fully integrated with processors, system memory etc., refer to Chapter 4 for details on installing those specific components.

Caution: Electrostatic Discharge (ESD) can damage electronic components. To prevent such damage to PCBs (printed circuit boards), it is important to use a grounded wrist strap, handle all PCBs by their edges and keep them in anti-static bags when not in use.

2.2 Preparing for Setup

The box in which the system was shipped includes the rackmount hardware needed to install it into the rack. Please read this section in its entirety before you begin the installation.

Choosing a Setup Location

- The system should be situated in a clean, dust-free area that is well ventilated. Avoid areas where heat, electrical noise and electromagnetic fields are generated.
- Leave enough clearance in front of the rack so that you can open the front door completely (~25 inches) and approximately 30 inches of clearance in the back of the rack to allow sufficient space for airflow and access when servicing.
- This product should be installed only in a Restricted Access Location (dedicated equipment rooms, service closets, etc.).
- This product is not suitable for use with visual display workplace devices according to §2 of the German Ordinance for Work with Visual Display Units.

Rack Precautions

- Ensure that the leveling jacks on the bottom of the rack are extended to the floor so that the full weight of the rack rests on them.
- In single rack installations, stabilizers should be attached to the rack. In multiple rack installations, the racks should be coupled together.

- Always make sure the rack is stable before extending a server or other component from the rack.
- You should extend only one server or component at a time - extending two or more simultaneously may cause the rack to become unstable.

Server Precautions

- Review the electrical and general safety precautions in Appendix B.
- Determine the placement of each component in the rack *before* you install the rails.
- Install the heaviest server components at the bottom of the rack first and then work your way up.
- Use a regulating uninterruptible power supply (UPS) to protect the server from power surges and voltage spikes and to keep your system operating in case of a power failure.
- Allow any drives and power supply modules to cool before touching them.
- When not servicing, always keep the front door of the rack and all covers/panels on the servers closed to maintain proper cooling.

Rack Mounting Considerations

Ambient Operating Temperature

If installed in a closed or multi-unit rack assembly, the ambient operating temperature of the rack environment may be greater than the room's ambient temperature. Therefore, consideration should be given to installing the equipment in an environment compatible with the manufacturer’s maximum rated ambient temperature (TMRA).

Airflow

Equipment should be mounted into a rack so that the amount of airflow required for safe operation is not compromised.

Mechanical Loading

Equipment should be mounted into a rack so that a hazardous condition does not arise due to uneven mechanical loading.

Circuit Overloading

Consideration should be given to the connection of the equipment to the power supply circuitry and the effect that any possible overloading of circuits might have on overcurrent protection and power supply wiring. Appropriate consideration of equipment nameplate ratings should be used when addressing this concern.

Reliable Ground

A reliable ground must be maintained at all times. To ensure this, the rack itself should be grounded. Particular attention should be given to power supply connections other than the direct connections to the branch circuit (i.e. the use of power strips, etc.).

To prevent bodily injury when mounting or servicing this unit in a rack, you must take special precautions to ensure that the system remains stable. The following guidelines are provided to ensure your safety:

- This unit should be mounted at the bottom of the rack if it is the only unit in the rack.
- When mounting this unit in a partially filled rack, load the rack from the bottom to the top with the heaviest component at the bottom of the rack.
- If the rack is provided with stabilizing devices, install the stabilizers before mounting or servicing the unit in the rack.

2.3 Installing the Rails

There are a variety of rack units on the market, which may require a slightly different assembly procedure.

The following is a basic guideline for installing the system into a rack with the rack mounting hardware provided. You should also refer to the installation instructions that came with the specific rack you are using.

Identifying the Rails

The chassis package includes two rail assemblies in the rack mounting kit. Each assembly consists of three sections: An inner chassis rail which secures directly to the chassis, an outer rail that secures to the rack, and a middle rail which extends from the outer rail. These assemblies are specifically designed for the left and right side of the chassis.

Locking Tabs

Each inner rail has a locking tab. This tab locks the chassis into place when installed and pushed fully into the rack. These tabs also lock the chassis in place when fully extended from the rack. This prevents the server from coming completely out of the rack when when the chassis is pulled out for servicing.

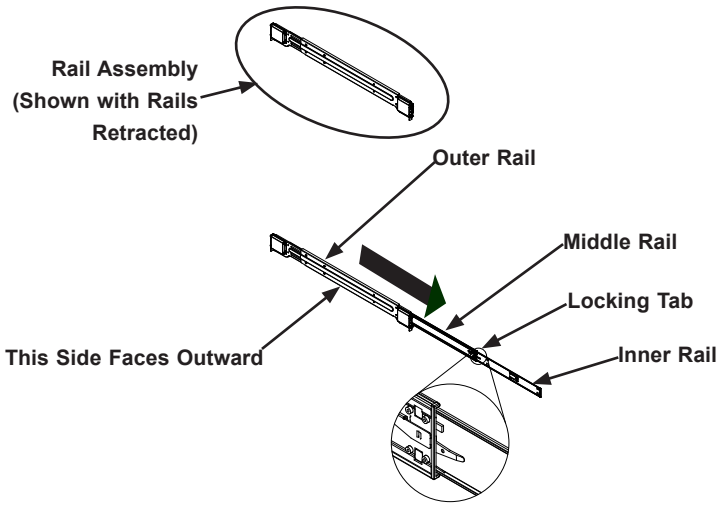


Figure 2-1. Identifying the Rail Sections

Slide rail mounted equipment is not to be used as a shelf or a work space.

Warning: do not pick up the server with the front handles. They are designed to pull the system from a rack only.

Releasing the Inner Rail

Each inner rail has a locking latch. This latch prevents the server from coming completely out of the rack when when the chassis is pulled out for servicing.

To mount the rail onto the chassis, first release the inner rail from the outer rails.

Releasing Inner Rail from the Outer Rails

1. Pull the inner rail out of the outer rail until it is fully extended as illustrated below.
2. Press the locking tab down to release the inner rail.
3. Pull the inner rail all the way out.
4. Repeat for the other outer rail.

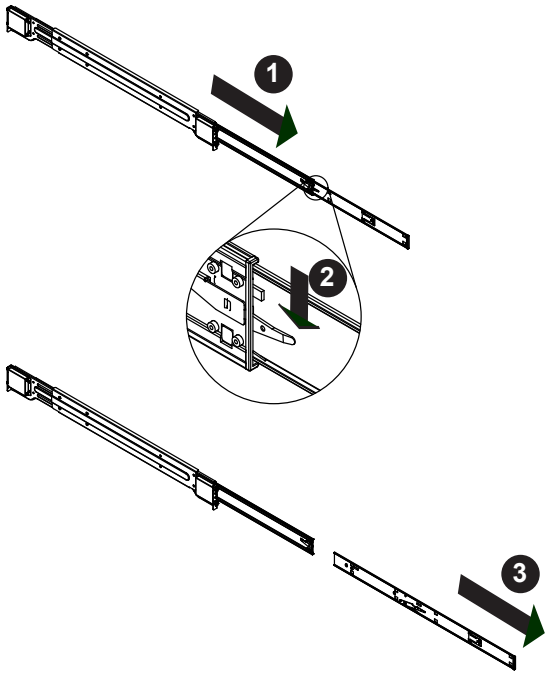


Figure 2-2. Extending and Releasing the Inner Rail

Installing the Inner Rails on the Chassis

Installing the Inner Rails

1. Identify the left and right inner rails. They are labeled.
2. Place the inner rail firmly against the side of the chassis, aligning the hooks on the side of the chassis with the holes in the inner rail.
3. Slide the inner rail forward toward the front of the chassis until the quick release bracket snaps into place, securing the rail to the chassis.
4. Optionally, you can further secure the inner rail to the chassis with a screw.
5. Repeat for the other inner rail.

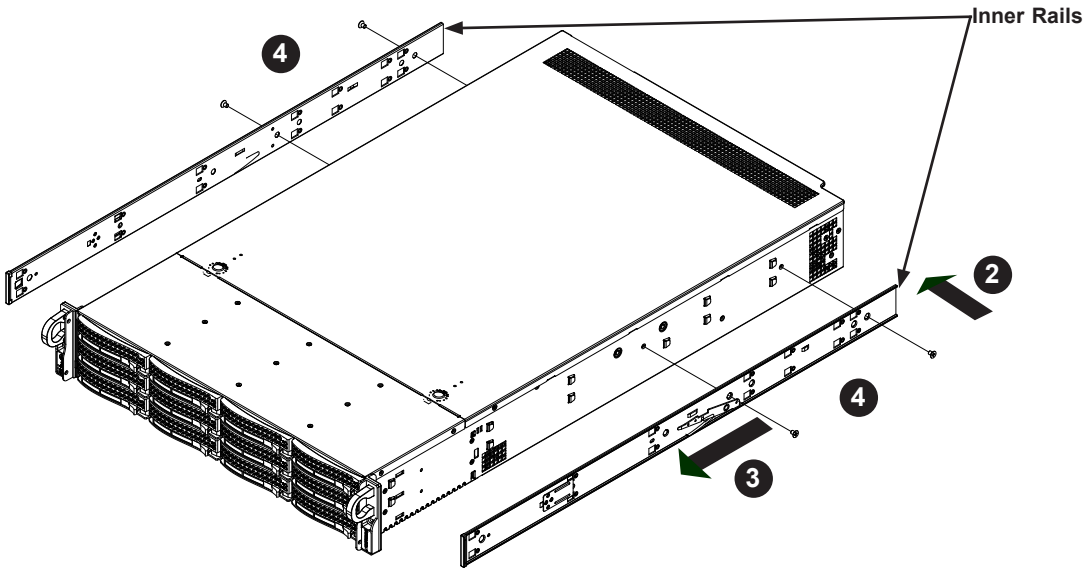


Figure 2-3. Installing the Inner Rails

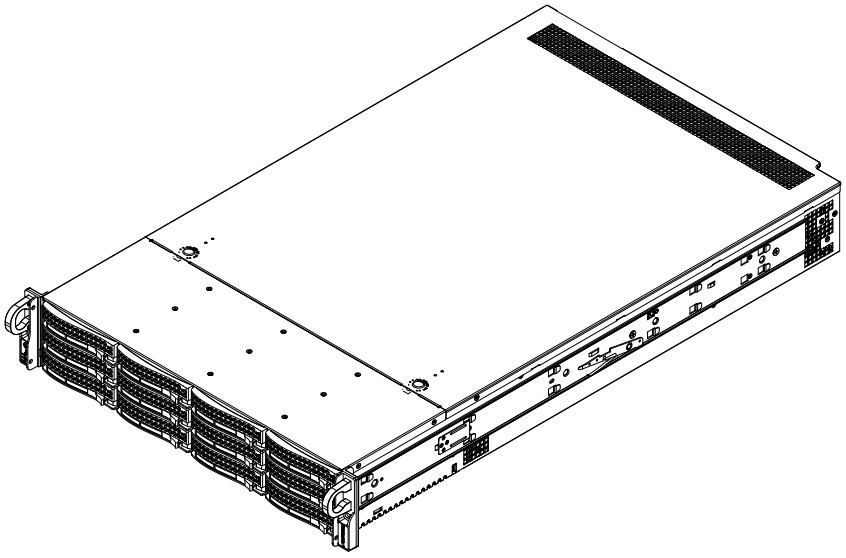


Figure 2-4. Inner Rails Installed on the Chassis

Installing the Outer Rails onto the Rack

Installing the Outer Rails

1. Press upward on the locking tab at the rear end of the middle rail.
2. Push the middle rail back into the outer rail.
3. Hang the hooks on the front of the outer rail onto the square holes on the front of the rack. If desired, use screws to secure the outer rails to the rack.
4. Pull out the rear of the outer rail, adjusting the length until it just fits within the posts of the rack.
5. Hang the hooks of the rear section of the outer rail onto the square holes on the rear of the rack. Take care that the proper holes are used so the rails are level. If desired, use screws to secure the rear of the outer rail to the rear of the rack.
6. Repeat for the other outer rail.

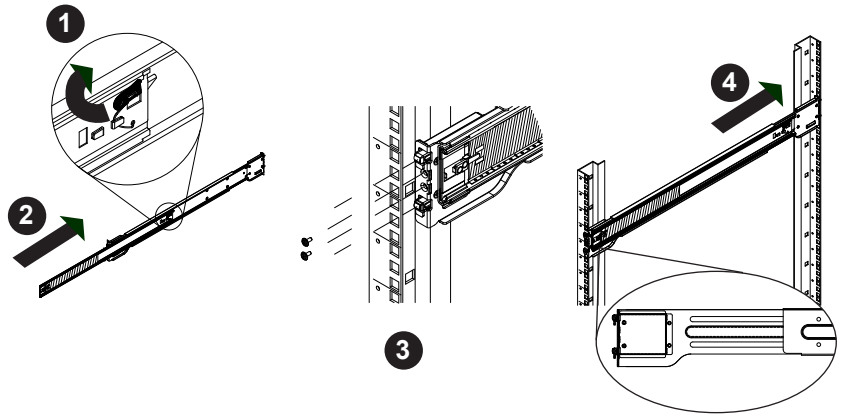


Figure 2-5. Extending and Releasing the Outer Rails

Note: Figure is for illustrative purposes only. Always install servers to the bottom of a rack first.

Warning: Stability hazard. The rack stabilizing mechanism must be in place, or the rack must be bolted to the floor before you slide the unit out for servicing. Failure to stabilize the rack can cause the rack to tip over.

Sliding the Chassis onto the Rack Rails

Warning: Mounting the system into the rack requires at least two people to support the chassis during installation. Please follow safety recommendations printed on the rails.

Installing the Chassis into a Rack

1. Extend the outer rails as illustrated above.
2. Align the inner rails of the chassis with the outer rails on the rack.
3. Slide the inner rails into the outer rails, keeping the pressure even on both sides. When the chassis has been pushed completely into the rack, it should click into the locked position.
4. Optional screws may be used to hold the front of the chassis to the rack.

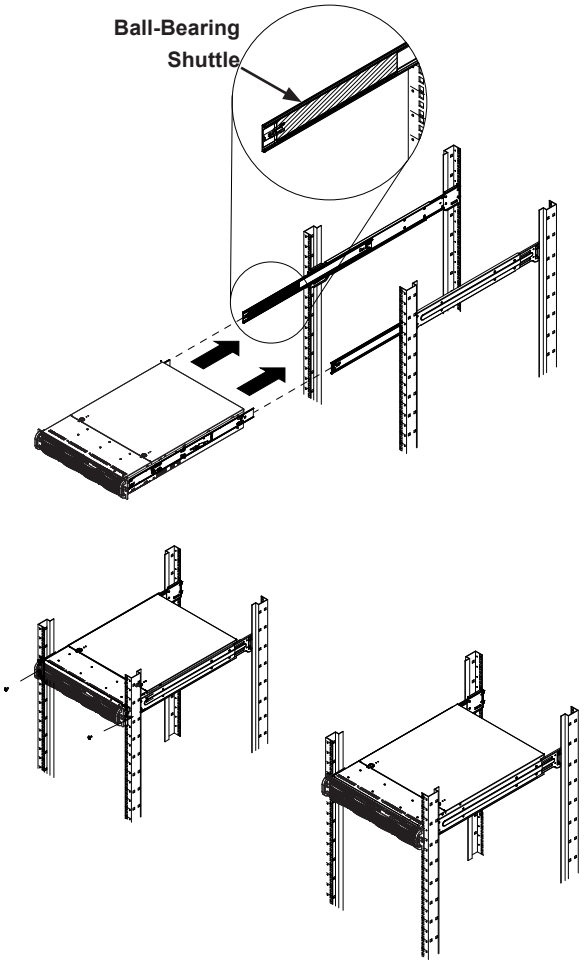


Figure 2-6. Installing into a Rack

Note: The figure above is for illustrative purposes only. Always install servers to the bottom of the rack first.

Caution: Do not pick up the server with the front handles. They are designed to pull the system from a rack only.

Chapter 3

Maintenance and Component Installation

This chapter provides instructions on installing and replacing main system components. To prevent compatibility issues, only use components that match the specifications and/or part numbers given.

Installation or replacement of most components require that power first be removed from the system. Please follow the procedures given in each section.

3.1 Removing Power

Use the following procedure to ensure that power has been removed from the system. This step is necessary when removing or installing non hot-swap components or when replacing a non-redundant power supply.

1. Use the operating system to power down the system.
2. After the system has completely shut-down, disconnect the AC power cord(s) from the power strip or outlet. (If your system has more than one power supply, remove the AC power cords from all power supply modules.)
3. Disconnect the power cord(s) from the power supply module(s).

3.2 Accessing the System

The SC829HE1C4-R1K62LPB features a removable top cover, which allows easy access to the inside of the chassis.

Removing the Top Cover

1. If rack mounted, first, grasp the two handles on either side and pull the system straight out until it locks (you will hear a "click").
2. Remove the two screws on each side of the cover, which secure the cover to the chassis.
3. Press the release tabs to remove the cover from the locked position. Press both tabs at the same time.
4. Once the top cover is released from the locked position, slide the cover toward the rear of the chassis.
5. Lift the cover off the chassis.

6. To remove the system from the rack completely, press the locking tabs in the chassis rails (push the right-side tab down and the left-side tab up) to continue to pull the system out past the locked position.

Warning: Except for short periods of time, do not operate the server without the cover in place. The chassis cover must be in place to allow for proper airflow and to prevent overheating.

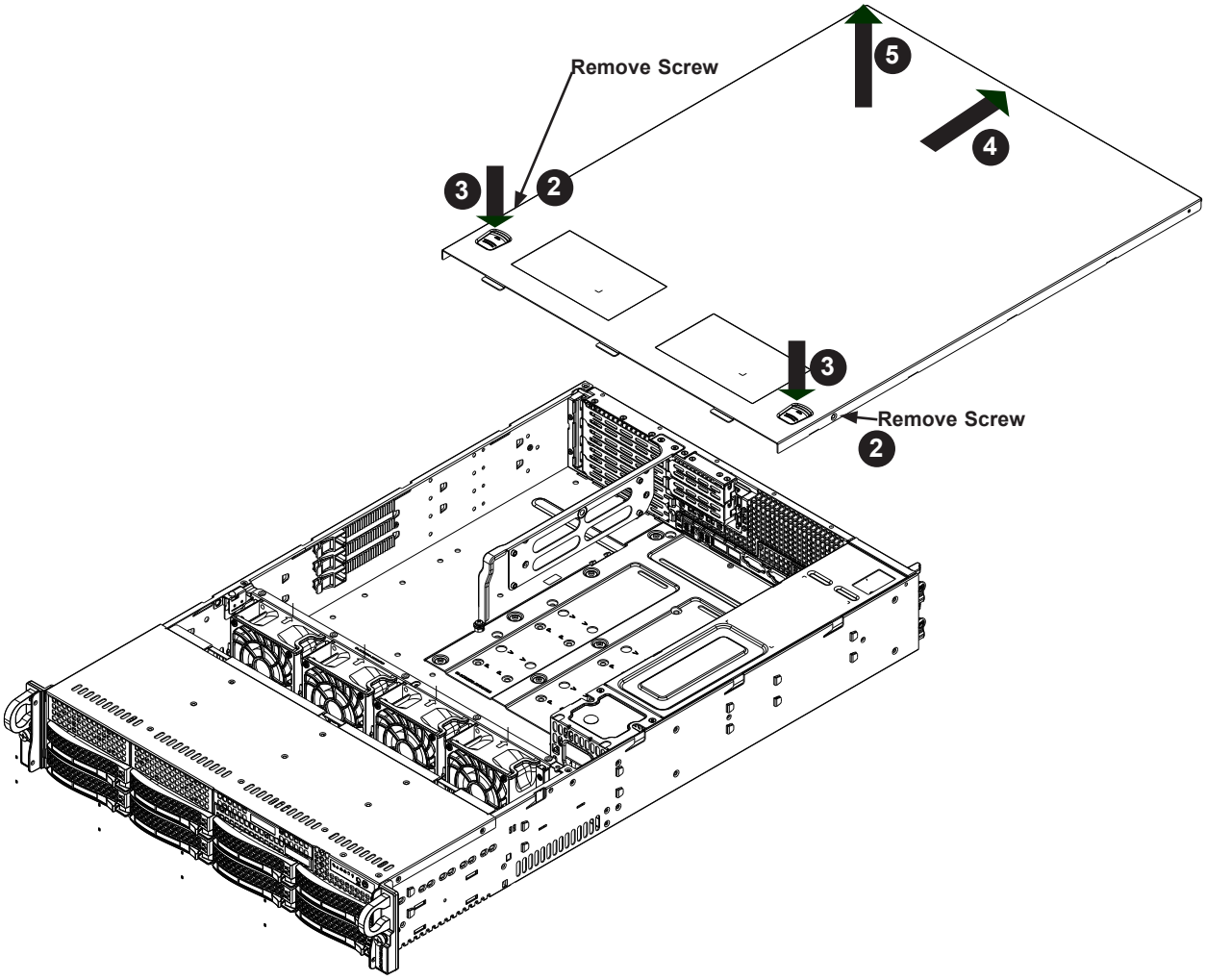


Figure 3-1. Removing the Chassis Cover

3.3 Motherboard Components

Processor and Heatsink Installation

Follow the procedures in this section to install a processor (CPU) and heatsink to the motherboard.

Notes:

- The motherboard should be installed into the chassis first and the processor should be installed into the CPU socket before you install a CPU heatsink.
- If you bought a CPU separately, make sure that you use an Intel-certified multi-directional heatsink only.
- When receiving a motherboard without a processor pre-installed, make sure that the plastic CPU socket cap is in place and none of the socket pins are bent; otherwise, contact your retailer immediately.
- Refer to the Supermicro website for updates on CPU support.

The Xeon Scalable Processor

The Intel Xeon Dual Intel® Xeon® 81xx/61xx/51xx/41xx/31xx and 82xx/62xx/52xx/42xx/32xx series processors comes in two models: Fabric (F Model) and Non-Fabric (Non-F Model). Only the Non-Fabric Model is supported for this system.

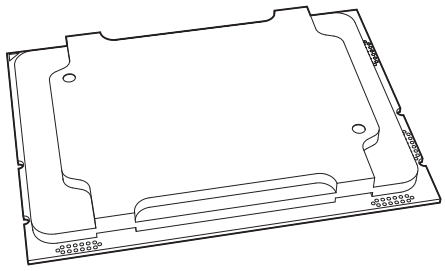


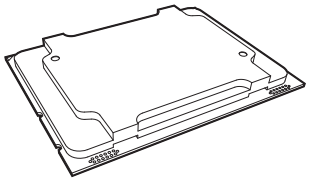
Figure 3-2. Xeon Scalable Processors

Note: All graphics, drawings, and pictures shown in this manual are for illustration only. The components that came with your server may or may not look exactly the same as those shown in this manual.

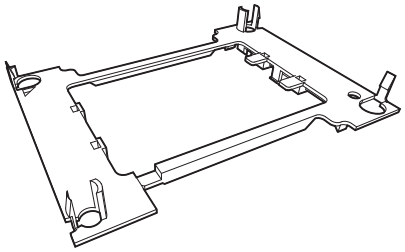
Overview of the Processor Socket Assembly

The processor socket assembly contains 1) the Intel processor, 2) the narrow processor clip, 3) the dust cover, and 4) the CPU socket.

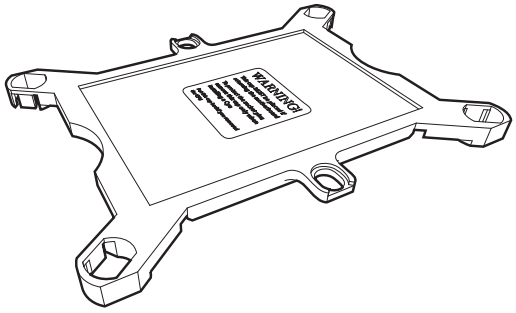
1. Processor



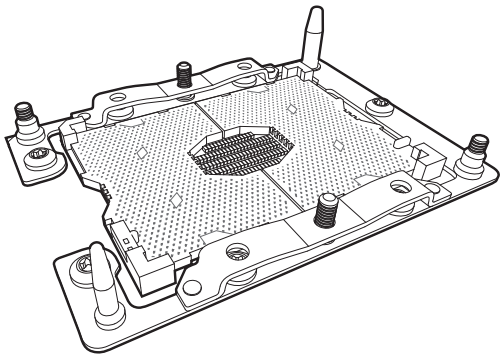
2. Narrow processor clip (the plastic processor package carrier used for the CPU)



3. Dust Cover



4. CPU Socket



Note: Be sure to cover the CPU socket with the dust cover when the CPU is not installed.

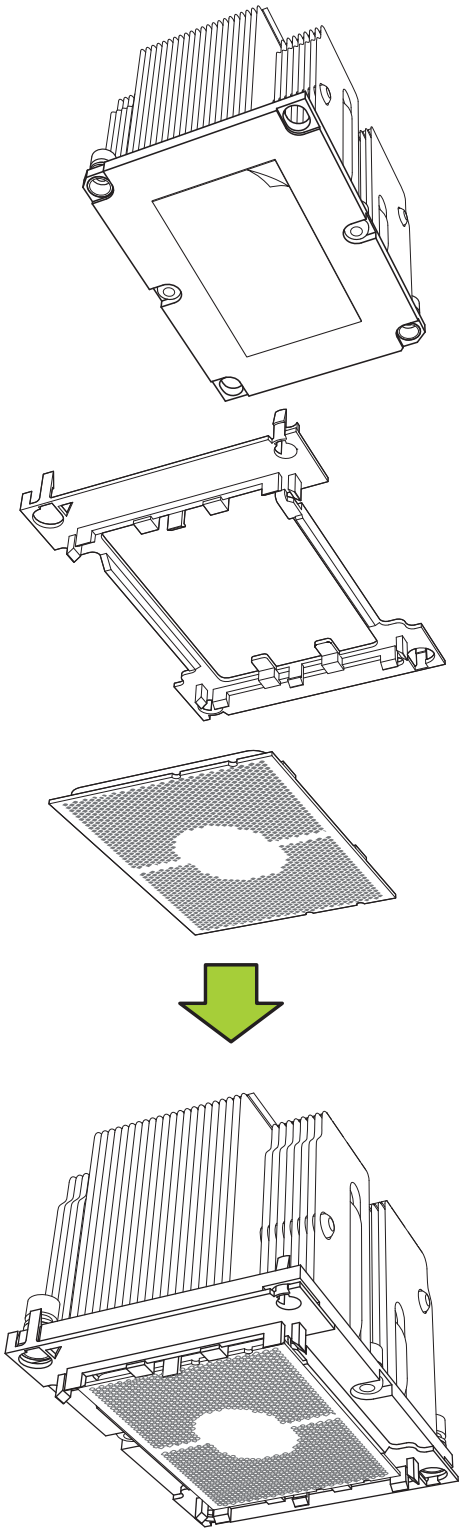
Overview of the Processor Heatsink Module (PHM)

The Processor Heatsink Module (PHM) contains 1) a heatsink, 2) a narrow processor clip, and 3) the processor.

1. Heatsink

2. Narrow processor clip

3. SKX(-F) Processor



(Bottom View for a non-F Model)

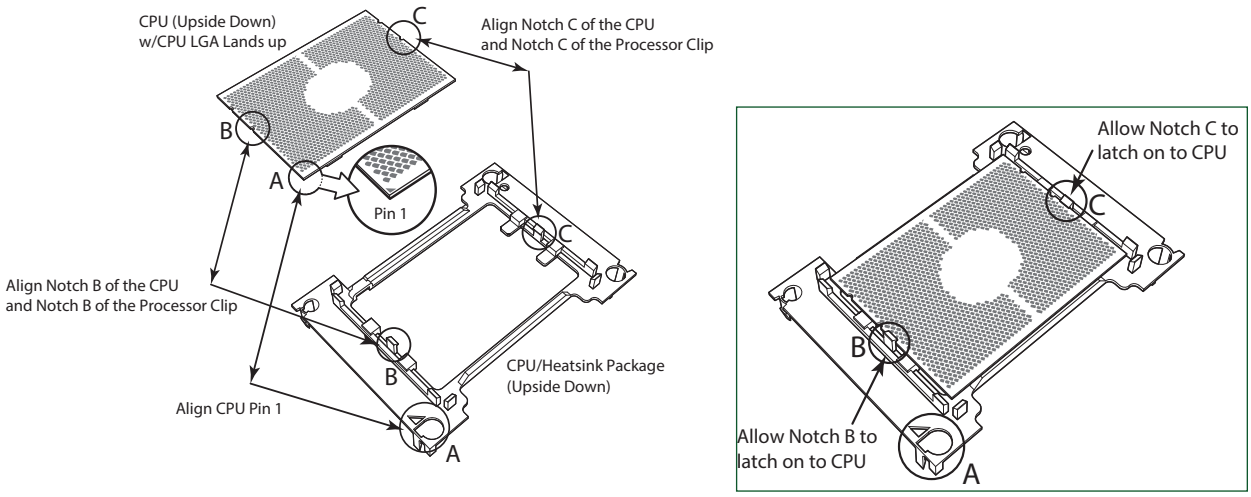
Assembling the Processor Package

Attach the processor to the narrow processor clip to create the processor package.

Caution: Exercise extreme caution when handling the CPU. Do not touch the underside of the CPU to avoid damaging it. Be sure to wear ESD gloves when handling components.

1. Locate pin 1 (A), which is the triangle on the top of the narrow processor clip. Also locate notch B and notch C on the processor clip.
2. Locate pin 1 (A), which is the triangle on the underside of the CPU. Also, locate notch B and notch C on the CPU as shown below.
3. Align pin 1 of the CPU with pin 1 of the narrow processor clip. Once they are aligned, carefully insert the CPU into the processor clip by sliding notch B of the CPU into notch B of the processor clip, and sliding notch C of the CPU into notch C of the processor clip.
4. Examine all corners of the CPU to ensure that it is properly seated and secure on the processor clip.

The processor package assembly is created.



Processor Package Assembly for the non-F Model Processors
(with CPU mounted on the Processor Clip)

Assembling the Processor Heatsink Module (PHM)

After creating the processor package assembly, mount it onto the heatsink to create the processor heatsink module (PHM).

1. Locate "1" on the heatsink label and the corner next to it. With your index finger pressing against the screw at this corner, carefully turn the heatsink upside down with the thermal grease side facing up.

2. Remove the protective thermal film if present. If this is a new heatsink, the necessary thermal grease has been pre-applied in the factory. If the heatsink is not new, apply the proper amount of thermal grease.

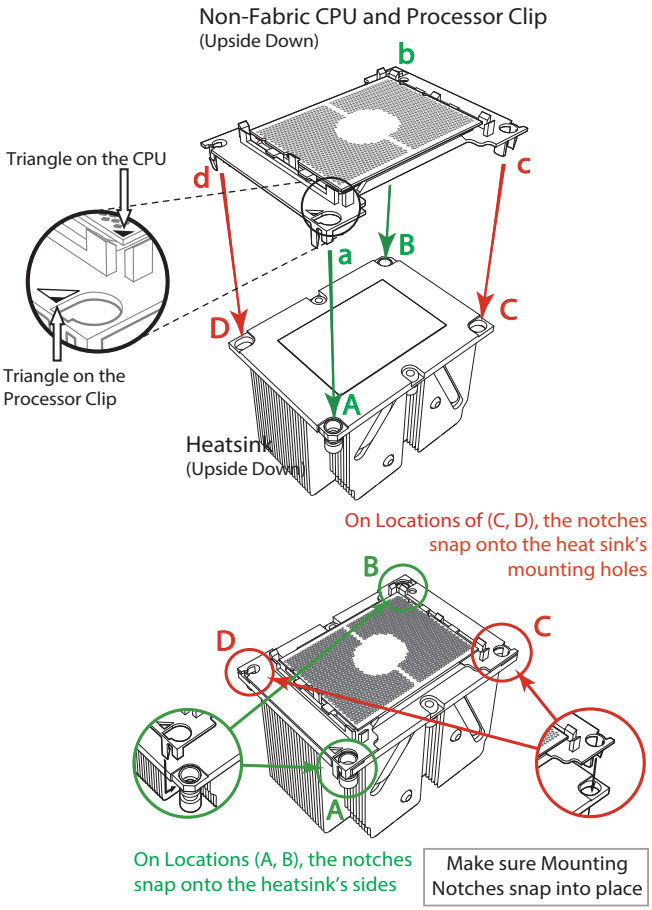
3. Holding the processor package assembly by the edge, locate the hollow triangle at the corner ("a" in the drawing below), and note a hole and plastic mounting clips next to the triangle. Also locate another set of mounting clips and a hole at the diagonal corner of the of the processor package assembly ("b" in the drawing).

4. With the under side of heatsink and the under side of the processor package assembly facing up, align the corner on the heatsink ("A" in the drawing) against the mounting clips next to the hollow triangle ("a") on the processor package assembly.

5. Also align the corner ("B") at the diagonal side of the heatsink with the corresponding clips on the processor package assembly ("b").

6. Once aligned, press the processor package assembly onto the heatsink until the mounting clips (at a, b, c, and d) snap into place.

The processor heatsink module (PHM) is created.



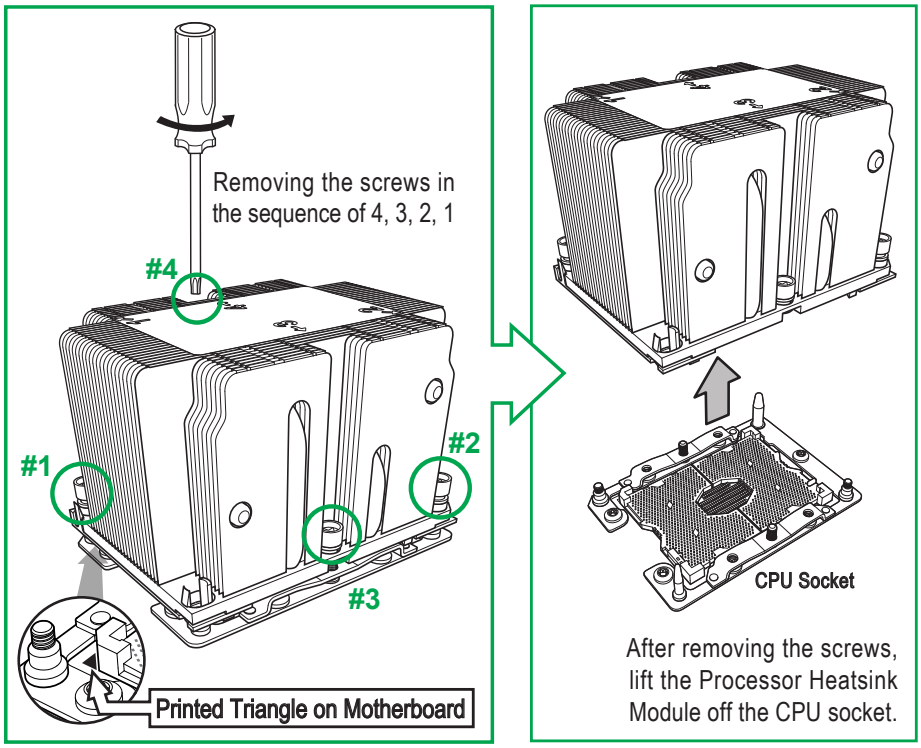
Processor Heatsink Module for the Processors

Removing the Processor Heatsink Module from the Motherboard

Before removing the processor heatsink module (PHM), power down as described in Section 3.1.

1. Using a T30 Torx-bit screwdriver, turn the screws on the PHM counterclockwise to loosen them from the socket, starting with screw marked #4, in the sequence of 4, 3, 2, 1.

2. After all four screws are removed, wiggle the PHM gently and pull it up to remove it from the socket.



Memory Installation

ESD Precautions

Electrostatic Discharge (ESD) can damage electronic components including memory modules. To avoid damaging your DIMM modules, it is important to handle it very carefully. The following measures are generally sufficient to protect your equipment from ESD.

Precautions

- Use a grounded wrist strap designed to prevent static discharge.
- Handle the memory module by its edges only.
- Put the memory modules into the antistatic bags when not in use.
- Check the Supermicro website for recommended memory modules

Introduction to Intel® Optane DC Persistent Memory

Intel® 82xx/62xx/52xx/4215 supports new DCPMM (Optane™ DC Persistent Memory Modules) technology. DCPMM offers data persistence with higher capacity at lower latencies than the existing memory modules and provides hyper-speed storage capability for high performance computing platforms with flexible configuration options.

Memory Support

The X11DPH-T can have up to 4 TB of Registered DIMM (RDIMM), Load Reduced DIMM (LRDIMM), 3D LRDIMM, Non-Volatile DIMM (NV-DIMM) ECC DDR4-2933/2666/2400/2133 memory modules installed in 16 slots. The black DIMM slots are reserved for future NVDIMM support. Populating the DIMM slots in a 2DPC (two DIMMs per channel) configuration with pairs of memory modules of the same type, speed and size will result in interleaved memory, which improves performance.

Note: 2933 MHz memory is supported by the 82xx/62xx series processors only.

DDR4 Memory Support for 81xx/61xx/51xx/41xx/31xx Processors						
Type	Ranks Per DIMM and Data Width	DIMM Capacity (GB)		Speed (MT/s)		
				One Slot per Channel	Two Slots per Channel	
		DRAM Density		One DIMM per Channel	One DIMM per Channel	Two DIMMs per Channel
		4 Gb	8 Gb	1.2 Volts	1.2 Volts	1.2 Volts
RDIMM	SRx4	4 GB	8 GB	2666	2666	2666
	SRx8	8 GB	16 GB			
	DRx8	8 GB	16 GB			
	DRx4	16 GB	32 GB			
RDIMM 3Ds	QRX4	N/A	2H-64GB			
	8RX4	N/A	4H-128GB			
LRDIMM	QRx4	32 GB	64 GB			
LRDIMM 3Ds	QRx4	N/A	2H-64GB			
	8Rx4	N/A	4H-128 GB			

DDR4 Memory Support for 82xx/62xx/52xx/42xx/32xx Processors							
Type	Ranks Per DIMM and Data Width	DIMM Capacity (GB)			Speed (MT/s)		
					One Slot per Channel	Two Slots per Channel	
		DRAM Density			One DIMM per Channel	One DIMM per Channel	Two DIMMs per Channel
		4 Gb	8 Gb	16 Gb	1.2 Volts	1.2 Volts	1.2 Volts
RDIMM	SRx4	4 GB	8 GB	16 GB	2933	2933	2933
	SRx8	8 GB	16 GB	32 GB			
	DRx8	8 GB	16 GB	32 GB			
	DRx4	16 GB	32 GB	64 GB			
RDIMM 3Ds	QRX4	N/A	2H-64GB	2H-128GB			
	8RX4	N/A	4H-128GB	4H-256GB			
LRDIMM	QRx4	32 GB	64 GB	128 GB			
LRDIMM 3Ds	QRx4	N/A	2H-64GB	2H-64GB			
	8Rx4	N/A	4H-128 GB	4H-256 GB			

Memory Installation Sequence

Memory modules for the X11 UP/DP/MP motherboards are populated using the "Fill First" method. The blue memory slot of each channel is considered the "first DIMM module" of the channel, and the black slot, the second module of the channel. When installing memory modules, be sure to populate the blue memory slots first and then populate the black slots. To maximize memory capacity and performance, please populate all DIMM slots on the motherboard, including all blue slots and black slots.

General Memory Population Requirements

1. Be sure to use the memory modules of the same type and speed on the motherboard. Mixing of memory modules of different types and speeds is not allowed.
2. Using unbalanced memory topology such as populating two DIMMs in one channel while populating one DIMM in another channel on the same motherboard will result in reduced memory performance.
3. Populating memory slots with a pair of DIMM modules of the same type and size will result in interleaved memory, which will improve memory performance.

DIMM Population Guidelines for Optimal Performance

For optimal memory performance, follow the instructions listed in the tables below when populating memory modules.

Key Parameters for DIMM Configuration

Key Parameters for DIMM Configurations	
Parameters	**Possible Values**
Number of Channels	1, 2, 3, 4, 5, or 6
Number of DIMMs per Channel	1DPC (1 DIMM Per Channel) or 2DPC (2 DIMMs Per Channel)
DIMM Type	RDIMM (w/ECC), 3DS RDIMM, LRDIMM, 3DS LRDIMM
DIMM Construction	non-3DS RDIMM Raw Cards: A/B (2Rx4), C (1Rx4), D (1Rx8), E (2Rx8) 3DS RDIMM Raw Cards: A/B (4Rx4) non-3DS LRDIMM Raw Cards: D/E (4Rx4) 3DS LRDIMM Raw Cards: A/B (8Rx4)

DIMM Mixing Guidelines

General DIMM Mixing Guidelines
• All DIMMs must be all DDR4 DIMMs. • x4 and x8 DIMMs can be mixed in the same channel. • Mixing of LRDIMMs and RDIMMs is not allowed in the same channel, across different channels, and across different sockets. • Mixing of non-3DS and 3DS LRDIMM is not allowed in the same channel, across different channels, and across different sockets.

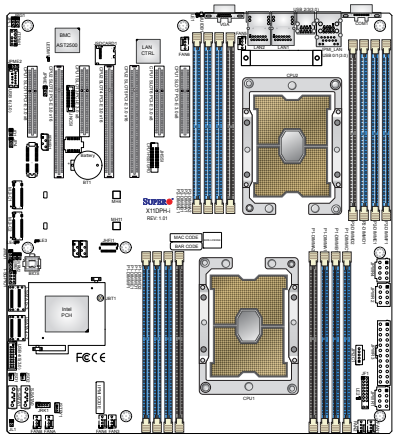
Mixing of DIMM Types within a Channel			
DIMM Types	**RDIMM**	**LRDIMM**	**3DS LRDIMM**
RDIMM	Allowed	Not Allowed	Not Allowed
LRDIMM	Not Allowed	Allowed	Not Allowed
3DS LRDIMM	Not Allowed	Not Allowed	Allowed

Note: Unbalanced memory configuration decreases memory performance and is not recommended for Supermicro motherboards.

Memory Population Table for the X11DP Motherboard w/16 DIMM Slots Onboard	
CPUs/DIMMs	**Memory Population Sequence**
1 CPU & 1 DIMM	CPU1: P1-DIMMA1
1 CPU & 2 DIMMs	CPU1: P1-DIMMA1/P1-DIMMD1
1 CPU & 3 DIMMs	CPU1: P1-DIMMC1/P1-DIMMB1/P1-DIMMA1
1 CPU & 4 DIMMs	CPU1: P1-DIMMB1/P1-DIMMA1/P1-DIMMD1/P1-DIMME1
1 CPU & 5 DIMMs*	CPU1: P1-DIMMC1/P1-DIMMB1/P1-DIMMA1/P1-DIMMD1/P1-DIMME1
1 CPU & 6 DIMM	CPU1: P1-DIMMC1/P1-DIMMB1/P1-DIMMA1/P1-DIMMD1/P1-DIMME1/P1-DIMMF1
1 CPU & 7 DIMMs*	CPU1:P1-DIMMC1/P1-DIMMB1/P1-DIMMA1/P1-DIMMA2/P1-DIMMD1/P1-DIMME1/P1-DIMMF1
1 CPU & 8 DIMMs*	CPU1: P1-DIMMC1/P1-DIMMB1/P1-DIMMA1/P1-DIMMA2/P1-DIMMD2/P1-DIMMD1/P1-DIMME1/P1-DIMMF1
2 CPUs & 2 DIMMs	CPU1: P1-DIMMA1 CPU2: P2-DIMMA1
2 CPUs & 4 DIMMs	CPU1: P1-DIMMA1/P1-DIMMD1 CPU2: P2-DIMMA1/P2-DIMMD1
2 CPUs & 6 DIMMs	CPU1: P1-DIMMC1/P1-DIMMB1/P1-DIMMA1 CPU2: P2-DIMMC1/P2-DIMMB1/P2-DIMMA1
2 CPUs & 8 DIMMs	CPU1: P1-DIMMB1/P1-DIMMA1/P1-DIMMD1/P1-DIMME1 CPU2: P2-DIMMB1/P2-DIMMA1/P2-DIMMD1/P2-DIMME1
2 CPUs & 10 DIMMs	CPU1: P1-DIMMC1/P1-DIMMB1/P1-DIMMA1/P1-DIMMD1/P1-DIMME1/P1-DIMMF1 CPU2: P2-DIMMB1/P2-DIMMA1/P2-DIMMD1/P2-DIMME1
2 CPUs & 12 DIMMs	CPU1: P1-DIMMC1/P1-DIMMB1/P1-DIMMA1/P1-DIMMD1/P1-DIMME1/P1-DIMMF1 CPU2: P2-DIMMC1/P2-DIMMB1/P2-DIMMA1/P2-DIMMD1/P2-DIMME1/P2-DIMMF1
2 CPUs & 14 DIMMs*	CPU1: P1-DIMMC1/P1-DIMMB1/P1-DIMMA1/P1-DIMMA2/P1-DIMMD1/P1-DIMME1/P1-DIMMF1 CPU2: P2-DIMMC1/P2-DIMMB1/P2-DIMMA1/P2-DIMMA2/P2-DIMMD1/P2-DIMME1/P2-DIMMF1
2 CPUs & 16 DIMMs*	CPU1: P1-DIMMC1/P1-DIMMB1/P1-DIMMA1/P1-DIMMA2/P1-DIMMD2/P1-DIMMD1/P1-DIMME1/P1-DIMMF1 CPU2: P2-DIMMC1/P2-DIMMB1/P2-DIMMA1/P2-DIMMA2/P2-DIMMD2/P2-DIMMD1/P2-DIMME1/P2-DIMMF1

*Unbalanced, not recommended.

Note: The drawing at right shows DIMM module population for each CPU installed on the motherboard. Please install your processors starting with CPU Socket 1.



Symmetric Population within 1 CPU Socket									
Modes	**P1-DIMMF1**	**P1-DIMME1**	**P1-DIMMD1**	**P1-DIMMD2**	**P1-DIMMA2**	**P1-DIMMA1**	**P1-DIMMB1**	**P1-DIMMC1**	**Channel Config.**
AD	DRAM1	DRAM1	DRAM1	DCPMM	DCPMM	DRAM1	DRAM1	DRAM1	2-1-1
MM	DRAM2	DRAM2	DRAM2	DCPMM	DCPMM	DRAM2	DRAM2	DRAM2	2-1-1
AD + MM	DRAM3	DRAM3	DRAM3	DCPMM	DCPMM	DRAM3	DRAM3	DRAM3	2-1-1
AD	DCPMM	DRAM1	DRAM1	-	-	DRAM1	DRAM1	DCPMM	1-1-1
MM	DCPMM	DRAM1	DRAM1	-	-	DRAM1	DRAM1	DCPMM	1-1-1
AD + MM	DCPMM	DRAM3	DRAM3	-	-	DRAM3	DRAM3	DCPMM	1-1-1

Asymmetric Population within 1 CPU Socket									
Modes	**P1-DIMMF1**	**P1-DIMME1**	**P1-DIMMD1**	**P1-DIMMD2**	**P1-DIMMA2**	**P1-DIMMA1**	**P1-DIMMB1**	**P1-DIMMC1**	**Channel Config.**
AD	DRAM1	DRAM1	DRAM1	-	DCPMM	DRAM1	DRAM1	DRAM1	2-1-1
AD*	DRAM1	DRAM1	DRAM1	-	DCPMM	DRAM1	DRAM1	DRAM1	2-1-1

Legend (for the two tables above)					
DDR4 Type					**Capacity**
DRAM1	RDIMM	3DS RDIMM	LRDIMM	3DS LRDIMM	Any Capacity
DRAM2	RDIMM	-		-	Refer to Validation Matrix (DDR4 DIMMs validated with DCPMM) below.
DRAM3	RDIMM	3DS RDIMM	LRDIMM	-	

Note: DDR4 single rank x8 is not available for DCPMM Memory Mode or App-Direct Mode.

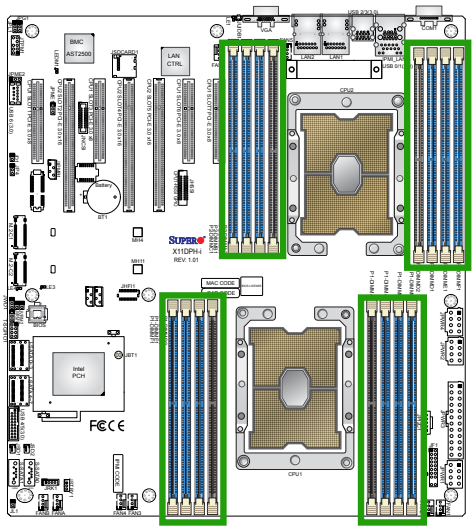
Legend (for the first two tables above)	
Capacity	
DCPMM	Any Capacity (Uniformly for all channels for a given configuration)

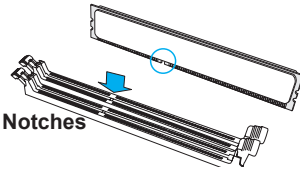
- * 2nd socket has no DCPMM DIMM
- For MM, general NM/FM ratio is between 1:4 and 1:16. Excessive capacity for FM can be used for AD. (NM = Near Memory; FM = Far Memory)
- For each individual population, rearrangements between channels are allowed as long as the resulting population is compliant with the PDG rules for the 82xx/62xx/52xx/42xx platform.
- For each individual population, please use the same DDR4 DIMM in all slots.
- For each individual population, sockets are normally symmetric with exceptions for 1 DCPMM per socket and 1 DCPMM per node case. Currently, DCPMM modules operate at 2666 MHz.
- No mixing of DCPMM and NVMDIMMs within the same platform is allowed.
- This DCPMM population guide targets a balanced DCPMM-to-DRAM-cache ratio in MM and MM + AD modes.

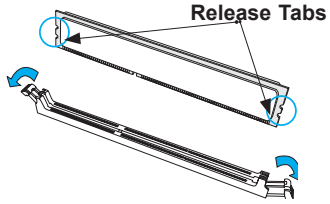
Validation Matrix (DDR4 DIMMs Validated w/DCPMM)			
DIMM Type	**Ranks Per DIMM & Data Width (Stack)**	**DIMM Capacity (GB) DRAM Density**	
		4Gb	**8Gb**
RDIMM	1Rx4	8GB	16GB
	2Rx8	8GB	16GB
	2Rx4	16GB	32GB
LRDIMM	4Rx4	N/A	64GB
LRDIMM 3DS	8Rx4 (4H)	N/A	128GB

DIMM Installation

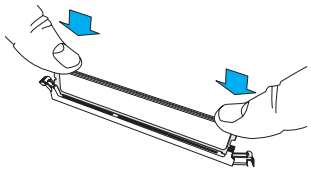
1. Follow the instructions given in the memory population guidelines listed in the previous sections to install memory modules on your motherboard. For the system to work properly, please use memory modules of the same type and speed on the motherboard. (See the Note below.)
2. Push the release tabs outwards on both ends of the DIMM slot to unlock it.
3. Align the key of the DIMM module with the receptive point on the memory slot.
4. Align the notches on both ends of the module against the receptive points on the ends of the slot.
5. Use two thumbs together to press the DIMM module straight down into the slot until the module snaps into place.
6. Press the release tabs to the lock positions to secure the DIMM module into the slot.





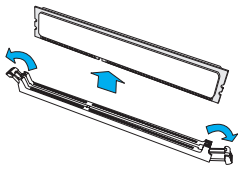


Insert the DIMM module into the memory slot.



DIMM Module Removal

Press the release tabs on both ends of the DIMM socket to release the DIMM module from the socket as shown in the drawing on the right.



Warning! 1. T to avoid damage to the DIMM module or the DIMM socket, do not use excessive force when pressing the release tabs on the ends of the DIMM socket. **2.** Handle DIMM modules with care. Carefully follow all the instructions given in Section 1 of this user guide to avoid ESD-related damage to your components or system. **3.** All graphics, including the layout drawing above, are for reference only. Your system components may or may not look the same as shown in this user guide.

PCI Expansion Card Installation

The 6029P-E1CR16T can accommodate up to seven low-profile add-on cards in the PCI expansion slots on the serverboard.

Installing Add-on Card

1. Begin by removing the shield for the PCI slot you wish to populate. Make sure that the card you are installing is supported by the slot (see table below).
2. Fully seat the card into the slot, pushing down with your thumbs evenly on both sides of the card.
3. Finish by using a screw to secure the top of the card shield to the chassis. The PCI slot shields protect the serverboard and its components from EMI and aid in proper ventilation, so make sure there is always a shield covering each unused slot..

Motherboard Battery

The motherboard uses non-volatile memory to retain system information when system power is removed. This memory is powered by a lithium battery residing on the motherboard.

Replacing the Battery

Begin by removing power from the system as described in Section 3.1 and removing the cover as described in Section 3.2.

1. Push aside the small clamp that covers the edge of the battery. When the battery is released, lift it out of the holder.
2. To insert a new battery, slide one edge under the lip of the holder with the positive (+) side facing up. Then push the other side down until the clamp snaps over it.

Note: Handle used batteries carefully. Do not damage the battery in any way; a damaged battery may release hazardous materials into the environment. Do not discard a used battery in the garbage or a public landfill. Please comply with the regulations set up by your local hazardous waste management agency to dispose of your used battery properly.

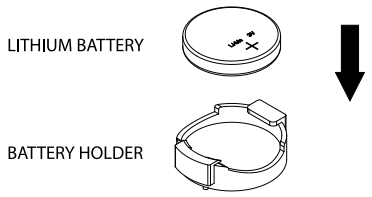


Figure 3-3. Installing the Onboard Battery

Warning: There is a danger of explosion if the onboard battery is installed upside down (which reverses its polarities). This battery must be replaced only with the same or an equivalent type recommended by the manufacturer (CR2032).

3.4 Chassis Components

Removing and Installing Hard Drives

The SC829U chassis accepts twelve hot-swappable 3.5" hard drives. The hard drives are mounted in drive carriers to simplify their installation and removal from the chassis. System power may remain on when removing carriers with drives installed. These carriers also help promote proper airflow for the drive bays. For this reason, even empty carriers without drives installed must remain in the chassis.

Removing Hard Drive Carrier from the Chassis

1. Press the release button on the drive carrier. This extends the drive carrier handle.
2. Use the handle to pull the drive out of the chassis.

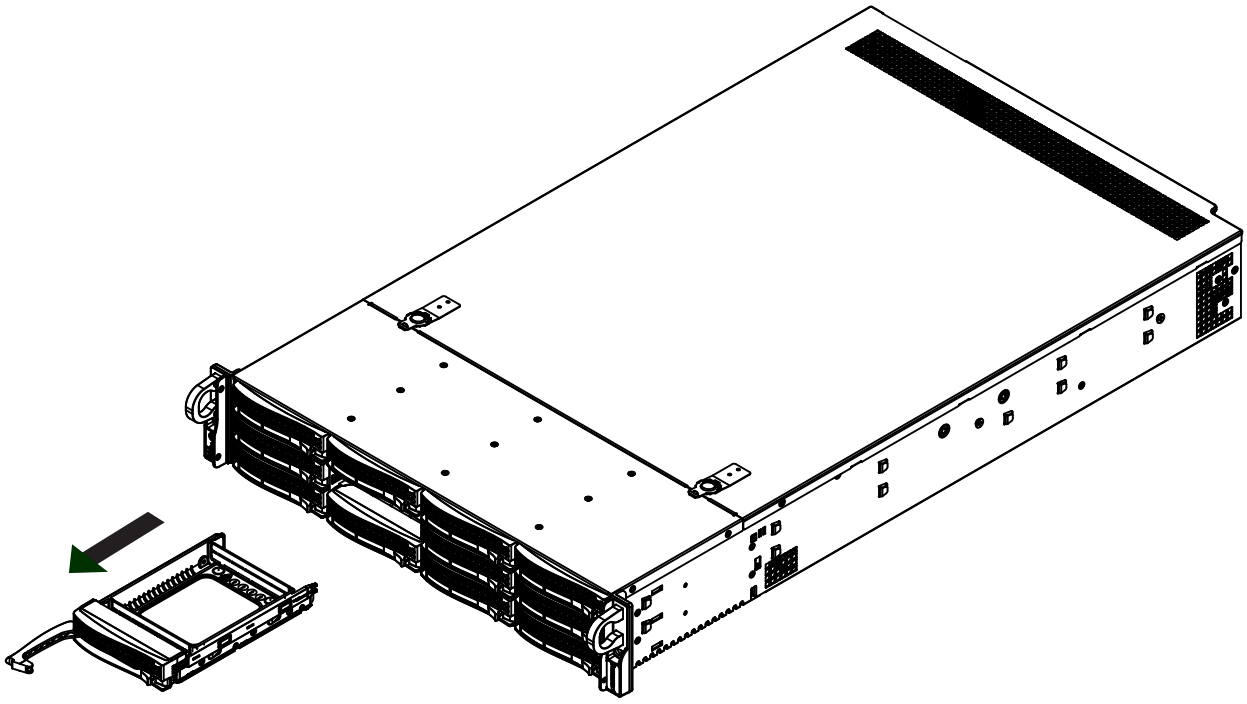


Figure 3-4. Removing a Drive Carrier from the System

Installing a Hard Drive into a Drive Carrier

1. Remove the screws securing the dummy drive to the carrier.
2. Remove the dummy drive from the carrier.
3. Install a new drive into the carrier with the printed circuit board side facing down so that the mounting holes align with those in the carrier.
4. Secure the hard drive by tightening all six screws.
5. Replace the drive carrier into the chassis bay, making sure that the drive carrier handle is completely closed.
6. Install a new drive into the carrier with the printed circuit board side facing down so that the mounting holes align with those in the carrier.
7. Secure the hard drive by tightening all six screws.
8. Replace the drive carrier into the chassis bay, making sure that the drive carrier handle is completely closed.

Caution: Except for short periods of time (swapping hard drives), do not operate the server with the hard drives removed from the bays.

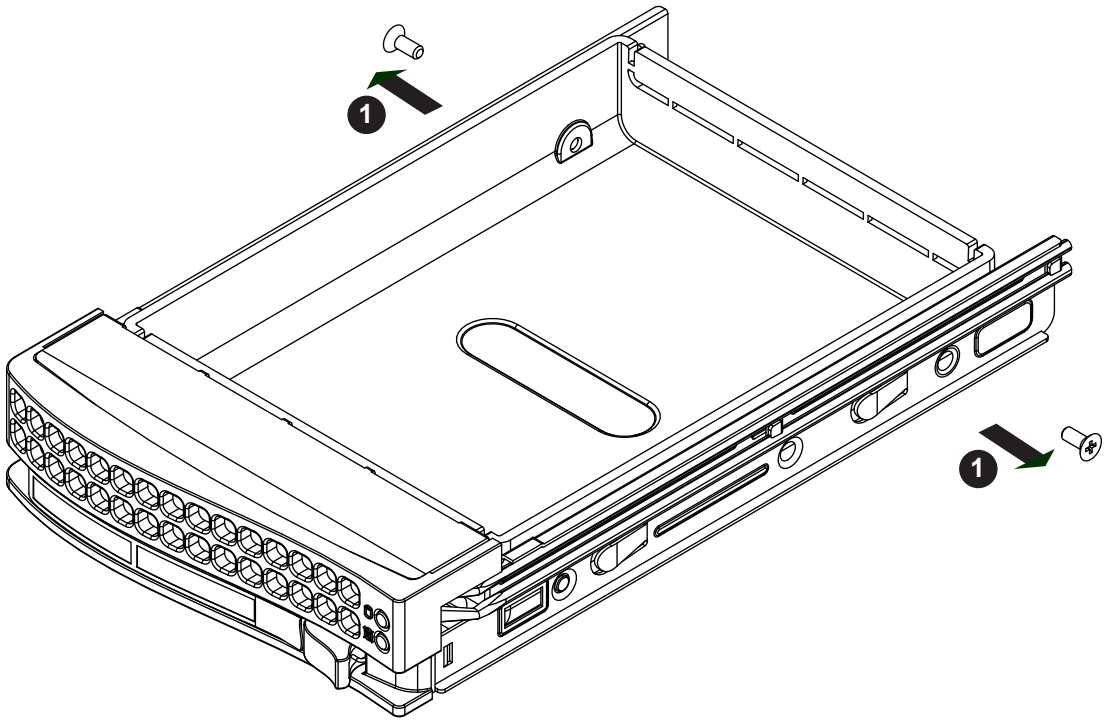


Figure 3-5. Removing a Dummy Drive from a Carrier

Note: Enterprise level hard disk drives are recommended for use in Supermicro chassis and servers. For information on recommended HDDs, visit the Supermicro website at http://www.supermicro.com/products/nfo/files/storage/SBB-HDDCompList.pdf

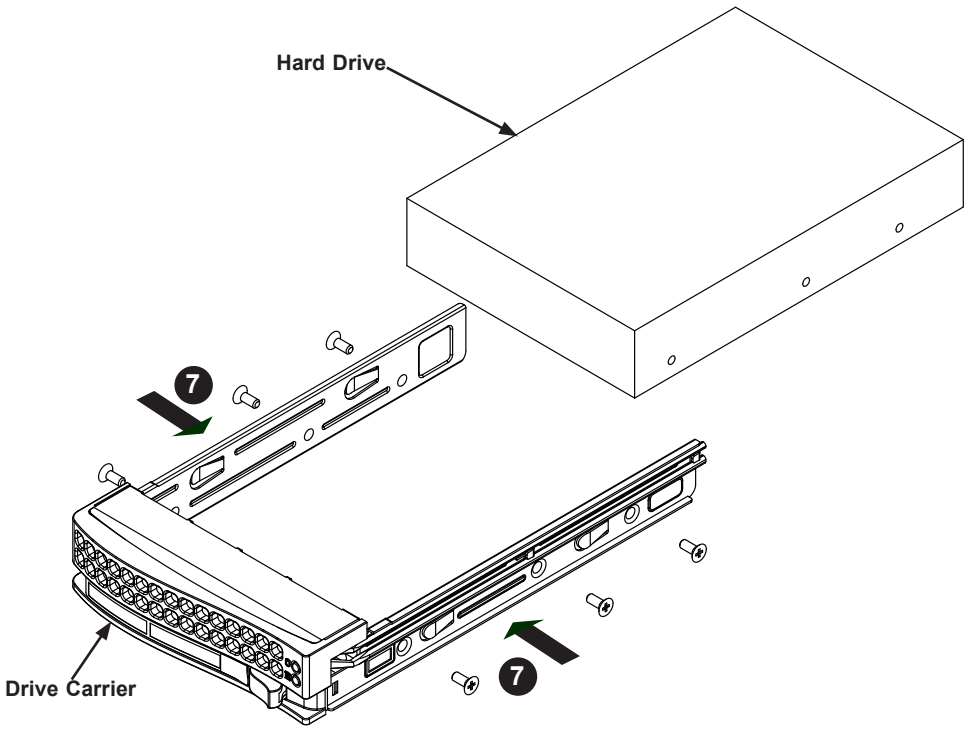


Figure 3-6. Installing a Hard Drive

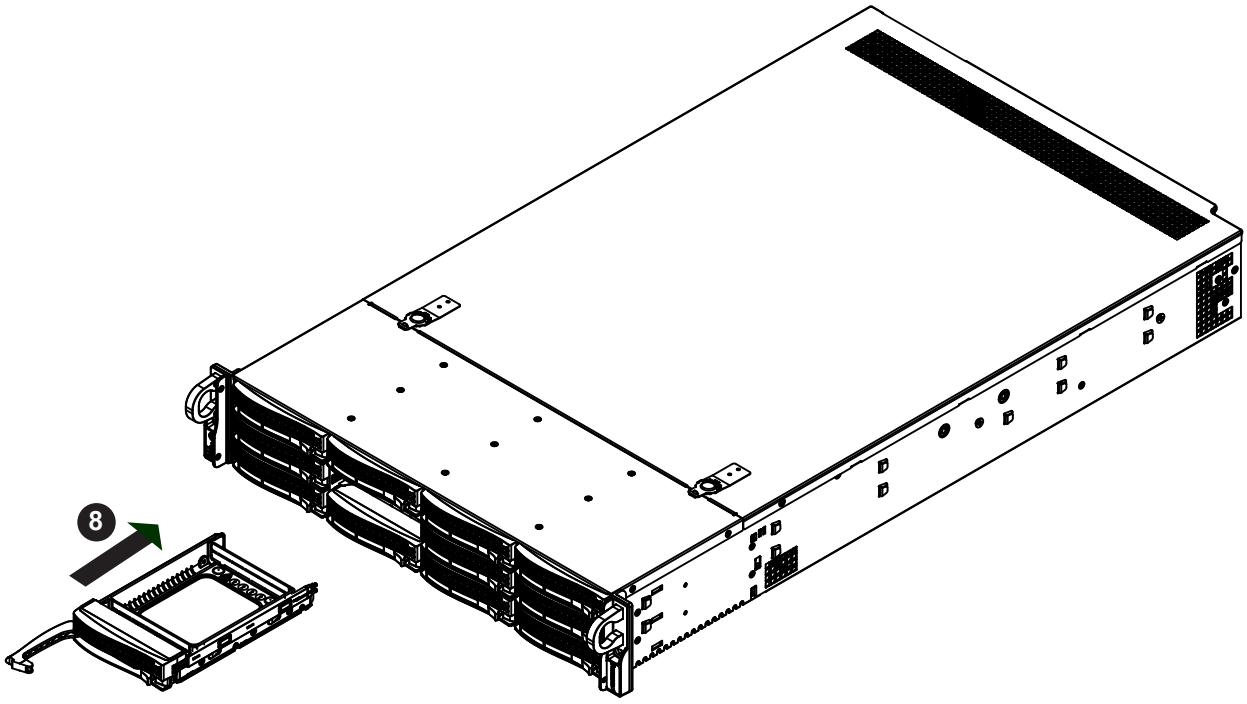


Figure 3-7. Installing a Carrier into its Bay

Internal 3.5" Hard Drives

The SC829U chassis supports four internal hot-swap 3.5" hard drives which are mounted in individual hard drive trays contained in an internal chassis tray. After the chassis tray has been installed into the chassis, the power can stay on when removing or installing the hard drives from their individual trays.

Setting up the Internal Chassis Tray and Individual Trays

1. Power down the system and remove the chassis covers as described in Section 3.2.
2. Remove the two side screws securing the tray to the chassis and set them aside for later use.
3. Lift the hard chassis tray up and out of the chassis.

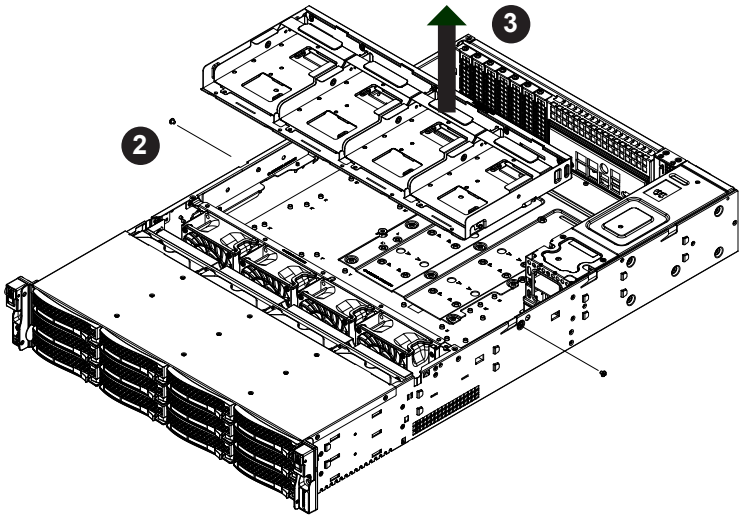


Figure 6-10. Removing the Chassis Tray

4. Remove the screws securing each hard drive tray to the chassis tray.

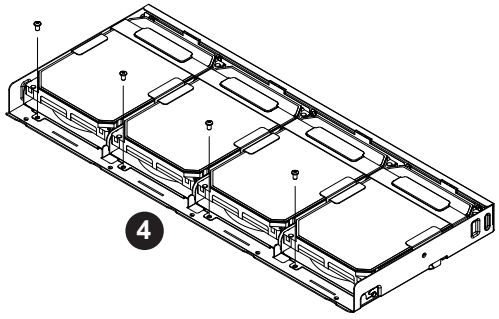


Figure 6-11. Removing Screws from the Individual Trays

5. Lift the individual trays up and out of the chassis tray.

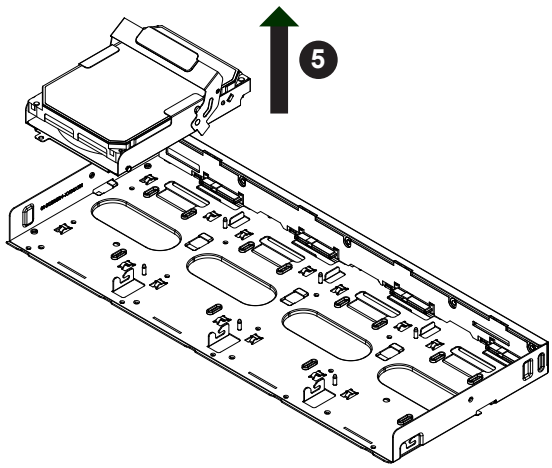


Figure 6-12. Removing a Hard Drive Carrier from the Hard Drive Tray

6. Place a hard drive into each of the individual trays and secure it with four screws.

7. Place the hard drives and individual trays into the chassis tray.

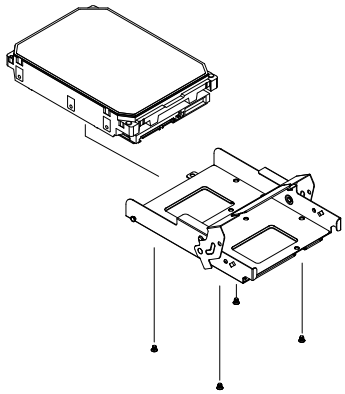


Figure 6-13. Installing a Hard Drive into its Tray

8. Secure the individual trays into the chassis tray with four screws.

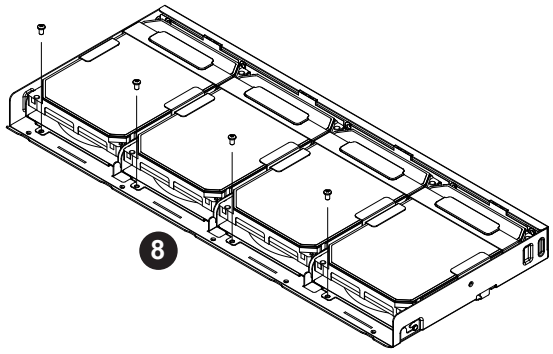


Figure 6-14. Installing Hard Drives and Carriers into the Hard Drive Tray

9. Place the loaded chassis tray into the chassis.

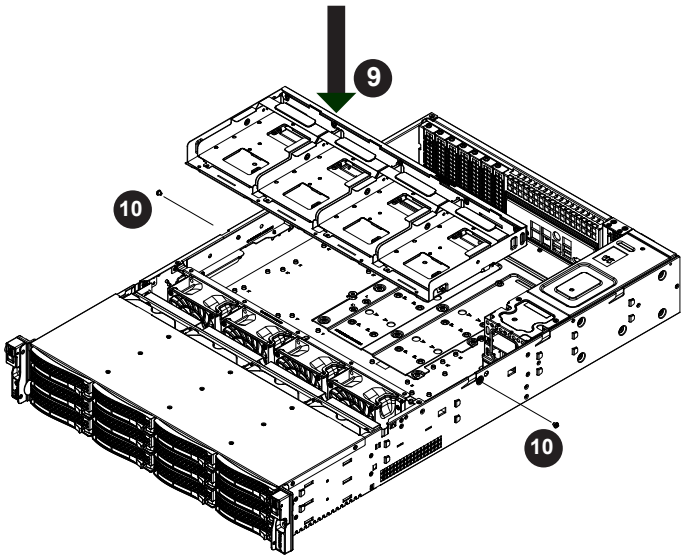


Figure 6-15. Installing the Hard Drive Tray into the Chassis

10. Secure the chassis tray with the two side screws previously set aside.

11. Plug the power cords into the rear of the power supply, replace the top cover and power up the system.

After installing the chassis tray and individual trays, the internal hot-swappable hard drives may be removed without powering down the system.

Removing Internal Hard Drives from the Chassis Tray

1. Confirm that that chassis tray and individual trays have been installed as directed in the previous section.
2. With the power running, remove the middle top cover as described in Section 6-3.
3. Lift the latch on the individual tray and slide the hard drive out toward the front of the chassis.

Installing Hard Drives Into the Individual Trays

1. After removing the middle top cover and lifting the individual tray latch, insert a hard drive into the individual tray by sliding it toward the rear of the tray.
2. Close the latch and replace the middle top cover.

Adding PCI Expansion Cards

Riser cards on chassis brackets allow you to add PCI expansion cards. The total number of expansion cards depends on the model (see "PCI Expansion Slots" in Section 1.3 and the table below). All expansion cards are PCI-Express 3.0. For all models:

- RSC-R2UW-4E8 supports four standard size PCI-E x8 expansion cards (5-8).
- RSC-R1UW-E8R supports one low profile x8 expansion card (4)

Other configurations are affected by the Ultra riser card.

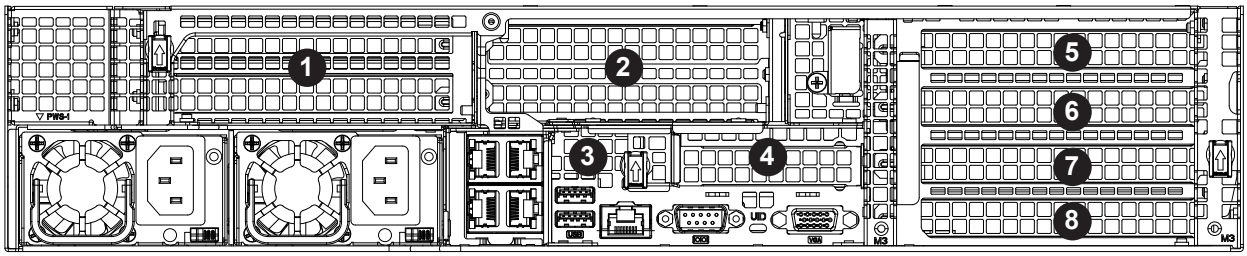


Figure 3-8. PCI Expansion Card Chassis Slots

Expansion Card Configurations		
Slot	**Mechanical**	**Electrical**
1	Double Width, full height, full length	NA
2	Double Width, full height, full length	x8 (CPU1)
3*	Internal Low Profile, half length	x8 (CPU1)
4	Low Profile, half length	x8 (CPU2)
5	Full Height, full length	x8 (CPU2)
6	Full Height, full length	x8 (CPU2)
7	Full Height, full length	x8 (CPU2)
8	Full Height, full length	x8 (CPU2)

Full height = 4.2", Low profile = 2.5", Full length = 10.5", Half length = 6.6"

* This slot supports only Supermicro SAS Cards listed below.

Supermicro SAS Cards	
Part Number	**Description**
AOC-S3008L-L8e (8-port HBA)	Std LP, 8 internal ports, 12 Gb/s per port, Gen 3, 122HDD, HBA
AOC-S3008L-L8i (8-port SW RAID)	Std LP, 8 internal ports, 12 Gb/s per port, Gen 3, 63HDD, RAID 0, 1, 1E
AOC-S3108L-H8iR (8-port HW RAID)	Std LP, 8 internal ports, 12 Gb/s per port, Gen 3, 240HDD, RAID 0, 1, 5, 6, 10, 50 ,60

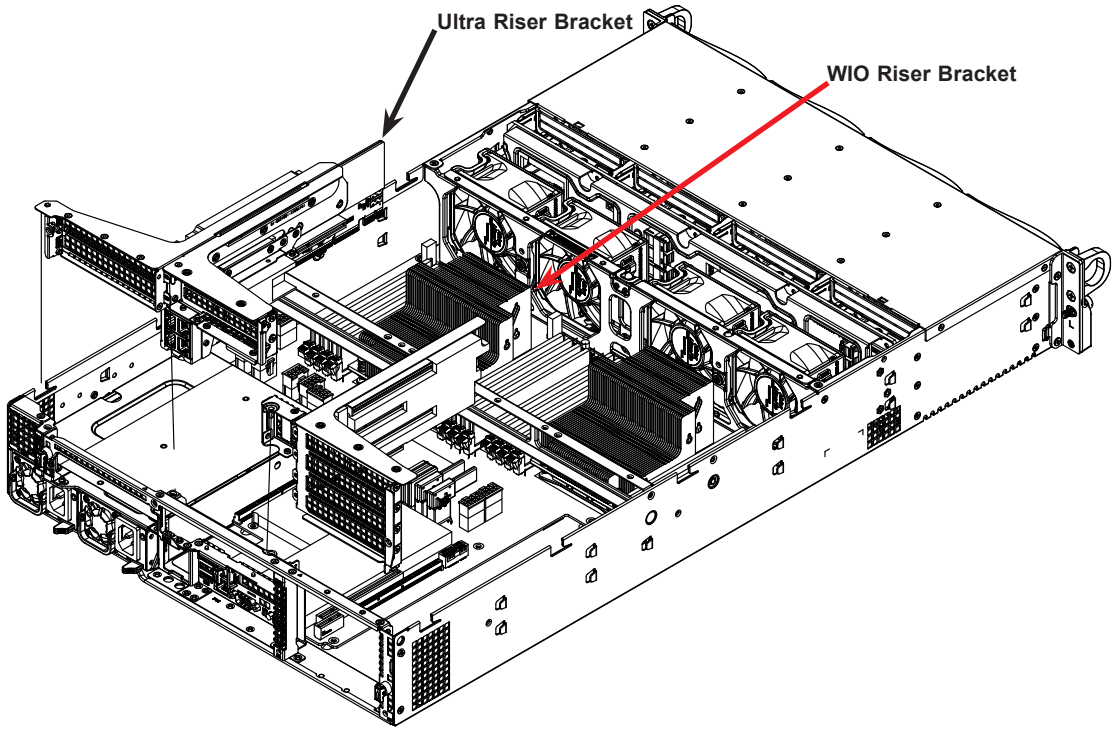


Figure 3-9. Expansion and Riser Cards—Rear View

Installing PCI Expansion Cards

1. Power down the system and remove the top chassis cover.
2. Remove the Ultra riser bracket or WIO riser bracket by flipping up its riser cage release tab as pictured in Figure 3-10.
3. Insert the expansion card(s) into the riser card slot(s).
4. Replace the riser card into the serverboard expansion slot while aligning the bracket into the chassis. Flip down the riser cage release tab.
5. Replace the chassis cover.

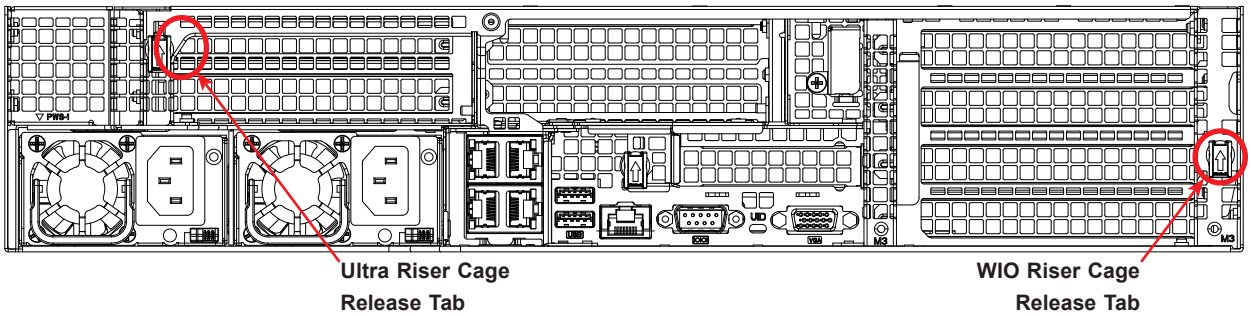


Figure 3-10. Riser Cage Release Tabs

System Fans

The chassis contains four 8-cm high-performance fans.

Replacing a System Fan

Fan speed is controlled by system temperature via IPMI. If a fan fails, the remaining fan will ramp up to full speed and the overheat/fan fail LED on the control panel will turn on. Replace any failed fan at your earliest convenience with the same type and model (the system can continue to run with a failed fan).

Remove the top chassis cover while the system is still running to determine which of the fans has failed. Please do not try to reach into the vicinity of fan blades even when the fan is not installed throughout the swapping process. Failing to do so may result in serious injury.

Replacing System Fans

1. After removing the top chassis cover, locate the failed fan.
2. Press the fan release tab to lift the failed fan from the chassis and pull it upwards from the chassis completely.
3. Install the new fan housing into the vacant space while making sure the arrows (air flow direction) on the top of the fan housing point in the same direction as the arrows on the other fans. Press firmly on the top of the fan until a snap is felt.
4. Check that the fan is working properly before replacing the chassis cover.

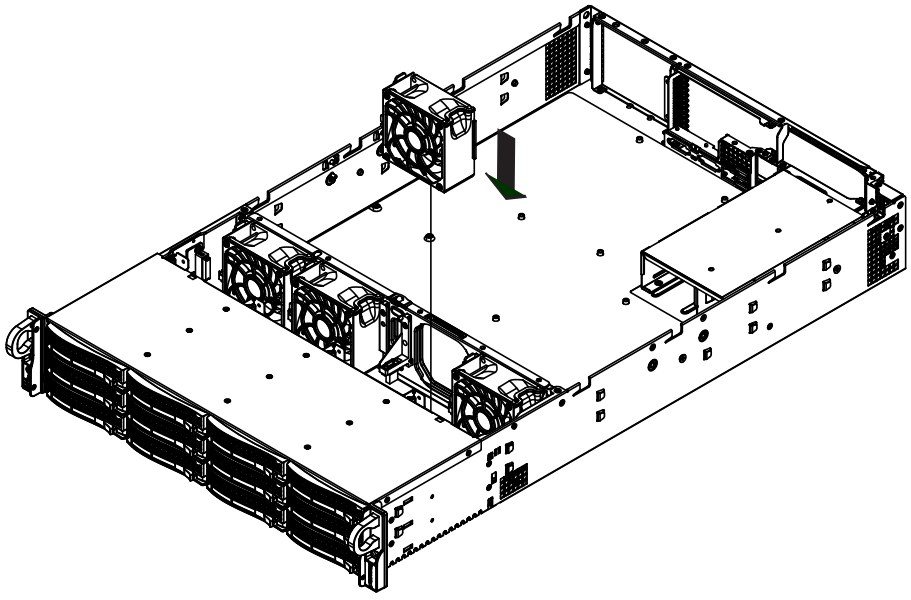


Figure 3-11. System Fans

Air Shroud

Cooling is also improved by installing the standard air shroud. Insert it over the CPUs.

Power Supply

The 6028U-E1CNR(4)T+ has a 1600 watt redundant hot-plug power supply consisting of two power modules. Each power supply module has an auto-switching capability, which enables it to automatically sense and operate at a 100V - 240V input voltage.

Replacing a Power Supply Module

If either of the two power supply modules fail, the other module will take the full load and allow the system to continue operation without interruption. The Power Fail LED will illuminate and remain on until the failed unit has been replaced. Replacement units can be ordered directly from Supermicro. The power supply units have a hot-plug capability, meaning you can replace the failed unit without powering down the system.

Replacing the Power Supply

1. First unplug the AC power cord from the failed power supply module.
2. Depress the release tab on the power supply module as illustrated.
3. Use the handle to pull the module straight out of the chassis.
4. Replace the failed hot-swap unit with another identical power supply unit.
5. Push the new power supply unit into the power bay until it clicks.
6. Plug the AC power cord back into the unit and power up the server.

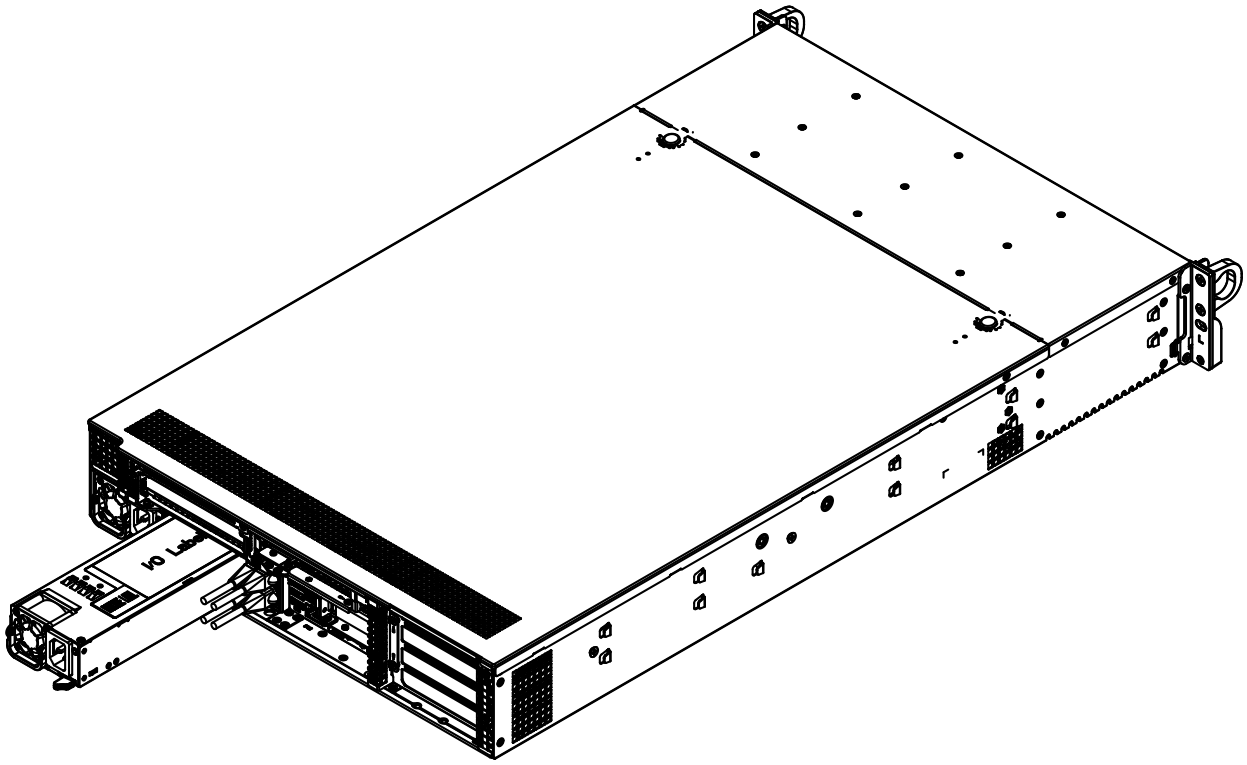


Figure 3-12. Removing/Replacing the Power Supply

Chapter 4

Motherboard Connections

This section describes the connections on the motherboard and provides pinout definitions. Note that depending on how the system is configured, not all connections are required. The LEDs on the motherboard are also described here. A serverboard layout indicating component locations may be found in Chapter 1.

Please review the Safety Precautions in Appendix B before installing or removing components.

4.1 Power Connections

Five power connections on the X11DPH-T must be connected to the power supply. The wiring is included with the power supply.

- 24-pin Primary ATX Power (JPWR3)
- 8-pin Processor Power (JPWR1, JPWR2, JPWR4)

Main ATX Power Connector

The primary power connector (JPWR3) meets the ATX SSI EPS 24-pin specification. You must also connect the 8-pin (JPWR2) power connectors to your power supply (see next page).

ATX Power 24-pin Connector Pin Definitions

Pin#	Definition	Pin#	Definition
13	+3.3V	1	+3.3V
14	NC	2	+3.3V
15	Ground	3	Ground
16	PS_ON	4	+5V
17	Ground	5	Ground
18	Ground	6	+5V
19	Ground	7	Ground
20	Res (NC)	8	PWR_OK
21	+5V	9	5VSB
22	+5V	10	+12V
23	+5V	11	+12V
24	Ground	12	+3.3V

Required Connection

Important: To provide adequate power to the motherboard, connect the 24-pin *and* the 8-pin power connectors to the power supply. Failure to do so may void the manufacturer's warranty on your power supply and motherboard.

Processor Power Connector

JPWR1, JPWR2 and JPWR4 are the 8-pin 12V DC power inputs for the CPU or alternative single power source for a special enclosure when the 24-pin ATX power is not in use.

12V 8-pin Power Pin Definitions	
Pin#	**Definition**
1 - 4	Ground
5 - 8	+12V

Required Connection

4.2 Headers and Connectors

Fan Headers

There are eight fan headers on the motherboard. These are 4-pin fan headers; pins 1-3 are backward compatible with traditional 3-pin fans. The onboard fan speeds are controlled by Thermal Management in the BIOS. When using Thermal Management setting, please use all 3-pin fans or all 4-pin fans.

Fan Header Pin Definitions	
Pin#	**Definition**
1	Ground (Black)
2	+12V (Red)
3	Tachometer
4	PWM Control

Power SMB (I^2C) Header

The Power System Management Bus (I^2C) connector (JPI^2C1) monitors the power supply, fan, and system temperatures.

Power SMB Header Pin Definitions	
Pin#	**Definition**
1	Clock
2	Data
3	PMBUS_Alert
4	Ground
5	+3.3V

SATA DOM Power Connector

The SATA Disk-On-Module (DOM) power connectors at JSD1 and JSD2 provide 5V power to solid-state storage devices connected to the SATA ports.

SATA DOM Power Pin Definitions

Pin#	Definition
1	+5V
2	Ground
3	Ground

RAID Key Header

A RAID Key header is located at JRK1 on the motherboard. The RAID key is used to support NVMe SDD.

Intel RAID Key Pin Definitions

Pin#	Definition
1	Ground
2	3.3V Standby
3	Ground
4	PCH RAID Key

T-SGPIO1 Header

The T-SGPIO (Serial General Purpose Input/Output) header is used for the onboard SATA devices to communicate with the enclosure management chip on the backplane.

T-SGPIO1 Header Pin Definitions

Pin#	Definition	Pin#	Definition
1	NC	2	NC
3	Ground	4	DATA Out
5	Load	6	Ground
7	Clock	8	NC

NC = No Connection

I-SATA 3.0 and S-SATA 3.0 Ports

This motherboard has ten SATA 3.0 ports (I-SATA0-3, 4-7) and S-SATA0/S-SATA1. I-SATA0-3 and 4-7 ports are supported by the Intel PCH, while S-SATA0/1 are supported by Intel SCU. S-SATA1/2 can be used with Supermicro SuperDOMs, which are yellow SATA DOM connectors with built-in power pins that do not require external power cables. Supermicro SuperDOMs are backward-compatible with regular SATA HDDs or SATA DOMs that need external power cables.

TPM Header

The JTPM1 header is used to connect a Trusted Platform Module (TPM)/Port 80, which is available from a third-party vendor. A TPM/Port 80 connector is a security device that supports encryption and authentication in hard drives. It allows the motherboard to deny access if the TPM associated with the hard drive is not installed in the system. See the layout below for the location of the TPM header..

Trusted Platform Module Header Pin Definitions			
Pin#	Definition	Pin#	Definition
1	+3.3V	2	SPI_CS#
3	RESET#	4	SPI_MISO
5	SPI_CLK	6	GND
7	SPI_MOSI	8	
9	+3.3V Stby	10	SPI_IRQ#

Speaker Header

A speaker header is located on JD1. Close pins 1-2 of JD1 to use the onboard speaker.

4-pin BMC External I²C Header

A System Management Bus header for IPMI 2.0 is located at JIPMB1. Connect the appropriate cable here to use the IPMB I²C connection on your system. Refer to the table below for pin definitions.

External I²C Header Pin Definitions	
Pin#	Definition
1	Data
2	Ground
3	Clock
4	No Connection

Chassis Intrusion

A Chassis Intrusion header is located at JL1 on the motherboard. Attach the appropriate cable from the chassis to inform you of a chassis intrusion when the chassis is opened.

Chassis Intrusion Pin Definitions	
Pin#	Definition
1	Intrusion Input
2	Ground

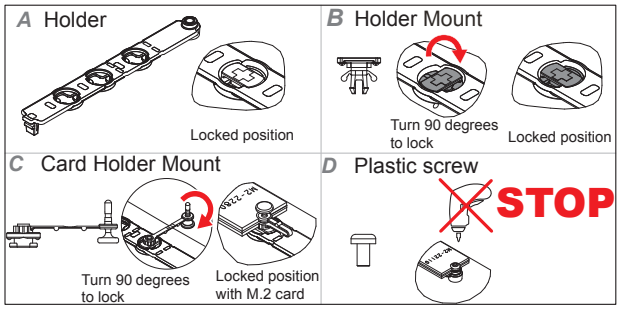
Standby Power

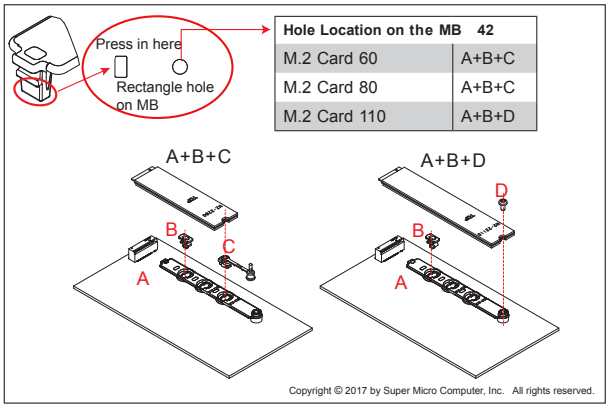
The Standby Power header is located at JSTBY1 on the motherboard. You must have a card with a Standby Power connector and a cable to use this feature.

Standby Power Pin Definitions	
Pin#	**Definition**
1	+5V Standby
2	Ground
3	No Connection

PCI-E M.2 Slots

This motherboard has two PCI-E M.2 slots (M.2-C1/M.2-C2). The M.2, formerly known as "Next Generation Form Factor (NGFF)" replaces a mini PCI-E slot. M.2 allows for a variety of card sizes and offers increased functionality and spatial efficiency. The M.2 socket on the motherboard supports PCI-E 3.0 X4 (32 Gb/s) SSD cards in the 2260, 2280 and 22110 form factors.





Control Panel

JF1 contains header pins for various control panel connections. See the figure below for the pin locations and definitions of the control panel buttons and LED indicators.

All JF1 wires have been bundled into a single cable to simplify this connection. Make sure the red wire plugs into pin 1 as marked on the motherboard. The other end connects to the control panel PCB board.

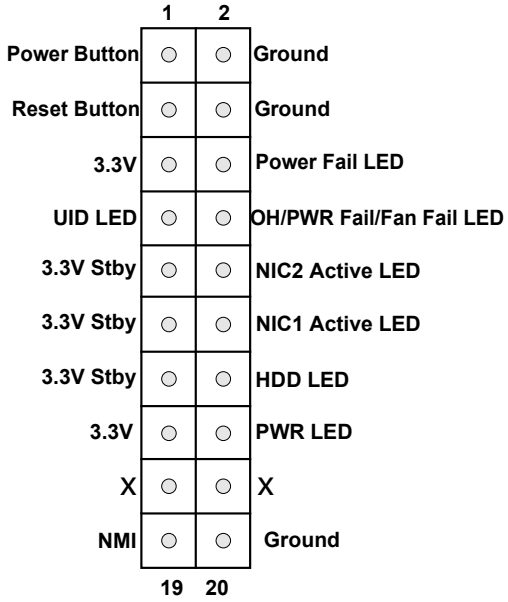


Figure 4-1. JF1: Control Panel Pins

Power Button

The Power Button connection is located on pins 1 and 2 of JF1. Momentarily contacting both pins will power on/off the system. This button can also be configured to function as a suspend button (with a setting in the BIOS - see Chapter 6). To turn off the power when the system is in suspend mode, press the button for 4 seconds or longer.

Power Button Pin Definitions (JF1)	
Pin#	**Definition**
1	Signal
2	Ground

Reset Button

The Reset Button connection is located on pins 3 and 4 of JF1. Attach it to a hardware reset switch on the computer case.

Reset Button Pin Definitions (JF1)	
Pin#	**Definition**
3	Reset
4	Ground

Power Fail LED

The Power Fail LED connection is located on pins 5 and 6 of JF1.

Power Fail LED Pin Definitions (JF1)	
Pin#	**Definition**
5	3.3V
6	PWR Supply Fail

OH/Fan Fail/PWR Fail/UID LED

Connect an LED cable to pins 7 and 8 of the Front Control Panel (JF1) to use UID/Overheat/ Fan Fail/Power Fail LED connections. The LED on pin 8 provides warnings of overheat, power failure or fan failure. Refer to the tables below for details.

Informational LED-UID/OH/PWR Fail/Fan Fail LED Pin Definitions (Pin 7 & Pin 8 of JF1)	
Status	**Description**
Solid red	An overheat condition has occurred. (This may be caused by cable congestion).
Blinking red (1Hz)	Fan failure: check for an inoperative fan.
Blinking red (0.25Hz)	Power failure: check for a non-operational power supply
Solid blue	Local UID is activated. Use this function to locate a unit in a rack mount environment that might be in need of service.
Blinking blue (300 msec)	Remote UID is on. Use this function to identify a unit from a remote location that might be in need of service.

NIC1/NIC2 (LAN1/LAN2)

The NIC (Network Interface Controller) LED connection for LAN port 1 is located on pins 11 and 12 of JF1, and LAN port 2 is on pins 9 and 10. Attach the NIC LED cables here to display network activity.

LAN1/LAN2 LED Pin Definitions (JF1)	
Pin#	**Definition**
9	NIC 2 Activity LED
10	3.3V Stdby
11	NIC 1 Activity LED
12	3.3V Stdby

HDD LED

The HDD LED connection is located on pins 13 and 14 of JF1. Attach a cable to pin 14 to show hard drive activity status.

HDD LED Pin Definitions (JF1)	
Pins	**Definition**
13	3.3V Stdby
14	HDD Active

Power LED

The Power LED connection is located on pins 15 and 16 of JF1.

Power LED Pin Definitions (JF1)	
Pins	**Definition**
15	3.3V
16	PWR LED

NMI Button

The non-maskable interrupt (NMI) button header is located on pins 19 and 20 of JF1.

NMI Button Pin Definitions (JF1)	
Pins	**Definition**
19	Control
20	Ground

4.3 Ports

VGA Port

The onboard VGA port is located next to IPMI LAN port on the I/O back panel. Use this connection for VGA display.

Serial Port

There is one COM port (COM1) on the I/O back panel on the motherboard. The COM port provides serial communications.

Ethernet Ports

Two Ethernet ports (LAN1, LAN2) are located on the I/O backplane. These Ethernet ports support 10GbE LAN connections. In addition, a 1 GbE dedicated IPMI LAN is located above USB 0/1 ports on the backplane. All Ethernet ports accept RJ45 type cables. Please refer to the LED Indicator Section for LAN LED information.

Universal Serial Bus (USB) Ports

Four USB 3.0 ports (USB 0/1, USB 2/3) are located on the I/O back panel. An internal USB header, located next to SATA 4~7, provides two USB 3.0 connections (USB2/3) for front access. In addition, A Type A USB header (USB6), located next to PCI-E Slot 1, also provides USB 3.0 connection for front access. The onboard headers can be used to provide front side USB access with a cable (not included).

Back Panel USB 0/1, 2/3 (3.0) Pin Definitions

Pin#	Definition	Pin#	Definition
A1	VBUS	B1	Power
A2	D-	B2	USB_N
A3	D+	B3	USB_P
A4	GND	B4	GND
A5	Stda_SSRX-	B5	USB3_RN
A6	Stda_SSRX+	B6	USB3_RP
A7	GND	B7	GND
A8	Stda_SSTX-	B8	USB3_TN
A9	Stda_SSTX+	B9	USB3_TP

Front Panel USB 4/5 (3.0) Pin Definitions

Pin#	Definition	Pin#	Definition
1	VBUS	19	Power
2	Stda_SSRX-	18	USB3_RN
3	Stda_SSRX+	17	USB3_RP
4	GND	16	GND
5	Stda_SSTX-	15	USB3_TN
6	Stda_SSTX+	14	USB3_TP
7	GND	13	GND
8	D-	12	USB_N
9	D+	11	USB_P
10		x	

Type A USB 6 (3.0) Pin Definitions

Pin#	Definition	Pin#	Definition
1	VBUS	5	SSRX-
2	USB_N	6	SSRX+
3	USB_P	7	GND
4	Ground	8	SSTX-
		9	SSTX+

Rear I/O Ports

See the figure below for the locations and descriptions of the various I/O ports on the rear of the motherboard.

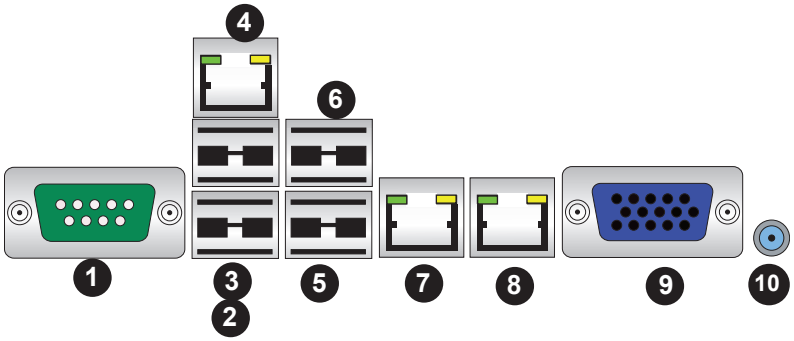


Figure 4-2. Rear I/O Ports

Rear I/O Ports			
#	**Description**	**#**	**Description**
1.	COM1	6.	USB 3 (USB 3.0)
2.	USB 0 (USB 3.0)	7.	10G LAN1 Port
3.	USB 1 (USB 3.0)	8.	10G LAN2 Port
4.	IPMI LAN	9.	VGA Port
5.	USB 2 (USB 3.0)	10.	Unit Identifier Switch (UID)

Unit Identifier Switch/UID LED Indicator

A Unit Identifier (UID) switch (UID) and a UID LED Indicator (LE1) are located on the I/O back panel. When you press the UID switch, the UID LED indicator will be turned on. Press the UID switch again to turn off the LED. The UID Indicator provides easy identification of a system unit that may be in need of service.

Note: UID can also be triggered via IPMI on the motherboard. For more information on IPMI, please refer to the IPMI User's Guide posted on our website at http://www.supermicro.com.

UID Switch Pin Definitions	
Pin#	**Definition**
1	Ground
2	Ground
3	Button In
4	Button In

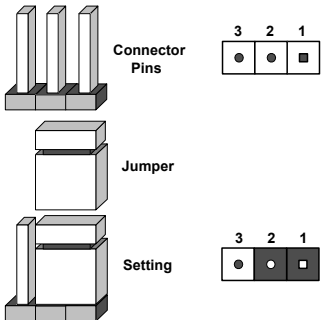
UID LED Pin Definitions	
Color	**Status**
Blue: On	Unit Identified

4.4 Jumpers

Explanation of Jumpers

To modify the operation of the motherboard, jumpers are used to choose between optional settings. Jumpers create shorts between two pins to change the function associated with it. Pin 1 is identified with a square solder pad on the printed circuit board. See the motherboard layout page for jumper locations.

Note: On a two-pin jumper, "Closed" means the jumper is on both pins and "Open" indicates the jumper is either on only one pin or has been completely removed.



CMOS Clear

JBT1 is used to clear CMOS, which will also clear any passwords. Instead of pins, this jumper consists of contact pads to prevent accidentally clearing the contents of CMOS.

To Clear CMOS

1. First power down the system and unplug the power cord(s).
2. Remove the cover of the chassis to access the motherboard.
3. Remove the onboard battery from the motherboard.
4. Short the CMOS pads with a metal object such as a small screwdriver for at least four seconds.
5. Remove the screwdriver (or shorting device).
6. Replace the cover, reconnect the power cord(s) and power on the system.

Notes: Clearing CMOS will also clear all passwords.

Do not use the PW_ON connector to clear CMOS.

VGA Enable/Disable

JPG1 allows you to enable or disable the VGA port using the onboard graphics controller.

The default setting is Enabled.

VGA Enable/Disable Jumper Settings	
Jumper Setting	**Definition**
Pins 1-2	Enabled
Pins 2-3	Disabled

LAN1/2 Enable/Disable

Change the setting of jumper JPL1 to enable or disable the LAN1 and LAN2 Ethernets ports, respectively.

The default setting is Enabled.

LAN1/2 Enable/Disable Jumper Settings	
Jumper Setting	**Definition**
Pins 1-2	Enabled
Pins 2-3	Disabled

Watch Dog

JWD controls the Watch Dog function. Watch Dog is a monitor that can reboot the system when a software application hangs. Jumping pins 1-2 will cause Watch Dog to reset the system if an application hangs. Jumping pins 2-3 will generate a non-maskable interrupt signal for the application that hangs. Watch Dog must also be enabled in BIOS.

The default setting is Reset.

Note: When Watch Dog is enabled, the user needs to write their own application software to disable it.

Watch Dog Jumper Settings	
Jumper Setting	**Definition**
Pins 1-2	Reset
Pins 2-3	NMI
Open	Disabled

I²C Bus for VRM

Jumpers JVRM1 and JVRM2 allow the VRM SMB clock and data to access the Baseboard Management Controller (BMC).

JVRM1 (VRM SMB Clock to BMC) Jumper Settings	
Jumper Setting	**Definition**
Closed	Enable (SMB Clock to BMC)
Open	Disable (SMB Clock to PCH)

JVRM2 (VRM SMB Data to BMC) Jumper Settings	
Jumper Setting	**Definition**
Closed	Enable (SMB Data to BMC)
Open	Disable (SMB Data to PCH)

Management Engine (ME) Recovery

Use jumper JPME1 to select ME Firmware Recovery mode, which will limit resource allocation for essential system operations only in order to maintain normal power operation and management. In the single operation mode, online upgrades will be available via Recovery mode.

Manufacturer Mode Jumper Settings	
Jumper Setting	**Definition**
Pins 1-2	Normal
Pins 2-3	ME Recovery

Manufacturing Mode Select

Close JPME2 to bypass SPI flash security and force the system to use Manufacturing Mode, which will allow you to flash the system firmware from a host server to modify system settings.

Manufacturing Mode Select Jumper Settings	
Jumper Setting	**Definition**
Pins 1-2	Normal (Default)
Pins 2-3	Manufacturing Mode

4.5 LED Indicators

LAN1/2 LEDs

The rear Ethernet ports have two LEDs. On each port, one LED indicates activity when flashing while the other LED may be green, amber or off to indicate the speed of the connection.

LAN1/2 Activity LED LED State		
Color	**Status**	**Definition**
Yellow	Flashing	Active

LAN1/2 Link LED LED State	
LED Color	**Definition**
Off	No connection, 10 Mb/s or 100 Mb/s
Amber	1 Gb/s

Dedicated IPMI LAN LEDs

The dedicated IPMI LAN has an amber LED on the right to indicate activity and a green LED on the left to indicate the speed of the connection.

IPMI LED Link and Activity LED States		
Color	**Status**	**Definition**
Link (left)	Solid green	100 Mb/s
Activity (right)	Flashing amber	Active

Onboard Power LED

LE2 is an Onboard Power LED. When this LED is on, it means power is present on the motherboard. Be sure to turn off the system and unplug the power cord(s) before removing or installing components

Onboard Power LED Indicator	
LED Color	**Definition**
Off	System Off (power cable not connected)
Green	System On

BMC Heartbeat LED

LEDM1 is the BMC heartbeat LED. When the LED is blinking green, BMC is functioning normally. See the table below for the LED status.

BMC Heartbeat LED Indicator	
LED Color	**Definition**
Green: Blinking	BMC Normal

Chapter 5

Software

After the hardware has been installed, you can install the Operating System (OS), configure RAID settings and install the drivers.

5.1 Microsoft Windows OS Installation

If you will be using RAID, you must configure RAID settings before installing the Windows OS and the RAID driver. Refer to the RAID Configuration User Guides posted on our website at www.supermicro.com/support/manuals.

Installing the OS

1. Create a method to access the MS Windows installation ISO file. That might be a DVD, perhaps using an external USB/SATA DVD drive, or a USB flash drive, or the IPMI KVM console.

2. Retrieve the proper RST/RSTe driver. Go to the Supermicro web page for your motherboard and click on "Download the Latest Drivers and Utilities", select the proper driver, and copy it to a USB flash drive.

3. Boot from a bootable device with Windows OS installation. You can see a bootable device list by pressing **F11** during the system startup.

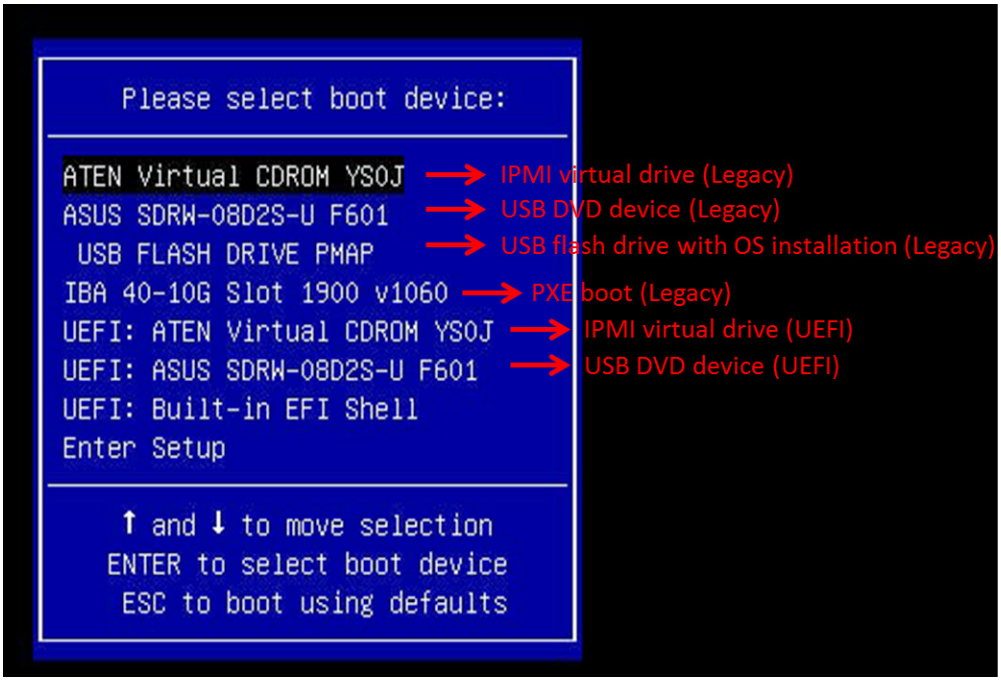


Figure 5-1. Select Boot Device

4. During Windows Setup, continue to the dialog where you select the drives on which to install Windows. If the disk you want to use is not listed, click on “Load driver” link at the bottom left corner.

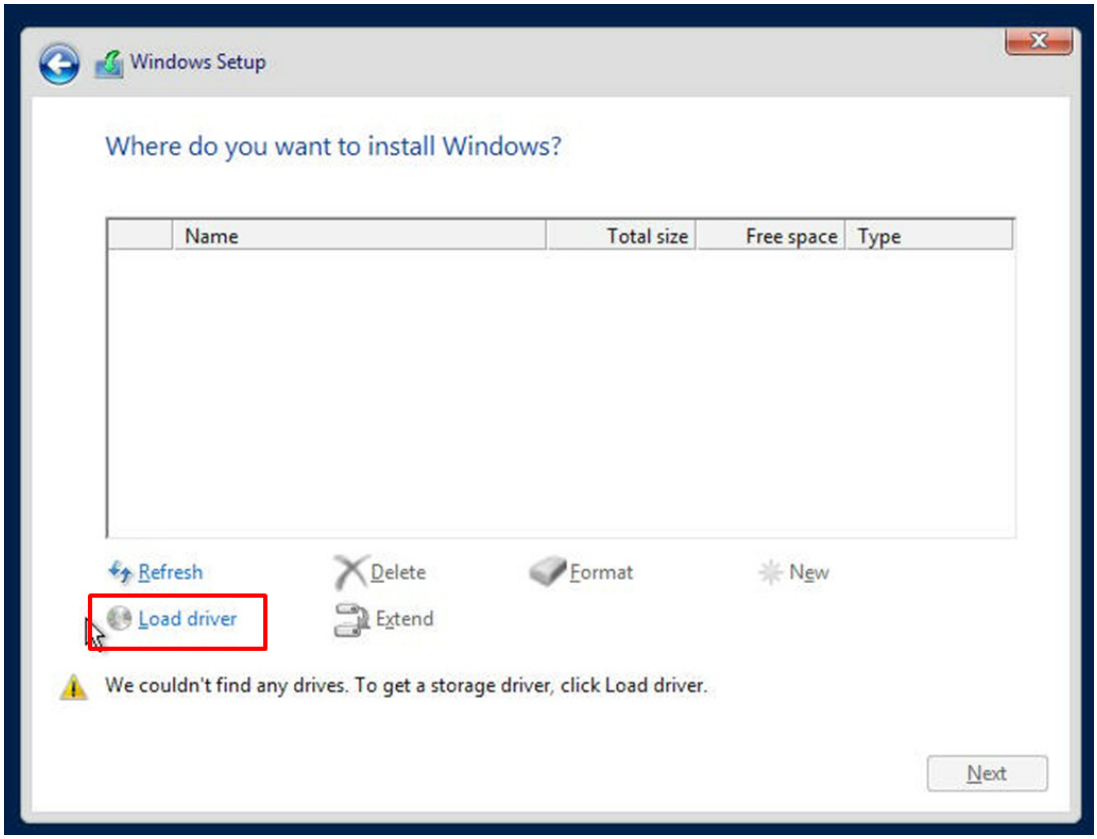


Figure 5-2. Load Driver Link

To load the driver, browse the USB flash drive for the proper driver files.

- For RAID, choose the SATA/sSATA RAID driver indicated then choose the storage drive on which you want to install it.
- For non-RAID, choose the SATA/sSATA AHCI driver indicated then choose the storage drive on which you want to install it.

5. Once all devices are specified, continue with the installation.
6. After the Windows OS installation has completed, the system will automatically reboot multiple times.

5.2 Driver Installation

The Supermicro website contains drivers and utilities for your system at https://www.supermicro.com/wftp/driver. Some of these must be installed, such as the chipset driver.

After accessing the website, go into the CDR_Images (in the parent directory of the above link) and locate the ISO file for your motherboard. Download this file to to a USB flash drive or a DVD. (You may also use a utility to extract the ISO file if preferred.)

Another option is to go to the Supermicro website at http://www.supermicro.com/products/. Find the product page for your motherboard, and "Download the Latest Drivers and Utilities".

Insert the flash drive or disk and the screenshot shown below should appear.

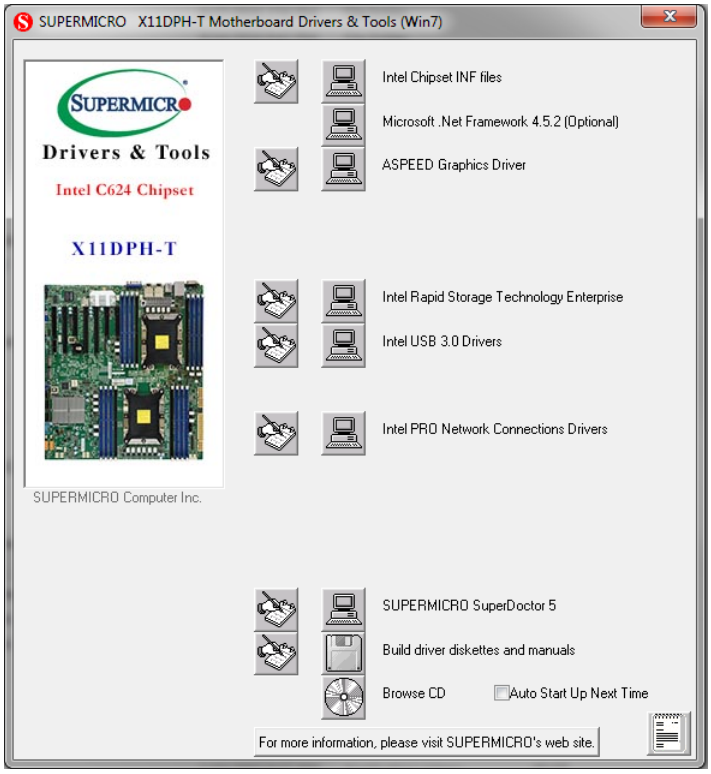


Figure 5-3. Driver & Tool Installation Screen

Note: Click the icons showing a hand writing on paper to view the readme files for each item. Click the computer icons to the right of these items to install each item (from top to the bottom) one at a time. **After installing each item, you must re-boot the system before moving on to the next item on the list.** The bottom icon with a CD on it allows you to view the entire contents.

5.3 SuperDoctor® 5

The Supermicro SuperDoctor 5 is a program that functions in a command-line or web-based interface for Windows and Linux operating systems. The program monitors such system health information as CPU temperature, system voltages, system power consumption, fan speed, and provides alerts via email or Simple Network Management Protocol (SNMP).

SuperDoctor 5 comes in local and remote management versions and can be used with Nagios to maximize your system monitoring needs. With SuperDoctor 5 Management Server (SSM Server), you can remotely control power on/off and reset chassis intrusion for multiple systems with SuperDoctor 5 or IPMI. SuperDoctor 5 Management Server monitors HTTP, FTP, and SMTP services to optimize the efficiency of your operation.

Note: The default User Name and Password for SuperDoctor 5 is ADMIN / ADMIN.

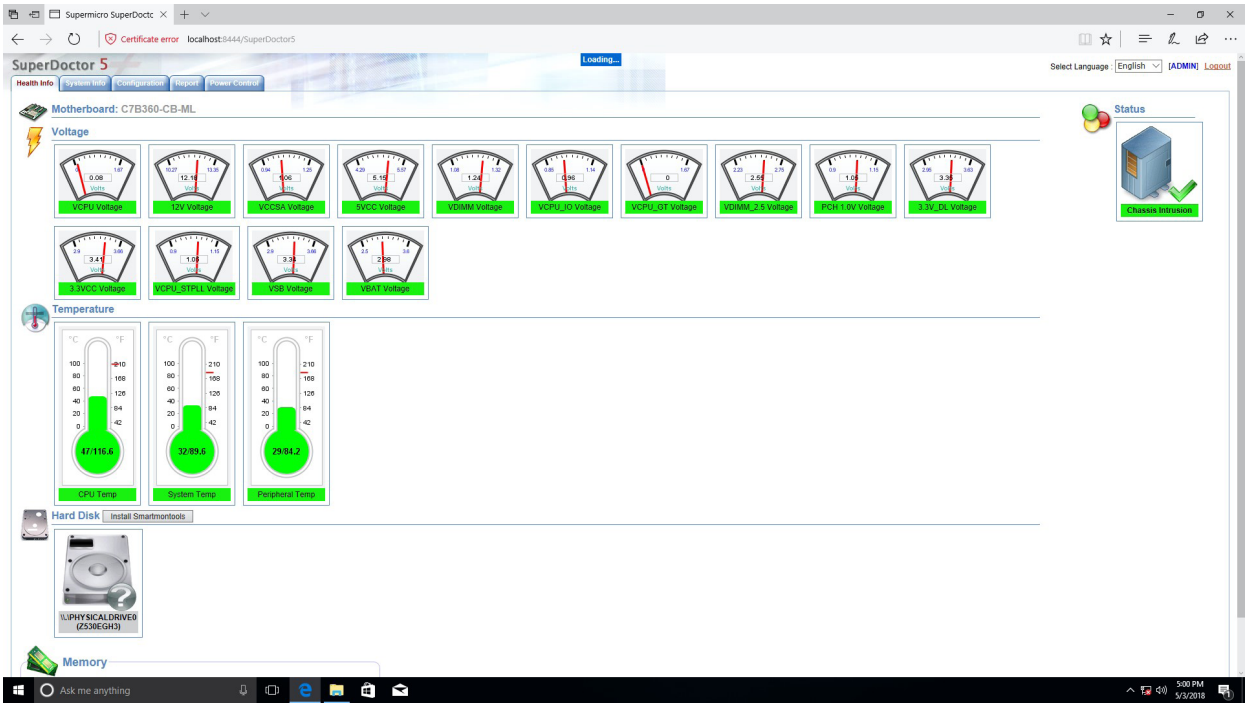


Figure 5-4. SuperDoctor 5 Interface Display Screen (Health Information)

5.4 IPMI

The X11DPH-T supports the Intelligent Platform Management Interface (IPMI). IPMI is used to provide remote access, monitoring and management. There are several BIOS settings that are related to IPMI.

For general documentation and information on IPMI, please visit our website at: http://www.supermicro.com/products/nfo/IPMI.cfm.

Chapter 6

UEFI BIOS

6.1 Introduction

This chapter describes the UEFI BIOS Setup utility for the X11DPH-T motherboard. The BIOS is stored on a chip and can be easily upgraded using a flash program.

Note: Due to periodic changes to the BIOS, some settings may have been added or deleted and might not yet be recorded in this manual. Please refer to the Manual Download area of our website for any changes to BIOS that may not be reflected in this manual.

Starting the Setup Utility

To enter the BIOS setup utility, press the <Delete> key while the system is booting up. (In most cases, the <Delete> key is used to invoke the BIOS setup screen. There are a few cases when other keys are used, such as <F1>, <F2>, etc.) Each main BIOS menu option is described in this manual.

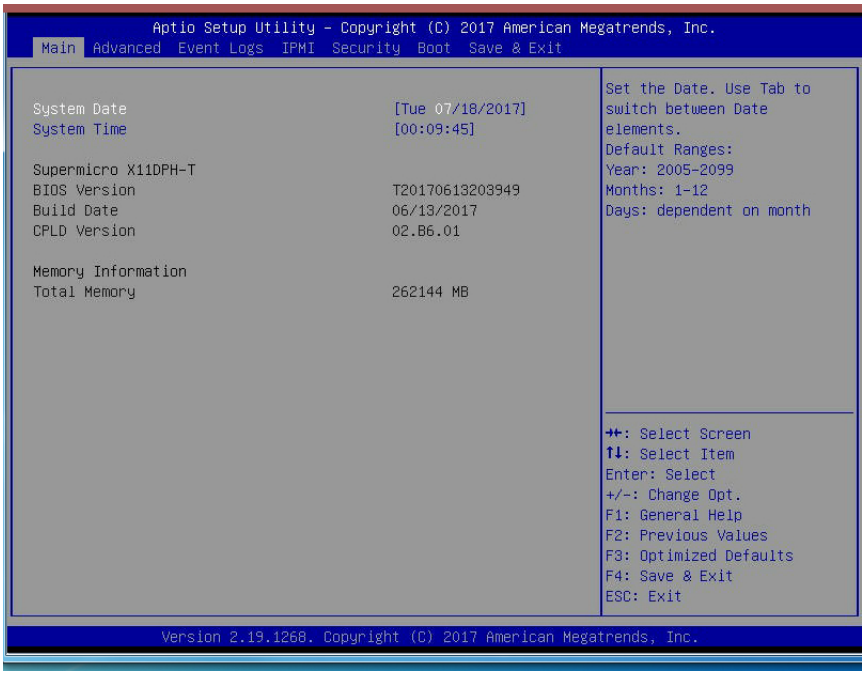
The Main BIOS screen has two main frames. The left frame displays all the options that can be configured. “Grayed-out” options cannot be configured. The right frame displays the key legend. Above the key legend is an area reserved for a text message. When an option is selected in the left frame, it is highlighted in white. Often a text message will accompany it. (Note that BIOS has default text messages built in. We retain the option to include, omit, or change any of these text messages.) Settings printed in **Bold** are the default values.

A "▶" indicates a submenu. Highlighting such an item and pressing the <Enter> key will open the list of settings within that submenu.

The BIOS setup utility uses a key-based navigation system called hot keys. Most of these hot keys (<F1>, <F10>, <Enter>, <ESC>, <Arrow> keys, etc.) can be used at any time during the setup navigation process.

6.2 Main Setup

When you first enter the AMI BIOS setup utility, you will enter the Main setup screen. You can always return to the Main setup screen by selecting the Main tab on the top of the screen. The Main BIOS setup screen is shown below. The following Main menu items will be displayed:



System Date/System Time

Use this feature to change the system date and time. Highlight *System Date* or *System Time* using the arrow keys on the keyboard. Press the <Tab> key or the arrow keys to move between fields. The date must be entered in Day MM/DD/YYYY format. The time is entered in HH:MM:SS format.

Note: The time is in the 24-hour format. For example, 5:30 P.M. appears as 17:30:00. The date's default value is 01/01/2014 after RTC reset.

Supermicro X11DPH-T

BIOS Version

This item displays the version of the BIOS ROM used in the system.

Build Date

This item displays the date when the version of the BIOS ROM used in the system was built.

CPLD Version

This item displays the version of the CPLD (Complex-Programmable Logical Device) used in the system.

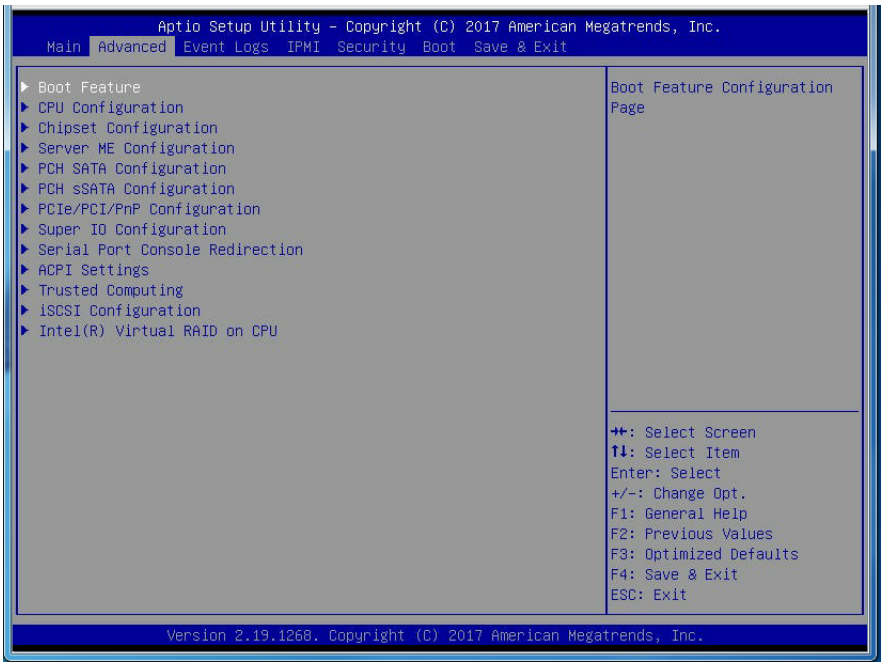
Memory Information

Total Memory

This item displays the total size of memory available in the system.

6.3 Advanced Setup Configurations

Use the arrow keys to select the Advanced submenu and press <Enter> to access the submenu items.



Warning: Take Caution when changing the Advanced settings. An incorrect value, an incorrect DRAM frequency, or an incorrect BIOS timing setting may cause the system to malfunction. When this occurs, restore the setting to the manufacture default setting.

▶Boot Feature

Quiet Boot

Use this feature to select the screen between displaying POST messages or the OEM logo at bootup. Select Disabled to display the POST messages. Select Enabled to display the OEM logo instead of the normal POST messages. The options are **Enabled** and Disabled.

Note: POST message is always displayed regardless of the item setting.

Option ROM Messages

Use this feature to set the display mode for the Option ROM. Select Keep Current to use the current AddOn ROM display setting. Select Force BIOS to use the Option ROM display mode set by the system BIOS. The options are **Force BIOS** and Keep Current.

Bootup NumLock State

Use this feature to set the Power-on state for the Numlock key. The options are Off and **On**.

Wait For 'F1' If Error

Select Enabled to force the system to wait until the 'F1' key is pressed if an error occurs. The options are Disabled and **Enabled**.

INT19 Trap Response

Interrupt 19 is the software interrupt that handles the boot disk function. When this item is set to Immediate, the ROM BIOS of the host adaptors will "capture" Interrupt 19 at bootup immediately and allow the drives that are attached to these host adaptors to function as bootable disks. If this item is set to Postponed, the ROM BIOS of the host adaptors will not capture Interrupt 19 immediately and allow the drives attached to these adaptors to function as bootable devices at bootup. The options are **Immediate** and Postponed.

Re-try Boot

When EFI (Expansible Firmware Interface) Boot is selected, the system BIOS will automatically reboot the system from an EFI boot device after an initial boot failure. Select Legacy Boot to allow the BIOS to automatically reboot the system from a Legacy boot device after an initial boot failure. The options are Disabled, **Legacy Boot**, and EFI Boot.

Install Windows 7 USB Support

Select Enabled to install Windows 7 and the XHCI drivers for USB keyboard/mouse support. After you've installed the Windows 7 and XHCI drivers, be sure to set this feature to "Disabled" (default). The options are **Disabled** and Enabled.

Port 61h Bit-4 Emulation

Select Enabled for I/O Port 61h-Bit 4 emulation support to enhance system performance. The options are Enabled and **Disabled**.

Power Configuration

Watch Dog Function

Select Enabled to allow the Watch Dog timer to reboot the system when it is inactive for more than 5 minutes. The options are Enabled and **Disabled.**

Restore on AC Power Loss

Use this feature to set the power state after a power outage. Select Power-Off for the system power to remain off after a power loss. Select Power-On for the system power to be turned on after a power loss. Select Last State to allow the system to resume its last power state before a power loss. The options are Stay-Off, Power-On, and **Last State**.

Power Button Function

This feature controls how the system shuts down when the power button is pressed. Select 4 Seconds Override for the user to power off the system after pressing and holding the power button for 4 seconds or longer. Select Instant Off to instantly power off the system as soon as the user presses the power button. The options are 4 Seconds Override and **Instant Off**.

Throttle on Power Fail

Select Enabled to decrease system power input by throttling CPU frequency when the power supply fails. The options are Enabled and **Disabled.**

▶CPU Configuration

Warning: Setting the wrong values in the following sections may cause the system to malfunction.

▶Processor Configuration

The following CPU information will be displayed:

- Processor BSP Revision
- Processor Socket
- Processor ID
- Processor Frequency
- Processor Max Ratio
- Processor Min Ratio
- Microcode Revision
- L1 Cache RAM
- L2 Cache RAM
- L3 Cache RAM
- Processor 0 Version
- Processor 1 Version

Hyper-Threading (ALL)

Select Enable to use Intel Hyper-Threading Technology to enhance CPU performance. The options are **Enable** and Disable.

Execute Disable Bit (Available if supported by the OS & the CPU)

Select Enable to enable Execute Disable Bit support which will allow the processor to designate areas in the system memory where an application code can execute and where it cannot, thus preventing a worm or a virus from flooding illegal codes to overwhelm the processor, damaging the system during a virus attack. The options are **Enable** and Disable. (Refer to Intel and Microsoft websites for more information.)

Intel Virtualization Technology

Select Enable to use Intel Virtualization Technology which will allow the I/O device assignments to be directly reported to the VMM (Virtual Memory Management) through the DMAR ACPI tables. This feature offers fully-protected I/O resource-sharing across the Intel platforms, providing the user with greater reliability, security and availability in networking and data-sharing. The settings are **Enable** and Disable.

PPIN Control

Select Unlock/Enable to use the Protected-Processor Inventory Number (PPIN) in the system. The options are **Unlock/Enable** and Unlock/Disable.

Hardware Prefetcher (Available when supported by the CPU)

If this feature is set to Enable, the hardware prefetcher will prefetch streams of data and instructions from the main memory to the Level 2 (L2) cache to improve CPU performance. The options are Disable and **Enable**.

Adjacent Cache Prefetch (Available when supported by the CPU)

Select Enable for the CPU to prefetch both cache lines for 128 bytes as comprised. Select Disable for the CPU to prefetch both cache lines for 64 bytes. The options are Disable and **Enable**.

Note: Please power off and reboot the system for the changes you've made to take effect. Please refer to Intel's website for detailed information.

DCU Streamer Prefetcher (Available when supported by the CPU)

If this feature is set to Enable, the DCU (Data Cache Unit) streamer prefetcher will prefetch data streams from the cache memory to the DCU (Data Cache Unit) to speed up data accessing and processing for CPU performance enhancement. The options are Disable and **Enable**.

DCU IP Prefetcher

If this feature is set to Enable, the IP prefetcher in the DCU (Data Cache Unit) will prefetch IP addresses to improve network connectivity and system performance. The options are **Enable** and Disable.

LLC Prefetch

If this feature is set to Enable, LLC (hardware cache) prefetching on all threads will be supported. The options are **Disable** and Enable.

Extended APIC (Extended Advanced Programmable Interrupt Controller)

Based on the Intel Hyper-Threading technology, each logical processor (thread) is assigned 256 APIC IDs (APIDs) in 8-bit bandwidth. When this feature is set to Enable, the APIC ID will be expanded from 8 bits to 16 bits to provide 512 APIDs to each thread to enhance CPU performance. The options are **Disable** and Enable.

AES-NI

Select Enable to use the Intel Advanced Encryption Standard (AES) New Instructions (NI) to ensure data security. The options are **Enable** and Disable.

▶Advanced Power Management Configuration

▶CPU P State Control

SpeedStep (PStates)

EIST (Enhanced Intel SpeedStep Technology) allows the system to automatically adjust processor voltage and core frequency in an effort to reduce power consumption and heat dissipation. Please refer to Intel's website for detailed information. The options are Disable and **Enable**.

EIST PSD Function (Available when SpeedStep is set to Enable)

Use this feature to configure the processor's P-State coordination settings. During a P-State, the voltage and frequency of the processor will be reduced when it is in operation. This makes the processor more energy efficient, resulting in further energy gains. The options are **HW_ALL**, SW_ALL and SW-ANY.

Turbo Mode (Available when SpeedStep is set to Enable)

Select Enable for processor cores to run faster than the frequency specified by the manufacturer. The options are Disable and **Enable**.

▶Hardware PM (Power Management) State Control

Hardware P-States

If this feature is set to Disable, hardware will choose a P-state setting for the system based on an OS request. If this feature is set to Native Mode, hardware will choose a P-state setting based on OS guidance. If this feature is set to Native Mode with No Legacy Support, hardware will choose a P-state setting independently without OS guidance. The options are **Disable**, Native Mode, Out of Band Mode, and Native Mode with No Legacy Support.

▶CPU C State Control

Autonomous Core C-State

Select Enable to support Autonomous Core C-State control which will allow the processor core to control its C-State setting automatically and independently. The options are Enable and **Disable**.

CPU C6 Report

Select Enable to allow the BIOS to report the CPU C6 state (ACPI C3) to the operating system. During the CPU C6 state, power to all caches is turned off. The options are **Auto**, Enable, and Disable.

Enhanced Halt State (C1E)

Select Enable to enable "Enhanced Halt State" support, which will significantly reduce the CPU's power consumption by minimizing CPU's clock cycles and reduce voltage during a "Halt State." The options are Disable and **Enable**.

▶Package C State Control

Package C State

Use this feature to set the limit on the C-State package register. The options are C0/1 state, C2 state, C6 (non-Retention) state, C6 (Retention) state, No Limit, and **Auto**.

▶CPU T State Control

Software Controlled T-States

If this feature is set to Enable, CPU throttling settings will be supported by the software of the system. The options are **Disable** and Enable.

▶Chipset Configuration

Warning: Setting the wrong values in the following sections may cause the system to malfunction.

▶North Bridge

This feature allows the user to configure the settings for the Intel North Bridge.

▶UPI (Ultra Path Interconnect) Configuration

This section displays the following UPI General Configuration information:

- Number of CPU
- Number of IIO
- Current UPI Link Speed
- Current UPI Link Frequency
- UPI Global MMIO Low Base/Limit
- UPI Global MMIO High Base/Limit
- UPI PCI-E Configuration Base/Size

Degrade Precedence

Use this feature to select the degrading precedence option for Ultra Path Interconnect connections. Select Topology Precedent to degrade UPI features if system options are in conflict. Select Feature Precedent to degrade UPI topology if system options are in conflict. The options are **Topology Precedence** and Feature Precedence.

Link L0p Enable

Select Enable to enable Link L0p. The options are Disable, Enable, and **Auto**.

Link L1 Enable

Select Enable to enable Link L1 (Level 1 link). The options are Disable, Enable, and **Auto**.

IO Directory Cache (IODC)

Select Enable for the IODC (I/O Directory Cache) to generate snoops instead of generating memory lockups for remote IIO (InvIToM) and/or WCiLF (Cores). Select Auto for the IODC to generate snoops (instead of memory lockups) for WCiLF (Cores). The options are Disable, **Auto**, Enable for Remote InvItoM Hybrid Push, InvItoM AllocFlow, Enable for Remote InvItoM Hybrid AllocNonAlloc, and Enable for Remote InvItoM and Remote WViLF.

SNC

Select Enable to use the feature of "Secure Network Communications" (SNC), which supports full SNC (2-cluster) interleave and 1-way IMC interleave. Select Auto for 1-cluster or 2-cluster support depending on the satuts of IMC (Integrated Memory Controller) Interleaving. The options are **Disable**, Enable, and Auto.

XPT Prefetch

Select Enable to support XPT Prefetching to enhance system performance. The options are **Enable** and Disable.

KTI Prefetch

Select Enable to support KTI Prefetching to enhance system performance. The options are **Enable** and Disable.

Local/Remote Threshold

Use this feature to configure the threshold settings for local and remote systems that are connected in the network. The options are Disable, **Auto**, Low, Medium, and High.

Stale AtoS (A to S)

Select Enable to remove the contents and the structures of the files that are no longer needed in the remote host server but are still in use by the local client machine from Directory A to Directory S in the NFS (Network File System) to optimize system performance. The options are **Disable**, Enable, and Auto.

LLC Dead Line Alloc

Select Enable to opportunistically fill the deadlines in LLC. The options are **Enable**, Disable, and Auto.

Isoc Mode

Select Enable to enable Isochronous support to meet QoS (Quality of Service) requirements. This feature is especially important for Virtualization Technology. The options are Disable, Enable, and **Auto**.

▶Memory Configuration

Enforce POR

Select POR to enforce POR restrictions for DDR4 memory frequency and voltage programming. The options are **POR** and Disable.

Memory Frequency

Use this feature to set the maximum memory frequency for onboard memory modules. The options are **Auto**, 1866, 2000, 2133, 2200, 2400, 2600, and 2666.

Data Scrambling for NVDIMM

Select Enable to enable data scrambling for onboard NVDIMM memory to enhance system performance and security. The options are **Auto**, Disable, and Enable.

Data Scrambling for DDR4

Select Enable to enable data scrambling for DDR4 memory to enhance system performance and security. The options are **Auto**, Disable, and Enable.

tCCD_L Relaxation

If this feature is enabled, SPD (Serial Presence Detect) will override tCCD_L ("Column to Column Delay-Long", or “Command to Command Delay-Long” on the column side.) If this feature is set to Disable, tCCD_L will be enforced based on the memory frequency. The options are Disable and **Auto**

Enable ADR

Select Enable for ADR (Automatic Diagnostic Repository) support to enhance memory performance. The options are Enable and **Disable**.

2X Refresh

Select Enable for memory 2X refresh support to enhance memory performance. The options are Enable and **Auto**.

Page Policy

Use this feature to set the page policy for onboard memory support The options are Closed, Adaptive and **Auto**.

IMC Interleaving

Use this feature to configure interleaving settings for the IMC (Integrated Memory Controller), which will improve memory performance. The options are 1-way Interleaving, 2-way Interleaving, and **Auto**.

▶Memory Topology

This item displays the information of onboard memory modules as detected by the BIOS.

- P1 DIMMA1/P1 DIMMA2/P1 DIMMB1/P1 DIMMC1/P1 DIMMD1/P1 DIMMD2/P1 DIMME1/P1 DIMMF1/
- P2 DIMMA1/P2 DIMMA2/P2 DIMMB1/P2 DIMMC1/P2 DIMMD1/P2 DIMMD2/P2 DIMME1/P2 DIMMF1

▶Memory RAS (Reliability_Availability_Serviceability) Configuration

Use this submenu to configure the following Memory RAS settings.

Static Virtual Lockstep Mode

Select Enable to support Static Virtual Lockstep mode to enhance memory performance. The options are Enable and **Disable**.

Mirror Mode

Use this feature to configure the mirror mode settings for all 1LM/2LM memory modules installed in the system which will create a duplicate copy of data stored in the memory to increase memory security, but it will reduce the memory capacity into half. The options are **Disable**, Mirror Mode 1LM, and Mirror Mode 2LM.

UEFI ARM Mirror

If this feature is set to Enable, mirror mode configuration settings for UEFI-based Address Range memory will be activated upon system boot. This will create a duplicate copy of data stored in the memory to increase memory security, but it will reduce the memory capacity into half. The options are **Disable** and Enable.

Memory Rank Sparing

Select Enable to support memory-rank sparing to optimize memory performance. The options are Enable and **Disable**.

Note: This item will not be available when memory mirror mode is enabled.

Correctable Error Threshold

Use this item to enter the threshold value for correctable memory errors. The default setting is 10.

SDDC Plus One

Select Enable for SDDC (Single Device Data Correction) Plus One support, which will increase the reliability and serviceability of your system memory. The options are Enable and **Disable**.

ADDDC (Adaptive Double Device Data Correction) Sparing

Select Enable for ADDDC sparing support to enhance memory performance. The options are Enable and **Disable**.

Patrol Scrub

Patrol Scrubbing is a process that allows the CPU to correct correctable memory errors detected in a memory module and send the corrections to the requestor (the original source). When this item is set to Enable, the IO hub will read and write back one cache line every 16K cycles if there is no delay caused by internal processing. By using this method, roughly 64 GB of memory behind the IO hub will be scrubbed every day. The options are **Enable** and Disable.

Patrol Scrub Interval

Use this item to specify the number of hours (between 0 to 24) required for the system to complete a full patrol scrubbing. Enter 0 for patrol scrubbing to be performed automatically. The default setting is **24**.

Note: This item is hidden when Patrol Scrub item is set to Disable.

▶IIO Configuration

EV DFX (Device Function On-Hide) Features

When this feature is set to Enable, the EV_DFX Lock Bits that are located in a processor will always remain clear during electric tuning. The options are **Disable** and Enable.

▶CPU1 Configuration/CPU2 Configuration

IOU0 (IIO PCIe Br1)

This feature configures the PCI-E Bifuraction setting for a PCI-E port specified by the user. The options are x4x4x4x4, x4x4x8, x8x4x4, x8x8, x16, and **Auto**.

IOU1 (IIO PCIe Br2)

This feature configures the PCI-E Bifuraction setting for a PCI-E port specified by the user. The options are x4x4x4x4, x4x4x8, x8x4x4, x8x8, x16, and **Auto**.

IOU2 (IIO PCIe Br3)

This feature configures the PCI-E Bifuraction setting for a PCI-E port specified by the user. The options are x4x4x4x4, x4x4x8, x8x4x4, x8x8, x16, and **Auto**.

MCP0 (IIO PCIe Br4)

This feature configures the PCI-E Bifuraction setting for a PCI-E port specified by the user. The options are x16 and **Auto**.

MCP1 (IIO PCIe Br5)

This feature configures the PCI-E Bifuraction setting for a PCI-E port specified by the user. The options are x16 and **Auto**.

▶CPU1 PCI-E Br0D00F0 - Port 0/DMI (Available for CPU 1 Configuration only)

Link Speed

This feature configures the link speed of a PCI-E port specified by the user. The options are **Auto**, Gen 1 (Generation 1) (2.5 GT/s), Gen 2 (Generation 2) (5 GT/s), and Gen 3 (Generation 3) (8 GT/s)

The following information will be displayed as well:

- PCI-E Port Link Status
- PCI-E Port Link Max
- PCI-E Port Link Speed

PCI-E Port Clocking (Available for CPU 1 Configuration only)

Use this feature to configure port overclocking settings between the port specified above and downstream components. The options are Distinct and **Common**.

PCI-E Port Max (Maximum) Payload Size (Available for CPU 1 Configuration only)

Select Auto for the system BIOS to automatically set the maximum payload value for a PCI-E device specified by to user to enhance system performance. The options are **Auto**, 128B, and 256B.

▶IOAT Configuration

Disable TPH (TLP Processing Hint)

TPH is used for data-tagging with a destination ID and a few important attributes. It can send critical data to a particular cache without writing through to memory. Select No in this item for TLP Processing Hint support, which will allow a "TPL request" to provide "hints" to help optimize the processing of each transaction occurred in the target memory space. The options are Yes and **No**.

Prioritize TPH (TLP Processing Hint)

Select Yes to prioritize the TPL requests that will allow the "hints" to be sent to help facilitate and optimize the processing of certain transactions in the system memory. The options are Enable and **Disable**.

Relaxed Ordering

Select Enable to enable Relaxed Ordering support which will allow certain transactions to violate the strict-ordering rules of PCI and to be completed prior to other transactions that have already been enqueued. The options are **Disable** and Enable.

▶Intel VT for Directed I/O (VT-d)

Intel® VT for Directed I/O (VT-d)

Select Enable to use Intel Virtualization Technology support for Direct I/O VT-d by reporting the I/O device assignments to the VMM (Virtual Machine Monitor) through the DMAR ACPI tables. This feature offers fully-protected I/O resource sharing across Intel platforms, providing greater reliability, security and availability in networking and data-sharing. The options are **Enable** and Disable.

Interrupt Remapping

Select Enable for Interrupt Remapping support to enhance system performance. The options are **Enable** and Disable.

PassThrough DMA

Select Enable for the Non-Iscoh VT-d engine to pass through DMA (Direct Memory Access) to enhance system performance. The options are **Enable** and Disable.

ATS

Select Enable to enable ATS (Address Translation Services) support for the Non-Iscoh VT-d engine to enhance system performance. The options are **Enable** and Disable.

Posted Interrupt

Select Enable to support VT_D Posted Interrupt which will allow external interrupts to be sent directly from a direct-assigned device to a client machine in non-root mode to improve virtualization efficiency by simplifying interrupt migration and lessening the need of physical interrupts. The options are **Enable** and Disable.

Coherency Support (Non-Isoch)

Select Enable for the Non-Iscoh VT-d engine to pass through DMA (Direct Memory Access) to enhance system performance. The options are **Enable** and Disable.

▶Intel VMD Technology

▶Intel VMD for Volume Management Device on CPU1/CPU2

VMD Configuration for PStack0/VMD Configuration for PStack1/VMD Configuration for PStack2

Intel VMD for Volume Management Device

Select Enable to enable Intel Volume Management Device support for the device specified by the user. The options are **Disable** and Enable.

IIO-PCIE Express Global Options

PCI-E Completion Timeout Disable

Select Yes to disable the PCI-E Completion Time-out settings. The options are **Yes**, No, and Per-Port.

▶South Bridge

The following South Bridge information will display:

- USB Module Version
- USB Devices

Legacy USB Support

Select Enabled to support onboard legacy USB devices. Select Auto to disable legacy support if there are no legacy USB devices present. Select Disable to have all USB devices available for EFI applications only. The options are **Enabled,** Disabled and Auto.

XHCI Hand-Off

This is a work-around solution for operating systems that do not support XHCI (Extensible Host Controller Interface) hand-off. The XHCI ownership change should be claimed by the XHCI driver. The options are Enabled and **Disabled**.

Port 60/64 Emulation

Select Enabled for I/O port 60h/64h emulation support, which in turn, will provide complete legacy USB keyboard support for the operating systems that do not support legacy USB devices. The options are **Enabled** and Disabled.

▶Server ME (Management Engine) Configuration

This feature displays the following system ME configuration settings.

General ME Configuration

Operational Firmware Version

Backup Firmware Version

Recovery Firmware Version

ME Firmware Status #1/ME Firmware Status #2

Current State

Error Code

▶PCH SATA Configuration

When this submenu is selected, the AMI BIOS automatically detects the presence of the SATA devices that are supported by the Intel PCH chip and displays the following items:

SATA Controller

This item enables or disables the onboard SATA controller supported by the Intel PCH chip. The options are **Enable** and Disable.

Configure SATA as (Available when the item above: SATA Controller is set to enabled)

Select AHCI to configure a SATA drive specified by the user as an AHCI drive. Select RAID to configure a SATA drive specified by the user as a RAID drive. The options are **AHCI** and RAID. (**Note:** This item is hidden when the SATA Controller item is set to Disabled.)

SATA HDD Unlock

Select Enable to unlock SATA HDD password in the OS. The options are **Enable** and Disable.

SATA RSTe Boot Info (Available when the item "Configure SATA as" is set to "RAID")

Select Enable to enable full int13h support for devices connected to the SATA controller which will allow these SATA devices to be used as boot devices for system boot. The options are Disable and **Enable**.

Aggressive Link Power Management

When this item is set to Enabled, the SATA AHCI controller manages the power use of the SATA link. The controller will put the link in a low power mode during an extended period of I/O inactivity, and will return the link to an active state when I/O activity resumes. The options are Enable and **Disable**.

SATA RAID Option ROM/UEFI Driver (Available when the item "Configure SATA as" is set to "RAID")

Select EFI to load the EFI driver for system boot. Select Legacy to load a legacy driver for system boot. The options are Disable, EFI, and **Legacy**.

SATA Port 0 - SATA Port 7

Hot Plug

Select Enable to support Hot-plugging for the device installed on a selected SATA port which will allow the user to replace the device installed in the slot without shutting down the system. The options are Enable and **Disable**.

Spin Up Device

On an edge detect from 0 to 1, set this item to allow the SATA device installed on the SATA port specified by the user to start a COMRESET initialization. The options are Enable and **Disable**.

SATA Device Type

Use this item to specify if the device installed on the SATA port selected by the user should be connected to a Solid State drive or a Hard Disk Drive. The options are **Hard Disk Drive** and Solid State Drive.

▶PCH sSATA Configuration

When this submenu is selected, AMI BIOS automatically detects the presence of the sSATA devices that are supported by the PCH sSATA controller and displays the following items:

sSATA Controller

This item enables or disables the onboard sSATA controller supported by the Intel SCU. The options are **Enable** and Disable.

Configure sSATA as

Select AHCI to configure an sSATA drive specified by the user as an AHCI drive. Select RAID to configure an sSATA drive specified by the user as a RAID drive. The options are **AHCI** and RAID. (**Note:** This item is hidden when the sSATA Controller item is set to Disabled.)

SATA HDD Unlock

Select Enable to unlock sSATA HDD password in the OS. The options are **Enable** and Disable.

sSATA RSTe Boot Info (Available when the item "Configure SATA as" is set to "RAID")

Select Enable to enable full int13h support for devices connected to the SATA controller which will allow these SATA devices to be used as boot devices for system boot. The options are Disable and **Enable**.

Aggressive Link Power Management

When this item is set to Enable, the sSATA AHCI controller manages the power use of the SATA link. The controller will put the link in a low power mode during an extended period of I/O inactivity, and will return the link to an active state when I/O activity resumes. The options are **Disable** and Enable.

sSATA RAID Option ROM/UEFI Driver (Available when the item "Configure SATA as" is set to "RAID")

Select EFI to load the EFI driver for system boot. Select Legacy to load a legacy driver for system boot. The options are Disable, EFI, and **Legacy**.

sSATA Port 0/sSATA Port 1

Hot Plug

Select Enable to support Hot-plugging for the device installed on an sSATA port selected by the user which will allow the user to replace the device installed in the slot without shutting down the system. The options are **Disable** and Enabled.

Spin Up Device

On an edge detect from 0 to 1, set this item to allow the sSATA device installed on the sSATA port specified by the user to start a COMRESET initialization. The options are Enable and **Disable**.

sSATA Device Type

Use this item to specify if the device installed on the sSATA port specified by the user should be connected to a Solid State drive or a Hard Disk Drive. The options are **Hard Disk Drive** and Solid State Drive.

▶PCIe/PCI/PnP Configuration

The following PCI information will be displayed:

- PCI Bus Driver Version
- PCI Devices Common Settings:

Above 4G Decoding (Available if the system supports 64-bit PCI decoding)

Select Enabled to decode a PCI device that supports 64-bit in the space above 4G Address. The options are **Enabled** and Disabled.

SR-IOV Support (Available if the system supports Single-Root Virtualization)

Select Enabled for Single-Root IO Virtualization support. The options are Enabled and **Disabled.**

MMIO High Base

Use this feature to select the base memory size according to memory-address mapping for the IO hub. The base memory size must be between 4032G to 4078G. The options are **56T**, 40T, 24T, 16T, 4T, and 1T.

MMIO High Granularity Size

Use this feature to select the high memory size according to memory-address mapping for the IO hub. The options are 1G, 4G, 16G, 64G, **256G**, and 1024G.

PCI PERR/SERR Support

Use this feature to enable or disable the runtime event for SERR (System Error)/ PERR (PCI/ PCI-E Parity Error). The options are Enabled and **Disbled**.

Maximum Read Request

Select Auto for the system BIOS to automatically set the maximum size for a read request for a PCI-E device to enhance system performance. The options are **Auto**, 128 Bytes, 256 Bytes, 512 Bytes, 1024 Bytes, 2048 Bytes, and 4096 Bytes.

MMCFG Base

This feature determines the lowest MMCFG (Memory-Mapped Configuration) base assigned to PCI devices. The options are 1G, 1.5G, 1.75G. **2G**, 2.25G, and 3G.

NVMe Firmware Source

This feature determines which type of the NVMe firmware should be used in your system. The options are **Vendor Defined Firmware** and AMI Native Support.

VGA Priority

This feature selects the graphics device to be used as the primary video display for system boot. The options are Auto, **Onboard** and Offboard.

CPU1 Slot 1 PCI-E 3.0 x8 OPROM/CPU2 Slot 2 PCI-E 3.0 x16 OPROM/CPU1 Slot 3 PCI-E 3.0 x8 OPROM/CPU2 Slot 4 PCI-E 3.0 x16 OPROM/CPU2 Slot 5 PCI-E 3.0 x16 OPROM/CPU1 Slot 6 PCI-E 3.0 x8 OPROM/CPU1 Slot 7 PCI-E 3.0 x8 OPROM/M.2-C1 3.0 x4 OPROM/M.2-C2 3.0 x4 OPROM

Select EFI to allow the user to boot the computer using an EFI (Expansible Firmware Interface) device installed on the PCI-E slot specified by the user. Select Legacy to allow the user to boot the computer using a legacy device installed on the PCI-E slot specified by the user. The options are Disabled, **Legacy** and EFI. (**Note:** Riser card names may differ in each system.)

Onboard LAN Device

Select Enable to use onboard LAN devices for internet connections. The options are Disabled and **Enable**.

Onboard LAN Option ROM Type

Use this feature to select the firmware type to be used for onboard LAN ports for system boot. The options are **Legacy** and EFI.

Onboard LAN1 Option ROM

Use this feature to select the type of device to be installed in LAN Port1 used for system boot. The options are **PXE**, iSCSI, and Disabled.

Onboard LAN2 Option ROM

Use this feature to select the type of device to be installed in LAN Port2 used for system boot. The options are PXE and **Disabled**.

Onboard Video Option ROM

Use this feature to select the Onboard Video Option ROM type. The options are Disabled, **Legacy** and EFI.

▶Network Stack Configuration

Network Stack

Select Enabled to enable PXE (Preboot Execution Environment) or UEFI (Unified Extensible Firmware Interface) for network stack support. The options are **Enabled** and Disabled.

If "Network Stack" is set to Enabled, the following items will display:

Ipv4 PXE Support

Select Enabled to enable Ipv4 PXE boot support. If this feature is disabled, it will not create the Ipv4 PXE boot option. The options are Disabled and **Enabled**.

Ipv4 HTTP Support

Select Enabled to enable Ipv4 HTTP boot support. If this feature is disabled, it will not create the Ipv4 HTTP boot option. The options are Enabled and **Disabled**.

Ipv6 PXE Support

Select Enabled to enable Ipv6 PXE boot support. If this feature is disabled, it will not create the Ipv6 PXE boot option. The options are Disabled and **Enabled**.

Ipv6 HTTP Support

Select Enabled to enable Ipv6 HTTP boot support. If this feature is disabled, it will not create the Ipv6 HTTP boot option. The options are Enabled and **Disabled**.

PXE Boot Wait Time

Use this feature to select the wait time to press the <ESC> key to abort the PXE boot. The default is **0**.

Media Detect Time

Use this feature to select the wait time in seconds for the BIOS ROM to detect the LAN media (Internet connection or LAN port). The default is **1**.

▶Super IO Configuration

Super IO Chip AST2500

▶Serial Port 1 Configuration

Serial Port 1

Select Enabled to enable the onboard serial port specified by the user. The options are **Enabled** and Disabled.

Device Settings

This feature displays the base I/O port address and the Interrupt Request address of a serial port specified by the user.

Note: This item is hidden when Serial Port 1 is set to Disabled.

Change Settings

This feature specifies the base I/O port address and the Interrupt Request address of Serial Port 1. Select **Auto** for the BIOS to automatically assign the base I/O and IRQ address to a serial port specified.

The options for Serial Port 1 are **Auto**, (IO=3F8h; IRQ=4), (IO=3F8h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12), (IO=2F8h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12); (IO=3E8h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12), and (IO=2E8h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12).

▶Serial Port 2 Configuration

Serial Port 2

Select Enabled to enable the onboard serial port specified by the user. The options are **Enabled** and Disabled.

Device Settings

This feature displays the base I/O port address and the Interrupt Request address of a serial port specified by the user.

Note: This item is hidden when Serial Port 1 is set to Disabled.

Change Settings

This feature specifies the base I/O port address and the Interrupt Request address of Serial Port 2. Select Auto for the BIOS to automatically assign the base I/O and IRQ address to a serial port specified. The options for Serial Port 2 are **Auto**, (IO=2F8h; IRQ=3), (IO=3F8h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12), (IO=2F8h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12); (IO=3E8h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12), and (IO=2E8h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12).

Serial Port 2 Attribute

Select SOL to use COM Port 2 as a Serial_Over_LAN (SOL) port for console redirection. The options are COM and **SOL**.

▶Serial Port Console Redirection

COM 1 Console Redirection

Select Enabled to enable COM Port 1 for Console Redirection, which will allow a client machine to be connected to a host machine at a remote site for networking. The options are Enabled and **Disabled**.

**If the item above set to Enabled, the following items will become available for configuration:*

▶Console Redirection Settings (when COM1 Console Redirection is Enabled)

Terminal Type

Use this feature to select the target terminal emulation type for Console Redirection. Select VT100 to use the ASCII Character set. Select VT100+ to add color and function key support. Select ANSI to use the Extended ASCII Character Set. Select VT-UTF8 to use UTF8 encoding to map Unicode characters into one or more bytes. The options are ANSI, VT100, **VT100+**, and VT-UTF8.

Bits Per second

Use this feature to set the transmission speed for a serial port used in Console Redirection. Make sure that the same speed is used in the host computer and the client computer. A lower transmission speed may be required for long and busy lines. The options are 9600, 19200, 38400, 57600 and **115200** (bits per second).

Data Bits

Use this feature to set the data transmission size for Console Redirection. The options are 7 (Bits) and **8 (Bits)**.

Parity

A parity bit can be sent along with regular data bits to detect data transmission errors. Select Even if the parity bit is set to 0, and the number of 1's in data bits is even. Select Odd if the parity bit is set to 0, and the number of 1's in data bits is odd. Select None if you do not want to send a parity bit with your data bits in transmission. Select Mark to add a mark as a parity bit to be sent along with the data bits. Select Space to add a Space as a parity bit to be sent with your data bits. The options are **None**, Even, Odd, Mark and Space.

Stop Bits

A stop bit indicates the end of a serial data packet. Select 1 Stop Bit for standard serial data communication. Select 2 Stop Bits if slower devices are used. The options are **1** and 2.

Flow Control

Use this feature to set the flow control for Console Redirection to prevent data loss caused by buffer overflow. Send a "Stop" signal to stop sending data when the receiving buffer is full. Send a "Start" signal to start sending data when the receiving buffer is empty. The options are **None** and Hardware RTS/CTS.

VT-UTF8 Combo Key Support

Select Enabled to enable VT-UTF8 Combination Key support for ANSI/VT100 terminals. The options are **Enabled** and Disabled**.**

Recorder Mode

Select Enabled to capture the data displayed on a terminal and send it as text messages to a remote server. The options are **Disabled** and Enabled.

Resolution 100x31

Select Enabled for extended-terminal resolution support. The options are Disabled and **Enabled**.

Legacy OS Redirection Resolution

Use this feature to select the number of rows and columns used in Console Redirection for legacy OS support. The options are **80x24** and 80x25.

Putty KeyPad

This feature selects Function Keys and KeyPad settings for Putty, which is a terminal emulator designed for the Windows OS. The options are **VT100**, LINUX, XTERMR6, SCO, ESCN, and VT400.

Redirection After BIOS Post

Use this feature to enable or disable legacy Console Redirection after BIOS POST. When the option-Bootloader is selected, legacy Console Redirection is disabled before booting the OS. When the option-Always Enable is selected, legacy Console Redirection remains enabled upon OS bootup. The options are **Always Enable** and Bootloader.

SOL (Serial-Over-LAN)/COM2

Console Redirection (for SOL/COM2)

Select Enabled to use the SOL port for Console Redirection. The options are **Enabled** and Disabled.

**If the item above set to Enabled, the following items will become available for user's configuration:*

▶Console Redirection Settings (for SOL/COM2)

Use this feature to specify how the host computer will exchange data with the client computer, which is the remote computer used by the user.

Terminal Type

Use this feature to select the target terminal emulation type for Console Redirection. Select VT100 to use the ASCII Character set. Select VT100+ to add color and function key support. Select ANSI to use the Extended ASCII Character Set. Select VT-UTF8 to use UTF8 encoding to map Unicode characters into one or more bytes. The options are ANSI, VT100, **VT100+**, and VT-UTF8.

Bits Per second

Use this feature to set the transmission speed for a serial port used in Console Redirection. Make sure that the same speed is used in the host computer and the client computer. A lower transmission speed may be required for long and busy lines. The options are 9600, 19200, 38400, 57600 and **115200** (bits per second).

Data Bits

Use this feature to set the data transmission size for Console Redirection. The options are 7 (Bits) and **8 (Bits)**.

Parity

A parity bit can be sent along with regular data bits to detect data transmission errors. Select Even if the parity bit is set to 0, and the number of 1's in data bits is even. Select Odd if the parity bit is set to 0, and the number of 1's in data bits is odd. Select None if you do not want to send a parity bit with your data bits in transmission. Select Mark to add a mark as a parity bit to be sent along with the data bits. Select Space to add a Space as a parity bit to be sent with your data bits. The options are **None**, Even, Odd, Mark and Space.

Stop Bits

A stop bit indicates the end of a serial data packet. Select 1 Stop Bit for standard serial data communication. Select 2 Stop Bits if slower devices are used. The options are **1** and 2.

Flow Control

Use this feature to set the flow control for Console Redirection to prevent data loss caused by buffer overflow. Send a "Stop" signal to stop sending data when the receiving buffer is full. Send a "Start" signal to start data-sending when the receiving buffer is empty. The options are **None** and Hardware RTS/CTS.

VT-UTF8 Combo Key Support

Select Enabled to enable VT-UTF8 Combination Key support for ANSI/VT100 terminals. The options are **Enabled** and Disabled**.**

Recorder Mode

Select Enabled to capture the data displayed on a terminal and send it as text messages to a remote server. The options are **Disabled** and Enabled.

Resolution 100x31

Select Enabled for extended-terminal resolution support. The options are Disabled and **Enabled**.

Legacy OS Redirection Resolution

Use this feature to select the number of rows and columns used in Console Redirection for legacy OS support. The options are **80x24** and 80x25.

Putty KeyPad

This feature selects Function Keys and KeyPad settings for Putty, which is a terminal emulator designed for the Windows OS. The options are **VT100**, LINUX, XTERMR6, SCO, ESCN, and VT400.

Redirection After BIOS Post

Use this feature to enable or disable legacy Console Redirection after BIOS POST (Power-On Self-Test). When this feature is set to Bootloader, legacy Console Redirection is disabled before booting the OS. When this feature is set to Always Enable, legacy Console Redirection remains enabled upon OS boot. The options are **Always Enable** and Bootloader.

▶Legacy Console Redirection Settings

Legacy Console Redirection Settings

Use the feature to select the COM port to display redirection of Legacy OS and Legacy OPROM messages. The default setting is **COM1**.

Serial Port for Out-of-Band Management/Windows Emergency Management Services (EMS)

The submenu allows the user to configure Console Redirection settings to support Out-of-Band Serial Port management.

Console Redirection (for EMS)

Select Enabled to use a COM port selected by the user for EMS Console Redirection. The options are **Disabled** and Enabled.

**If the item above set to Enabled, the following items will become available for user's configuration:*

▶EMS Console Redirection Settings

Out-of-Band Management Port

The feature selects a serial port in a client server to be used by the Windows Emergency Management Services (EMS) to communicate with a remote host server. The options are **COM1 (Console Redirection)** and COM2/SOL (Console Redirection).

Terminal Type

Use this feature to select the target terminal emulation type for Console Redirection. Select VT100 to use the ASCII character set. Select VT100+ to add color and function key support. Select ANSI to use the extended ASCII character set. Select VT-UTF8 to use UTF8 encoding to map Unicode characters into one or more bytes. The options are ANSI, VT100, VT100+, and **VT-UTF8**.

Bits Per Second

This feature sets the transmission speed for a serial port used in Console Redirection. Make sure that the same speed is used in both host computer and the client computer. A lower transmission speed may be required for long and busy lines. The options are 9600, 19200, 57600, and **115200** (bits per second).

Flow Control

Use this feature to set the flow control for Console Redirection to prevent data loss caused by buffer overflow. Send a "Stop" signal to stop data-sending when the receiving buffer is full. Send a "Start" signal to start data-sending when the receiving buffer is empty. The options are **None,** Hardware RTS/CTS, and Software Xon/Xoff.

The setting for each these features is displayed:

Data Bits, Parity, Stop Bits

▶ACPI Settings

Use this feature to configure Advanced Configuration and Power Interface (ACPI) power management settings for your system.

NUMA Support (Available when the OS supports this feature)

Select Enabled to enable Non-Uniform Memory Access support to enhance system performance. The options are **Enabled** and Disabled.

WHEA Support

Select Enabled to support the Windows Hardware Error Architecture (WHEA) platform and provide a common infrastructure for the system to handle hardware errors within the Windows OS environment to reduce system crashes and to enhance system recovery and health monitoring. The options are **Enabled** and Disabled.

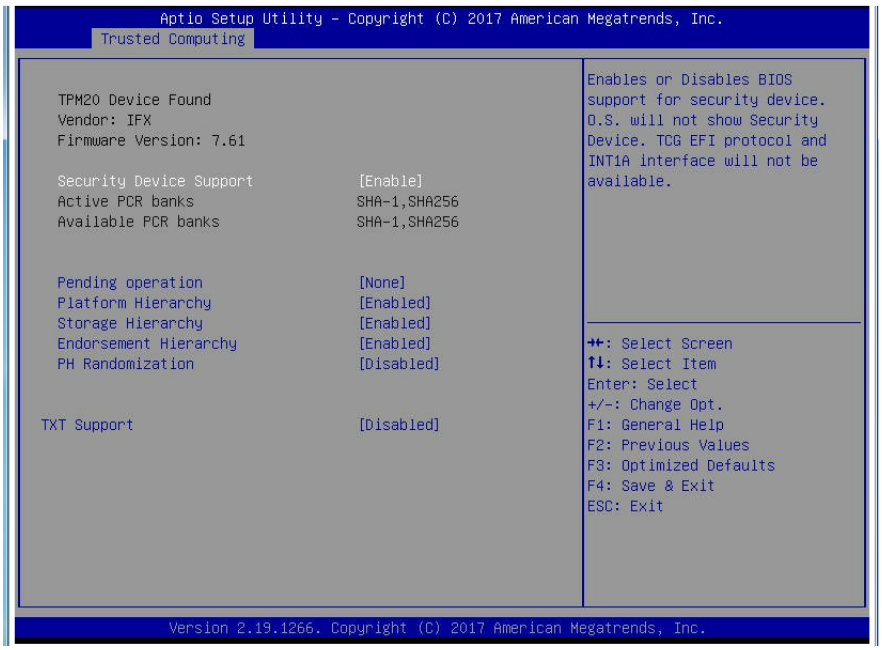
High Precision Timer

Select Enabled to activate the High Precision Event Timer (HPET) that produces periodic interrupts at a much higher frequency than a Real-time Clock (RTC) does in synchronizing multimedia streams, providing smooth playback and reducing the dependency on other timestamp calculation devices, such as an x86 RDTSC Instruction embedded in the CPU. The High Performance Event Timer is used to replace the 8254 Programmable Interval Timer. The options are **Enabled** and Disabled.

▶Trusted Computing (Available when a TPM device is installed and detected by the BIOS)

When a TPM (Trusted-Platform Module) device is detected in your machine, the following information will be displayed.

- TPM2.0 Device Found
- Vendor
- Firmware Version



Security Device Support

If this feature and the TPM jumper (JPT1) on the motherboard are both enabled, the onboard security (TPM) device will be enabled in the BIOS to enhance data integrity and system security. Please note that the OS will not show the security device. Neither TCG EFI protocol nor INT1A interaction will be made available for use. If you have made changes on the setting on this item, be sure to reboot the system for the change to take effect. The options are Disable and **Enable**. If this option is set to Enable, the following screen and items will display:

- Active PCR Banks
- Available PCR Banks

Pending Operation

Use this feature to schedule a TPM-related operation to be performed by a security (TPM) device at the next system boot to enhance system data integrity. Your system will reboot to carry out a pending TPM operation. The options are **None** and TPM Clear.

Note: Your system will reboot to carry out a pending TPM operation.

Platform Hierarchy (for TPM Version 2.0 and above)

Select Enabled for TPM Platform Hierarchy support which will allow the manufacturer to utilize the cryptographic algorithm to define a constant key or a fixed set of keys to be used for initial system boot. This early boot code is shipped with the platform and is included in the list of "public keys". During system boot, the platform firmware uses this trusted public key to verify a digital signature in an attempt to manage and control the security of the platform firmware used in a host system via a TPM device. The options are **Enabled** and Disabled.

Storage Hierarchy

Select Enabled for TPM Storage Hierarchy support that is intended to be used for non-privacy-sensitive operations by the platform owner such as an IT professional or the end user. Storage Hierarchy has an owner policy and an authorization value, both of which can be set and are held constant (-rarely changed) through reboots. This hierarchy can be cleared or changed independently of the other hierarchies. The options are **Enabled** and Disabled.

Endorsement Hierarchy

Select Enabled for Endorsement Hierarchy support, which contains separate controls to address the user's privacy concerns because the primary keys in this hierarchy are certified by the TPM or a manufacturer to be constrained to an authentic TPM device that is attached to an authentic platform. A primary key can be an encrypted, and a certificate can be created using TPM2_ ActivateCredential. It allows the user to independently enable "flag, policy, and authorization value" without involving other hierarchies. A user with privacy concerns can disable the endorsement hierarchy while still using the storage hierarchy for TPM applications and permitting the platform software to use the TPM. The options are **Enabled** and Disabled.

PH (Platform Hierarchy) Randomization (for TPM Version 2.0 and above)

Select Enabled for Platform Hierarchy Randomization support, which is used only during the platform developmental stage. This feature cannot be enabled in the production platforms. The options are **Disabled** and Enabled.

TXT Support

Select Enabled to enable Intel Trusted Execution Technology (TXT) support to enhance system security and data integrity. The options are **Disabled** and Enabled.

Note 1: If the option for this item (TXT Support) is set to Enabled, be sure to disable EV DFX (Device Function On-Hide) support for the system to work properly. (EV DFX is under "IIO Configuration" in the "Chipset/North Bridge" submenu).

Note 2: For more information on TPM, please refer to the TPM manual at http://www.supermicro.com/manuals/other.

▸iSCSi Configuration

iSCSI Initiator Name

This feature allows the user to enter the unique name of the iSCSI Initiator in IQN format. Once the name of the iSCSI Initiator is entered into the system, configure the proper settings for the following items.

▸Add an Attempt

▸Delete Attempts

▸Change Attempt order

▶Intel® Virtual RAID on CPU

When this submenu is selected and the RAID devices are detected, the BIOS screen displays the following items:

Intel® VROC with VMD Technology 5.2.0.1023

6.4 Event Logs

Use this feature to configure Event Log settings.

▶Change SMBIOS Event Log Settings

Enabling/Disabling Options

SMBIOS Event Log

Select Enabled to enable SMBIOS (System Management BIOS) Event Logging during system boot. The options are **Enabled** and Disabled.

Erasing Settings

Erase Event Log

Select Enabled to erase all error events in the SMBIOS (System Management BIOS) log before an event logging is initialized at bootup. The options are **No**, Yes, Next Reset, and Yes, Next Reset.

When Log is Full

Select Erase Immediately to immediately erase all errors in the SMBIOS event log when the event log is full. Select Do Nothing for the system to do nothing when the SMBIOS event log is full. The options are **Do Nothing** and Erase Immediately.

SMBIOS Event Log Standard Settings

Log System Boot Event

Select Enabled to log system boot events. The options are Enabled and **Disabled**.

MECI (Multiple Event Count Increment)

Enter the increment value for the multiple event counter. Enter a number between 1 to 255. The default setting is **1**.

METW (Multiple Event Count Time Window)

Use this feature to determine how long (in minutes) the multiple event counter should wait before generating a new event log. Enter a number between 0 to 99. The default setting is **60**.

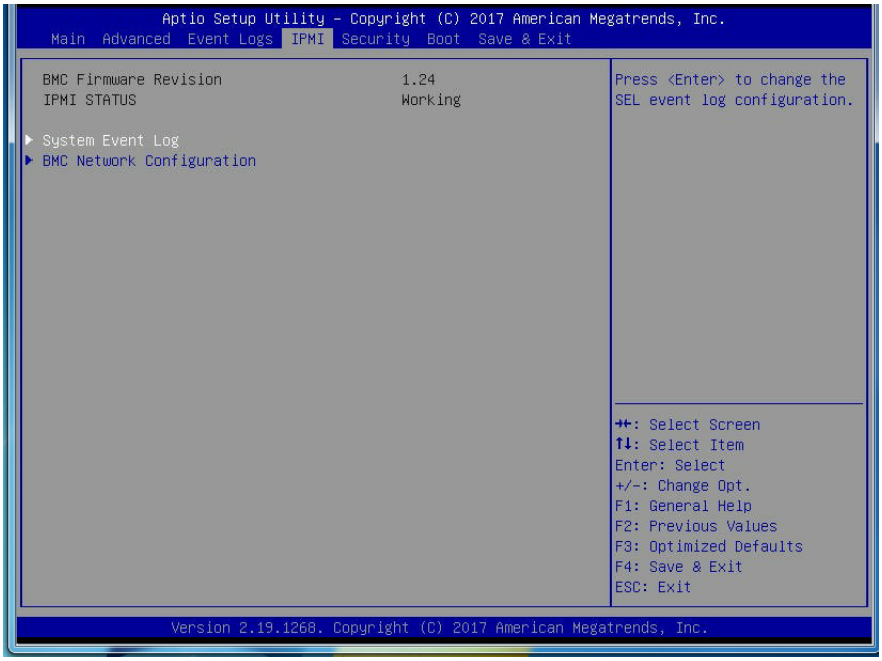
Note: Please reboot the system for the changes to take effect.

▶View System Event Log

This item allows the user to view the event in the system event log. Select this feature and press <Enter> to view the status of an event in the log. The following categories are displayed: **Date/Time/Error Code/Severity**

6.5 IPMI

Use this feature to configure Intelligent Platform Management Interface (IPMI) settings.



When you select this submenu and press the <Enter> key, the following information will display:

- BMC Firmware Revision: This feature indicates the IPMI firmware revision used in your system.
- IPMI Status: This feature indicates IPMI status of your system.

▶System Event Log

Enabling/Disabling Options

SEL Components

Select Enabled for all system event logging at bootup. The options are **Enabled** and Disabled.

Erasing Settings

Erase SEL

Select Yes, On next reset to erase all system event logs upon next system reboot. Select Yes, On every reset to erase all system event logs upon each system reboot. Select No to keep all system event logs after each system reboot. The options are **No,** Yes, On next reset, and Yes, On every reset.

When SEL is Full

This feature allows the user to determine what the BIOS should do when the system event log is full. Select Erase Immediately to erase all events in the log when the system event log is full. The options are **Do Nothing** and Erase Immediately.

▶BMC Network Configuration

The following items will be displayed:

- IPMI LAN Selection: This feature displays the IPMI LAN setting. The default setting is **Failover**.
- IPMI Network Link Status: This item displays the IPMI Network Link status. The default setting is **Dedicated LAN**.
- Update IPMI LAN Configuration: Select Yes for the BIOS to implement all IP/MAC address changes at the next system boot. The default setting is **No**.
- Current Configuration Address Source: This feature displays the source of the current IPMI LAN address. The default setting is **DHCP (Dynamic Host Configuration Protocol)**.
- Station IP Address: This feature displays the Station IP address for this computer. This should be in decimal and in dotted quad form (i.e., 192.168.10.253).
- Subnet Mask: This feature displays the sub-network that this computer belongs to. The value of each three-digit number separated by dots should not exceed 255.
- Station MAC Address: This feature displays the Station MAC address for this computer. Mac addresses are 6 two-digit hexadecimal numbers.
- Gateway IP Address: This feature displays the Gateway IP address for this computer. This should be in decimal and in dotted quad form (i.e., 192.168.10.253).
- VLAN: Select Enabled to enable IPMI VLAN support. The options are **Enabled** and Disabled.
- LAN Channel 1

IPV6 Support

Select Enabled for IPV6 support. The options are **Enabled** and Disabled.

Configuration Address Source

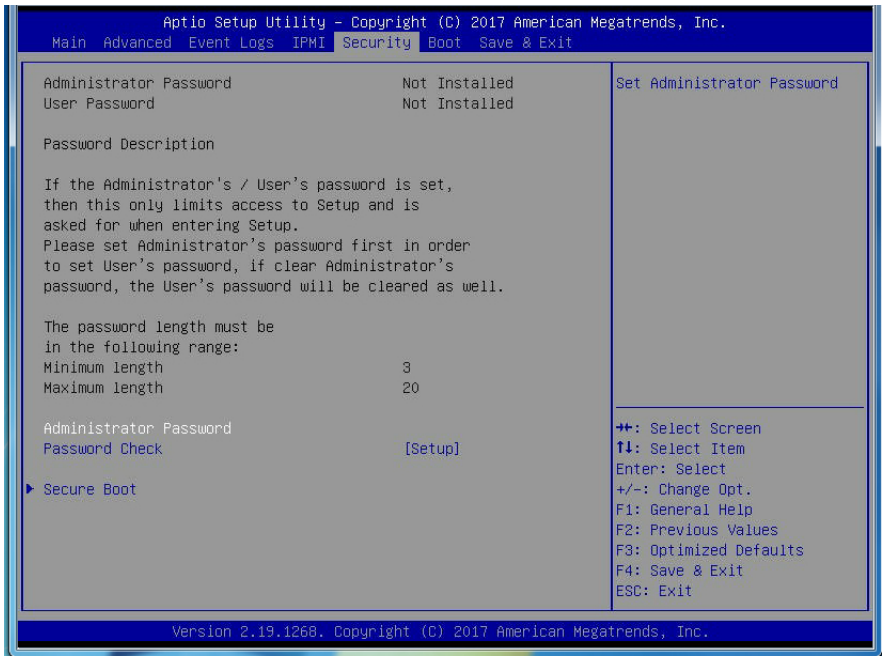
Use this feature to select the IP address source for this computer. If Static is selected, you will need to know the IP address of this computer and enter it to the system manually in the field. If DHCP is selected, AMI BIOS will search for a DHCP (Dynamic Host Configuration Protocol) server attached to the network and request the next available IP address for this computer. The options are **Unspecified**, DHCP and Static.

The following features will be displayed:

- Current Configuration Address Source
- Station IPV6 Address
- Prefix Length
- IPV6 Router1 IP Address
- IPV6 Address Status
- IPV6 DHCP Algorithm

6.6 Security Settings

This menu allows the user to configure the following security settings for the system.



Administrator Password

Use this feature to set the administrator password which is required to enter the BIOS setup utility. The length of the password should be from 3 characters to 20 characters long.

User Password

Use this feature to set the user password which is required to enter the BIOS setup utility. The length of the password should be from 3 characters to 20 characters long.

Password Check

Select Setup for the system to check for a password at Setup. Select Always for the system to check for a password at bootup or upon entering the BIOS Setup utility. The options are **Setup** and Always.

▸Secure Boot

When you select this submenu and press the <Enter> key, the following items will display:

- System Mode
- Secure Boot
- Vendor Keys

Secure Boot

If this feature is set to Enabled, Secure Boot will be activated when a Platform Key (PK) is entered. A Platform Key is a security key used to manage the security settings of the platform firmware used in your system. The options are Enabled and **Disabled.**

Secure Boot Mode

Use this feature to select the desired secure boot mode for the system. The options are Standard and **Custom**.

CMS Support

Select Enbabled for CMS support to enhance system performance. The options are **Enabled** and Disabled.

▸Key Management

Provision Factory Default Keys

Select Enabled to install all manufacturer default keys to configure the following system security settings. The options are Enabled and **Disabled**.

▸Enroll All Factor Defaults

Select Yes to install all manufacturer defaults to configure the following system security settings. The options are **Yes** and No.

▸Enroll EFI Image

Select this item and press <Enter> to select an EFI (Extensible Firmware Interface) image for the system to operate in Secure Boot mode.

▸Save All Secure Boot Variables

This feature allows the user to set and save the secure boot key variables specified by the user.

▸Platform Key (PK)

This feature allows the user to enter and configure a set of values to be used as a platform firmware key for the system. This set of values also indicate the size, the keys numbers, and the key source of the Platform Key. The options are **Save to File**, Set New, and Erase.

▸Key Exchange Keys

This feature allows the user to enter and configure a set of values to be used as a Key-Exchange-Keys for the system. This set of values also indicate the size, the keys numbers, and the key source of the Key-Exchange-Keys. The options are **Save to File**, Set New, and Erase.

▸Authorized Signatures

This feature allows the user to enter and configure a set of values to be used as Authorized Signatures for the system. These values also indicate the size, the keys numbers, and the key source of the Authorized Signatures. The options are **Set New** and Append.

Secure Boot Variable/Size/Key#/Key Sources The options are **Save to File**, Set New, and Erase.

▸Forbidden Signatures

This feature allows the user to enter and configure a set of values to be used as Forbidden Signatures for the system. These values also indicate the size, the keys numbers, and the key source of the Forbidden Signatures. The options are **Save to File**, Set New, and Erase.

▸Authorized TimeStamps

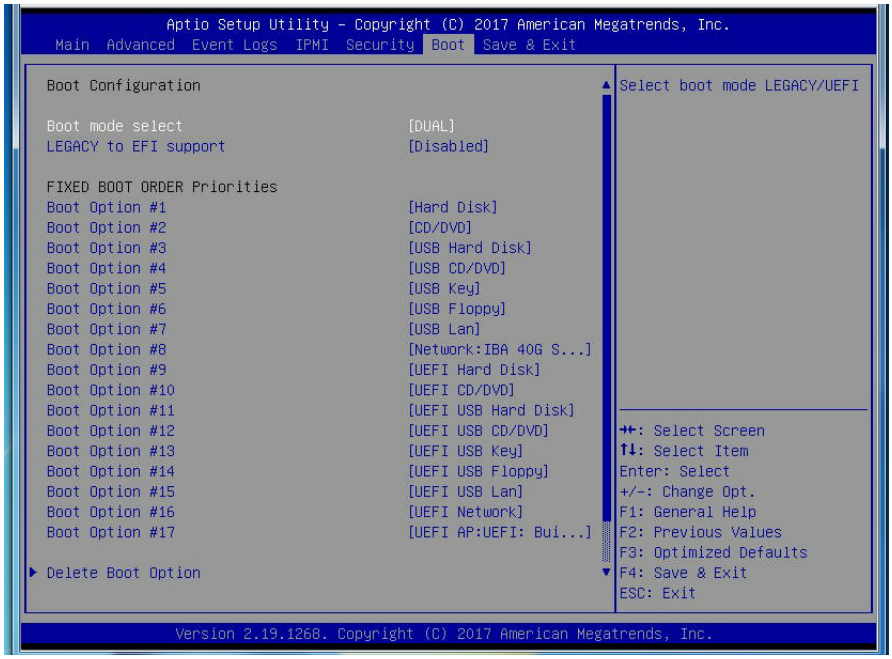
This feature allows the user to set and save the timestamps for Authorized Signatures to indicate when these signatures were entered into the system. The options are **Save to File**, Set New, and Erase.

▸OsRecovery Signatures

This feature allows the user to set and save the Authorized Signatures used for OS recovery. The options are **Save to File**, Set New, and Erase.

6.7 Boot Settings

Use this feature to configure Boot Settings:



Boot Mode Select

Use this feature to select the type of devices to be used for system boot. The options are Legacy, UEFI (Unified Extensible Firmware Interface), and **Dual.**

Legacy to EFI Support

Select Enabled for the system to boot from an EFI OS when the Legacy OS fails. The options are Enabled and **Disabled**.

Fixed Boot Order Priorities

This feature prioritizes the order of a bootable device from which the system will boot. Press <Enter> on each entry from top to bottom to select devices.

When the item above -"Boot Mode Select" is set to **Dual** (default), the following items will be displayed for configuration:

- Boot Option #1 - Boot Option #17

When the item above -"Boot Mode Select" is set to Legacy, the following items will be display for configuration:

- Boot Option #1 - Boot Option #8

When the item above -"Boot Mode Select" is set to UEFI, the following items will be display for configuration:

- Boot Option #1 - Boot Option #9

Add New Boot Option

This feature allows the user to add a new boot option to the boot priority features for your system.

Add Boot Option

Use this feature to specify the name for the new boot option.

Path for Boot Option

Use this feature to enter the path for the new boot option in the format fsx:\path\filename.efi.

Boot Option File Path

Use this feature to specify the file path for the new boot option.

Create

After the name and the file path for the boot option are set, press <Enter> to create the new boot option in the boot priority list.

▶Delete Boot Option

Use this feature to select a boot device to delete from the boot priority list.

Delete Boot Option

Use this feature to remove an EFI boot option from the boot priority list.

▶Add New Driver Option

Use this feature to select a new driver to add to the boot priority list.

Add Driver Option

Use this feature to specify the name of the driver that the new boot option is added to.

Path for Drover Option

Use this feature to specify the path to the driver that the new boot option is added to.

Driver Option File Path

Use this feature to specify the file path of the driver that the new boot option is added to.

Create

After the driver option name and the file path are set, press <Enter> to enter to submenu and click OK to create the new boot option drive.

▶Delete Driver Option

Use this item to select a boot driver to delete from the boot priority list.

Delete Drive Option
Select the target boot driver to delete from the boot priority list.

▶Hard Disk Drive BBS Priorities
- Boot Option #1 - #5

▶Network Drive BBS Priorities
- Boot Option #1

▶USB Key Drive BBS Priorities
- Boot Option #1

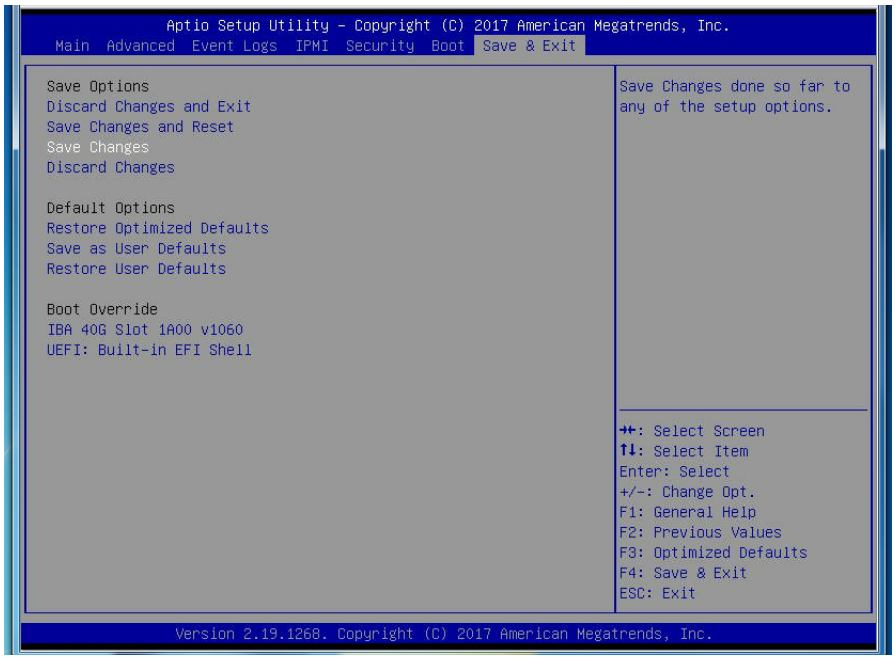
▶UEFI Hard Disk Drive BBS Priorities
- Boot Option #1

▶UEFI USB Key Drive BBS Priorities
- Boot Option #1

▶UEFI Application Boot Priorities
- Boot Option #1

6.8 Save & Exit

Select the Save & Exit tab from the BIOS setup screen to configure the settings below.



Save Options

Discard Changes and Exit

Select this option to quit the BIOS setup without making any permanent changes to the system configuration and reboot the computer. Select Discard Changes and Exit from the Exit menu and press <Enter>.

Save Changes and Reset

When you have completed the system configuration changes, select this option to leave the BIOS setup utility and reboot the computer for the new system configuration parameters to take effect. Select Save Changes and Exit from the Exit menu and press <Enter>.

Save Changes

When you have completed the system configuration changes, select this option to save all changes made. This will not reset (reboot) the system.

Discard Changes

Select this option and press <Enter> to discard all the changes and return to the AMI BIOS setup utility.

Default Options

Restore Optimized Defaults

To set this feature, select Restore Defaults from the Exit menu and press <Enter> to load manufacturer default settings which are intended for maximum system performance but not for maximum stability.

Save As User Defaults

To set this feature, select Save as User Defaults from the Exit menu and press <Enter>. This enables the user to save any changes to the BIOS setup for future use.

Restore User Defaults

To set this feature, select Restore User Defaults from the Exit menu and press <Enter>. Use this feature to retrieve user-defined settings that were saved previously.

Boot Override

This feature allows the user to override the Boot priorities sequence in the Boot menu, and immediately boot the system with a device specified by the user instead of the one specified in the boot list. This is a one-time override.

Appendix A

BIOS Codes

A.1 BIOS Error POST (Beep) Codes

During the POST (Power-On Self-Test) routines, which are performed each time the system is powered on, errors may occur.

Non-fatal errors are those which, in most cases, allow the system to continue the boot-up process. The error messages normally appear on the screen.

Fatal errors are those which will not allow the system to continue the boot-up procedure. If a fatal error occurs, you should consult with your system manufacturer for possible repairs.

These fatal errors are usually communicated through a series of audible beeps. The table shown below lists some common errors and their corresponding beep codes encountered by users.

BIOS Beep (POST) Codes		
Beep Code	**Error Message**	**Description**
1 beep	Refresh	Circuits have been reset (Ready to power up)
5 short, 1 long	Memory error	No memory detected in system
5 long, 2 short	Display memory read/write error	Video adapter missing or with faulty memory
1 long continuous	System OH	System overheat condition

A.2 Additional BIOS POST Codes

The AMI BIOS supplies additional checkpoint codes, which are documented online at http://www.supermicro.com/support/manuals/ ("AMI BIOS POST Codes User's Guide").

When BIOS performs the Power On Self Test, it writes checkpoint codes to I/O port 0080h. If the computer cannot complete the boot process, a diagnostic card can be attached to the computer to read I/O port 0080h (Supermicro p/n AOC-LPC80-20).

For information on AMI updates, please refer to http://www.ami.com/products/.

Appendix B

Standardized Warning Statements for AC Systems

B.1 About Standardized Warning Statements

The following statements are industry standard warnings, provided to warn the user of situations which have the potential for bodily injury. Should you have questions or experience difficulty, contact Supermicro's Technical Support department for assistance. Only certified technicians should attempt to install or configure components.

Read this appendix in its entirety before installing or configuring components in the Supermicro chassis.

These warnings may also be found on our website at http://www.supermicro.com/about/policies/safety_information.cfm.

Warning Definition

Warning! This warning symbol means danger. You are in a situation that could cause bodily injury. Before you work on any equipment, be aware of the hazards involved with electrical circuitry and be familiar with standard practices for preventing accidents.

警告の定義

この警告サインは危険を意味します。

人身事故につながる可能性がありますので、いずれの機器でも動作させる前に、

電気回路に含まれる危険性に注意して、標準的な事故防止策に精通して下さい。

此警告符号代表危险。

您正处于可能受到严重伤害的工作环境中。在您使用设备开始工作之前，必须充分意识到触电的危险，并熟练掌握防止事故发生的标准工作程序。请根据每项警告结尾的声明号码找到此设备的安全性警告说明的翻译文本。

此警告符號代表危險。

您目前所處的工作環境可能讓您受傷。在您使用任何設備之前，請注意觸電的危險，並且要熟悉預防事故發生的標準工作程序。請依照每一注意事項後的號碼找到相關的翻譯說明內容。

Warnung

WICHTIGE SICHERHEITSHINWEISE

Dieses Warnsymbol bedeutet Gefahr. Sie befinden sich in einer Situation, die zu Verletzungen führen kann. Machen Sie sich vor der Arbeit mit Geräten mit den Gefahren elektrischer Schaltungen und den üblichen Verfahren zur Vorbeugung vor Unfällen vertraut. Suchen Sie mit der am Ende jeder Warnung angegebenen Anweisungsnummer nach der jeweiligen Übersetzung in den übersetzten Sicherheitshinweisen, die zusammen mit diesem Gerät ausgeliefert wurden.

BEWAHREN SIE DIESE HINWEISE GUT AUF.

INSTRUCCIONES IMPORTANTES DE SEGURIDAD

Este símbolo de aviso indica peligro. Existe riesgo para su integridad física. Antes de manipular cualquier equipo, considere los riesgos de la corriente eléctrica y familiarícese con los procedimientos estándar de prevención de accidentes. Al final de cada advertencia encontrará el número que le ayudará a encontrar el texto traducido en el apartado de traducciones que acompaña a este dispositivo.

GUARDE ESTAS INSTRUCCIONES.

IMPORTANTES INFORMATIONS DE SÉCURITÉ

Ce symbole d'avertissement indique un danger. Vous vous trouvez dans une situation pouvant entraîner des blessures ou des dommages corporels. Avant de travailler sur un équipement, soyez conscient des dangers liés aux circuits électriques et familiarisez-vous avec les procédures couramment utilisées pour éviter les accidents. Pour prendre connaissance des traductions des avertissements figurant dans les consignes de sécurité traduites qui accompagnent cet appareil, référez-vous au numéro de l'instruction situé à la fin de chaque avertissement.

CONSERVEZ CES INFORMATIONS.

תקנון הצהרות אזהרה

הצהרות הבאות הן אזהרות על פי תקני התעשייה, על מנת להזהיר את המשתמש מפני חבלה פיזית אפשרית. במידה ויש שאלות או היתקלות בבעיה כלשהי, יש ליצור קשר עם מחלקת תמיכה טכנית של סופרמיקרו. טכנאים מוסמכים בלבד רשאים להתקין או להגדיר את הרכיבים.

יש לקרוא את הנספח במלואו לפני התקנת או הגדרת הרכיבים במארזי סופרמיקרו.

ا كً ف حالة وٌكي أى تتسبب ف اصابة جسد ةٌ هذا الزهز عٌ خطز !تحذ زٌ .
قبل أى تعول على أي هعذات،كي على علن بالوخاطز ال ٱجوة عي الذوائز
الكهزبائ ةٍ
وكي على درا ةٌ بالووارسات البقائ ةٍ لو عٌ وقع أي حادث
استخذم رقن الب إٍى الو صٌص ف هًا ةٌ كل تحذ زٌ للعشر تزجوتها

안전을 위한 주의사항

경고!

이 경고 기호는 위험이 있음을 알려 줍니다. 작업자의 신체에 부상을 야기 할 수 있는 상태에 있게 됩니다. 모든 장비에 대한 작업을 수행하기 전에 전기회로와 관련된 위험요소들을 확인하시고 사전에 사고를 방지할 수 있도록 표준 작업절차를 준수해 주시기 바랍니다.

해당 번역문을 찾기 위해 각 경고의 마지막 부분에 제공된 경고문 번호를 참조하십시오

BELANGRIJKE VEILIGHEIDSINSTRUCTIES

Dit waarschuwings symbool betekent gevaar. U verkeert in een situatie die lichamelijk letsel kan veroorzaken. Voordat u aan enige apparatuur gaat werken, dient u zich bewust te zijn van de bij een elektrische installatie betrokken risico's en dient u op de hoogte te zijn van de standaard procedures om ongelukken te voorkomen. Gebruik de nummers aan het eind van elke waarschuwing om deze te herleiden naar de desbetreffende locatie.

BEWAAR DEZE INSTRUCTIES

Installation Instructions

Warning! Read the installation instructions before connecting the system to the power source.

設置手順書

システムを電源に接続する前に、設置手順書をお読み下さい。

警告

将此系统连接电源前,请先阅读安装说明。

警告

將系統與電源連接前，請先閱讀安裝說明。

Warnung

Vor dem Anschließen des Systems an die Stromquelle die Installationsanweisungen lesen.

¡Advertencia!

Lea las instrucciones de instalación antes de conectar el sistema a la red de alimentación.

Attention

Avant de brancher le système sur la source d'alimentation, consulter les directives d'installation.

יש לקרוא את הוראות התקנה לפני חיבור המערכת למקור מתח.

اقر إرشادات التركيب قبل توصيل النظام إلى مصدر للطاقة

시스템을 전원에 연결하기 전에 설치 안내를 읽어주십시오.

Waarschuwing

Raadpleeg de installatie-instructies voordat u het systeem op de voedingsbron aansluit.

Circuit Breaker

Warning! This product relies on the building's installation for short-circuit (overcurrent) protection. Ensure that the protective device is rated not greater than: 250 V, 20 A.

サーキット・ブレーカー

この製品は、短絡（過電流）保護装置がある建物での設置を前提としています。

保護装置の定格が250 V、20 Aを超えないことを確認下さい。

警告

此产品的短路(过载电流)保护由建筑物的供电系统提供,确保短路保护设备的额定电流不大于250V,20A。

警告

此產品的短路(過載電流)保護由建築物的供電系統提供,確保短路保護設備的額定電流不大於250V,20A。

Warnung

Dieses Produkt ist darauf angewiesen, dass im Gebäude ein Kurzschluss- bzw. Überstromschutz installiert ist. Stellen Sie sicher, dass der Nennwert der Schutzvorrichtung nicht mehr als: 250 V, 20 A beträgt.

¡Advertencia!

Este equipo utiliza el sistema de protección contra cortocircuitos (o sobrecorrientes) del edificio. Asegúrese de que el dispositivo de protección no sea superior a: 250 V, 20 A.

Attention

Pour ce qui est de la protection contre les courts-circuits (surtension), ce produit dépend de l'installation électrique du local. Vérifiez que le courant nominal du dispositif de protection n'est pas supérieur à :250 V, 20 A.

מוצר זה מסתמך על הגנה המותקנת במבנים למניעת קצר חשמלי. יש לוודא כי
המכשיר המגן מפני הקצר החשמלי הוא לא יותר מ-250VDC, 20A

هذا المنتج يعتمد على معداث الحمايت مه الدوائرالقصيرة التي تم تثبيتها في
المبنى
تأكد من أن تقييم الجهاز الوقائي ليس أكثر من : 20A, 250V

경고!

이 제품은 전원의 단락(과전류)방지에 대해서 전적으로 건물의 관련 설비에 의존합니다.
보호장치의 정격이 반드시 250V(볼트), 20A(암페어)를 초과하지 않도록 해야 합니다.

Waarschuwing

Dit product is afhankelijk van de kortsluitbeveiliging (overspanning) van uw electrische installatie. Controleer of het beveiligde aparaat niet groter gedimensioneerd is dan 250V, 20A.

Power Disconnection Warning

Warning! The system must be disconnected from all sources of power and the power cord removed from the power supply module(s) before accessing the chassis interior to install or remove system components.

電源切断の警告

システムコンポーネントの取り付けまたは取り外しのために、シャーシー内部にアクセスするには、システムの電源はすべてのソースから切断され、電源コードは電源モジュールから取り外す必要があります。

警告

在你打开机箱并安装或移除内部器件前,必须将系统完全断电,并移除电源线。

警告

在您打開機殼安裝或移除內部元件前，必須將系統完全斷電，並移除電源線。

Warnung

Das System muss von allen Quellen der Energie und vom Netzanschlusskabel getrennt sein, das von den Spg.Versorgungsteilmodulen entfernt wird, bevor es auf den Chassisinnenraum zurückgreift, um Systemsbestandteile anzubringen oder zu entfernen.

¡Advertencia!

El sistema debe ser disconnected de todas las fuentes de energía y del cable eléctrico quitado de los módulos de fuente de alimentación antes de tener acceso el interior del chasis para instalar o para quitar componentes de sistema.

Attention

Le système doit être débranché de toutes les sources de puissance ainsi que de son cordon d'alimentation secteur avant d'accéder à l'intérieur du chassis pour installer ou enlever des composants de systéme.

אזהרה מפני ניתוק חשמלי

!אזהרה

יש לנתק את המערכת מכל מקורות החשמל ויש להסיר את כבל החשמלי מהספק

.לפני גישה לחלק הפנימי של המארז לצורך התקנת או הסרת רכיבים

يجب فصم انتظاو من جميع مصادر انطاقت وإزانت سهك انكهرباء من وحدة امداد
انطاقت قبم
انصل إنى اىمناطق انداخهيت نههيكم نتثبيج أو إزانت مكناث الجهاز

경고!

시스템에 부품들을 장착하거나 제거하기 위해서는 섀시 내부에 접근하기 전에 반드시 전원 공급장치로부터 연결되어있는 모든 전원과 전기코드를 분리해주어야 합니다.

Waarschuwing

Voordat u toegang neemt tot het binnenwerk van de behuizing voor het installeren of verwijderen van systeem onderdelen, dient u alle spanningsbronnen en alle stroomkabels aangesloten op de voeding(en) van de behuizing te verwijderen

Equipment Installation

Warning! Only trained and qualified personnel should be allowed to install, replace, or service this equipment.

機器の設置

トレーニングを受け認定された人だけがこの装置の設置、交換、またはサービスを許可されています。

警告

只有经过培训且具有资格的人员才能进行此设备的安装、更换和维修。

警告

只有經過受訓且具資格人員才可安裝、更換與維修此設備。

Warnung

Das Installieren, Ersetzen oder Bedienen dieser Ausrüstung sollte nur geschultem, qualifiziertem Personal gestattet werden.

¡Advertencia!

Solamente el personal calificado debe instalar, reemplazar o utilizar este equipo.

Attention

Il est vivement recommandé de confier l'installation, le remplacement et la maintenance de ces équipements à des personnels qualifiés et expérimentés.

אזהרה!

צוות מוסמך בלבד רשאי להתקין, להחליף את הציוד או לתת שירות עבור הציוד.

والمدربيه لتزكيب واستبدال أو خدمة هذا الجهاس يجب أن يسمح فقط للمظفيه المؤهليه

경고!

훈련을 받고 공인된 기술자만이 이 장비의 설치, 교체 또는 서비스를 수행할 수 있습니다.

Waarschuwing

Deze apparatuur mag alleen worden geïnstalleerd, vervangen of hersteld door geschoold en gekwalificeerd personeel.

Restricted Area

Warning! This unit is intended for installation in restricted access areas. A restricted access area can be accessed only through the use of a special tool, lock and key, or other means of security. (This warning does not apply to workstations).

アクセス制限区域

このユニットは、アクセス制限区域に設置されることを想定しています。

アクセス制限区域は、特別なツール、鍵と錠前、その他のセキュリティの手段を用いてのみ出入りが可能です。

警告

此部件应安装在限制进出的场所，限制进出的场所指只能通过使用特殊工具、锁和钥匙或其它安全手段进出的场所。

警告

此裝置僅限安裝於進出管制區域，進出管制區域係指僅能以特殊工具、鎖頭及鑰匙或其他安全方式才能進入的區域。

Warnung

Diese Einheit ist zur Installation in Bereichen mit beschränktem Zutritt vorgesehen. Der Zutritt zu derartigen Bereichen ist nur mit einem Spezialwerkzeug, Schloss und Schlüssel oder einer sonstigen Sicherheitsvorkehrung möglich.

¡Advertencia!

Esta unidad ha sido diseñada para instalación en áreas de acceso restringido. Sólo puede obtenerse acceso a una de estas áreas mediante la utilización de una herramienta especial, cerradura con llave u otro medio de seguridad.

Attention

Cet appareil doit être installée dans des zones d'accès réservés. L'accès à une zone d'accès réservé n'est possible qu'en utilisant un outil spécial, un mécanisme de verrouillage et une clé, ou tout autre moyen de sécurité.

אזור עם גישה מוגבלת

אזהרה!

יש להתקין את היחידה באזורים שיש בהם הגבלת גישה. הגישה ניתנת בעזרת
'כלי אבטחה בלבד)מפתח, מנעול וכד.)

تخصيص هذه انحذة نترك بُها ف مناطق محظورة تم .
،مَكن انصبل إن منطقت محظورة فقط من خلال استخذاو أداة خاصت
أو أ وس هُت أخري نلالأمما قفم ومفتاح

경고!

이 장치는 접근이 제한된 구역에 설치하도록 되어있습니다. 특수도구, 잠금 장치 및 키, 또는 기타 보안 수단을 통해서만 접근 제한 구역에 들어갈 수 있습니다.

Waarschuwing

Dit apparaat is bedoeld voor installatie in gebieden met een beperkte toegang. Toegang tot dergelijke gebieden kunnen alleen verkregen worden door gebruik te maken van speciaal gereedschap, slot en sleutel of andere veiligheidsmaatregelen.

Battery Handling

Warning! There is the danger of explosion if the battery is replaced incorrectly. Replace the battery only with the same or equivalent type recommended by the manufacturer. Dispose of used batteries according to the manufacturer's instructions

電池の取り扱い

電池交換が正しく行われなかった場合、破裂の危険性があります。交換する電池はメーカーが推奨する型、または同等のものを使用下さい。使用済電池は製造元の指示に従って処分して下さい。

警告

电池更换不当会有爆炸危险。请只使用同类电池或制造商推荐的功能相当的电池更换原有电池。请按制造商的说明处理废旧电池。

警告

電池更換不當會有爆炸危險。請使用製造商建議之相同或功能相當的電池更換原有電池。請按照製造商的說明指示處理廢棄舊電池。

Warnung

Bei Einsetzen einer falschen Batterie besteht Explosionsgefahr. Ersetzen Sie die Batterie nur durch den gleichen oder vom Hersteller empfohlenen Batterietyp. Entsorgen Sie die benutzten Batterien nach den Anweisungen des Herstellers.

Attention

Danger d'explosion si la pile n'est pas remplacée correctement. Ne la remplacer que par une pile de type semblable ou équivalent, recommandée par le fabricant. Jeter les piles usagées conformément aux instructions du fabricant.

¡Advertencia!

Existe peligro de explosión si la batería se reemplaza de manera incorrecta. Reemplazar la batería exclusivamente con el mismo tipo o el equivalente recomendado por el fabricante. Desechar las baterías gastadas según las instrucciones del fabricante.

!אזהרה

קיימת סכנת פיצוץ של הסוללה במידה והוחלפה בדרך לא תקינה. יש להחליף
את הסוללה בסוג התואם מחברת יצרן מומלצת.
סילוק הסוללות המשומשות יש לבצע לפי הוראות היצרן.

هناك خطر من انفجار في حالة اسحبذال البطارية بطريقة غير صحيحة فعليل
اسحبذال البطارية
فقط بنفس النبع أو ما يعادلها مما أوصث به الشرمة المصنعة
جخلص من البطاريات المسحعملة وفقا لحعليمات الشرمة الصانعة

경고!

배터리가 올바르게 교체되지 않으면 폭발의 위험이 있습니다. 기존 배터리와 동일하거나 제조사에서 권장하는 동등한 종류의 배터리로만 교체해야 합니다. 제조사의 안내에 따라 사용된 배터리를 처리하여 주십시오.

Waarschuwing

Er is ontploffingsgevaar indien de batterij verkeerd vervangen wordt. Vervang de batterij slechts met hetzelfde of een equivalent type die door de fabrikant aanbevolen wordt. Gebruikte batterijen dienen overeenkomstig fabrieksvoorschriften afgevoerd te worden.

Redundant Power Supplies

Warning! This unit might have more than one power supply connection. All connections must be removed to de-energize the unit.

冗長電源装置

このユニットは複数の電源装置が接続されている場合があります。

ユニットの電源を切るためには、すべての接続を取り外さなければなりません。

警告
此部件连接的电源可能不止一个，必须将所有电源断开才能停止给该部件供电。

警告
此裝置連接的電源可能不只一個，必須切斷所有電源才能停止對該裝置的供電。

Warnung

Dieses Gerät kann mehr als eine Stromzufuhr haben. Um sicherzustellen, dass der Einheit kein trom zugeführt wird, müssen alle Verbindungen entfernt werden.

¡Advertencia!

Puede que esta unidad tenga más de una conexión para fuentes de alimentación. Para cortar por completo el suministro de energía, deben desconectarse todas las conexiones.

Attention

Cette unité peut avoir plus d'une connexion d'alimentation. Pour supprimer toute tension et tout courant électrique de l'unité, toutes les connexions d'alimentation doivent être débranchées.

אם קיים יותר מספק אחד

אזהרה!

ליחדה יש יותר מחיבור אחד של ספק. יש להסיר את כל החיבורים על מנת לרוקן את היחידה.

قد يكون لهذا الجهاز عدة اتصالات بوحدات امداد الطاقة .

يجب إزالة كافة الاتصالات لعسل الوحدة عن الكهرباء

경고!

이 장치에는 한 개 이상의 전원 공급 단자가 연결되어 있을 수 있습니다. 이 장치에 전원을 차단하기 위해서는 모든 연결 단자를 제거해야만 합니다.

Waarschuwing

Deze eenheid kan meer dan één stroomtoevoeraansluiting bevatten. Alle aansluitingen dienen verwijderd te worden om het apparaat stroomloos te maken.

Backplane Voltage

Warning! Hazardous voltage or energy is present on the backplane when the system is operating. Use caution when servicing.

バックプレーンの電圧

システムの稼働中は危険な電圧または電力が、バックプレーン上にかかっています。

修理する際には注意ください。

警告

当系统正在进行时，背板上有很危险的电压或能量，进行维修时务必小心。

警告

當系統正在進行時，背板上有危險的電壓或能量，進行維修時務必小心。

Warnung

Wenn das System in Betrieb ist, treten auf der Rückwandplatine gefährliche Spannungen oder Energien auf. Vorsicht bei der Wartung.

¡Advertencia!

Cuando el sistema está en funcionamiento, el voltaje del plano trasero es peligroso. Tenga cuidado cuando lo revise.

Attention

Lorsque le système est en fonctionnement, des tensions électriques circulent sur le fond de panier. Prendre des précautions lors de la maintenance.

מתח בפנל האחורי

אזהרה!

קיימת סכנת מתח בפנל האחורי בזמן תפעול המערכת. יש להיזהר במהלך העבודה.

هناك خطر مه التيار الكهزبائي أوالطاقة المجبدة على اللحة
عندما يكن النظام يعمل كه حذرا عند خدمة هذا الجهاس

경고!
시스템이 동작 중일 때 후면판 (Backplane)에는 위험한 전압이나 에너지가 발생 합니다. 서비스 작업 시 주의하십시오.

Waarschuwing
Een gevaarlijke spanning of energie is aanwezig op de backplane wanneer het systeem in gebruik is. Voorzichtigheid is geboden tijdens het onderhoud.

Comply with Local and National Electrical Codes

Warning! Installation of the equipment must comply with local and national electrical codes.

地方および国の電気規格に準拠

機器の取り付けはその地方および国の電気規格に準拠する必要があります。

警告
设备安装必须符合本地与本国电气法规。

警告
設備安裝必須符合本地與本國電氣法規。

Warnung
Die Installation der Geräte muss den Sicherheitsstandards entsprechen.

¡Advertencia!
La instalacion del equipo debe cumplir con las normas de electricidad locales y nacionales.

Attention
L'équipement doit être installé conformément aux normes électriques nationales et locales.

תיאום חוקי החשמל הארצי
אזהרה!
התקנת הציוד חייבת להיות תואמת לחוקי החשמל המקומיים והארציים.

تركيب المعدات الكهربائية يجب أن يمتثل للقاويه المحلية والبطية المتعلقة
بالكهرباء

경고!
현 지역 및 국가의 전기 규정에 따라 장비를 설치해야 합니다.

Waarschuwing
Bij installatie van de apparatuur moet worden voldaan aan de lokale en nationale elektriciteitsvoorschriften.

Product Disposal

Warning! Ultimate disposal of this product should be handled according to all national laws and regulations.

製品の廃棄
この製品を廃棄処分する場合、国の関係する全ての法律・条例に従い処理する必要があります。

警告
本产品的废弃处理应根据所有国家的法律和规章进行。

警告
本產品的廢棄處理應根據所有國家的法律和規章進行。

Warnung
Die Entsorgung dieses Produkts sollte gemäß allen Bestimmungen und Gesetzen des Landes erfolgen.

¡Advertencia!
Al deshacerse por completo de este producto debe seguir todas las leyes y reglamentos nacionales.

Attention

La mise au rebut ou le recyclage de ce produit sont généralement soumis à des lois et/ou directives de respect de l'environnement. Renseignez-vous auprès de l'organisme compétent.

סילוק המוצר

אזהרה!

סילוק סופי של מוצר זה חייב להיות בהתאם להנחיות וחוקי המדינה.

التخلص النهائي من هذا المنتج ينبغي التعامل معه وفقا لجميع القانين واللائح البطنية عند

경고!

이 제품은 해당 국가의 관련 법규 및 규정에 따라 폐기되어야 합니다.

Waarschuwing

De uiteindelijke verwijdering van dit product dient te geschieden in overeenstemming met alle nationale wetten en reglementen.

Hot Swap Fan Warning

Warning! Hazardous moving parts. Keep away from moving fan blades. The fans might still be turning when you remove the fan assembly from the chassis. Keep fingers, screwdrivers, and other objects away from the openings in the fan assembly's housing.

ファン・ホットスワップの警告

警告!回転部品に注意。運転中は回転部(羽根)に触れないでください。シャーシから冷却ファン装置を取り外した際、ファンがまだ回転している可能性があります。ファンの開口部に、指、ドライバー、およびその他のものを近づけないで下さい。

警告!

警告！危险的可移动性零件。请务必与转动的风扇叶片保持距离。 当您从机架移除风扇装置，风扇可能仍在转动。小心不要将手指、螺丝起子和其他物品太靠近风扇

警告

危險的可移動性零件。請務必與轉動的風扇葉片保持距離。 當您從機架移除風扇裝置，風扇可能仍在轉動。小心不要將手指、螺絲起子和其他物品太靠近風扇。

Warnung

Gefährlich Bewegende Teile. Von den bewegenden Lüfterblätter fern halten. Die Lüfter drehen sich u. U. noch, wenn die Lüfterbaugruppe aus dem Chassis genommen wird. Halten Sie Finger, Schraubendreher und andere Gegenstände von den Öffnungen des Lüftergehäuses entfernt.

¡Advertencia!

Riesgo de piezas móviles. Mantener alejado de las aspas del ventilador. Los ventiladores podran dar vuelta cuando usted quite ell montaje del ventilador del chasis. Mandtenga los dedos, los destornilladores y todos los objetos lejos de las aberturas del ventilador

Attention

Pieces mobiles dangereuses. Se tenir a l'ecart des lames du ventilateur Il est possible que les ventilateurs soient toujours en rotation lorsque vous retirerez le bloc ventilateur du châssis. Prenez garde à ce que doigts, tournevis et autres objets soient éloignés du logement du bloc ventilateur.

אזהרה!

חלקים נעים מסוכנים. התרחק מלהבי המאוורר בפעולהכאשר מסירים את חלקי
המאוורר מהמארז, יתכן והמאוררים עדיין עובדים. יש להרחיק למרחק בטוח את
האצבעות וכלי עבודה שונים מהפתחים בתוך המאוורר

تحذير! أجزاء متحركة خطرة. ابتعد عن شفرات المروحة المتحركة.من الممكن أن
المراوح لا تزال تدورعند إزالة كتلة المروحة من الهيكل يجب إبقاء الأصابع
.ومفكات البراغي وغيرها من الأشياء بعيدا عن الفتحات في كتلة المروحة

경고!

움직이는 위험한 부품. 회전하는 송풍 날개에 접근하지 마세요. 섀시로부터 팬 조립품을 제거할 때 팬은 여전히 회전하고 있을 수 있습니다. 팬 조림품 외관의 열려있는 부분들로부터 손가락 및 스크류드라이버, 다른 물체들이 가까이 하지 않도록 배치해 주십시오.

Waarschuwing

Gevaarlijk bewegende onderdelen. Houd voldoende afstand tot de bewegende ventilatorbladen. Het is mogelijk dat de ventilator nog draait tijdens het verwijderen van het ventilatorsamenstel uit het chassis. Houd uw vingers, schroevendraaiers en eventuele andere voorwerpen uit de buurt van de openingen in de ventilatorbehuizing.

Power Cable and AC Adapter

Warning! When installing the product, use the provided or designated connection cables, power cables and AC adaptors. Using any other cables and adaptors could cause a malfunction or a fire. Electrical Appliance and Material Safety Law prohibits the use of UL or CSA -certified cables (that have UL/CSA shown on the code) for any other electrical devices than products designated by Supermicro only.

電源コードとACアダプター

製品を設置する場合、提供または指定および購入された接続ケーブル、電源コードとACアダプターを 該当する地域の条例や安全基準に適合するコードサイズやプラグと共に使用下さい。他のケーブルやアダプタを使用すると故障や火災の原因になることがあります。

電気用品安全法は、ULまたはCSA認定のケーブル(UL/CSEマークがコードに表記)を Supermicroが指定する製品以外に使用することを禁止しています。

警告

安装此产品时,请使用本身提供的或指定的或采购的连接线,电源线和电源适配器，包含遵照当地法规和安全要求的合规的电源线尺寸和插头.使用其它线材或适配器可能会引起故障或火灾。除了Supermicro所指定的产品,电气用品和材料安全法律规定禁止
使用未经UL或CSA认证的线材。(线材上会显示UL/CSA符号)。

警告

安裝此產品時,請使用本身提供的或指定的或採購的連接線,電源線和電源適配器，包含遵照當地法規和安全要求的合規的電源線尺寸和插頭.使用其它線材或適配器可能會引起故障或火災。除了Supermicro所指定的產品,電氣用品和材料安全法律規定禁止
使用未經UL或CSA認證的線材。 (線材上會顯示UL/CSA符號)。

Warnung

Nutzen Sie beim Installieren des Produkts ausschließlich die von uns zur Verfügung gestellten Verbindungskabeln, Stromkabeln und/oder Adapater, die Ihre örtlichen Sicherheitsstandards einhalten. Der Gebrauch von anderen Kabeln und Adapter können Fehlfunktionen oder Feuer verursachen. Die Richtlinien untersagen das Nutzen von UL oder CAS zertifizierten Kabeln (mit UL/CSA gekennzeichnet), an Geräten oder Produkten die nicht mit Supermicro gekennzeichnet sind.

¡Advertencia!

Cuando instale el producto, utilice la conexión provista o designada o procure cables, Cables de alimentación y adaptadores de CA que cumplan con los códigos locales y los requisitos de seguridad, incluyendo el tamaño adecuado del cable y el enchufe. El uso de otros cables y adaptadores podría causar un mal funcionamiento o un incendio. La Ley de Seguridad de Aparatos Eléctricos y de Materiales prohíbe El uso de cables certificados por UL o CSA (que tienen el certificado UL / CSA en el código) para cualquier otros dispositivos eléctricos que los productos designados únicamente por Supermicro.

Attention

Lors de l'installation du produit, utilisez les cables de connection fournis ou désigné ou achetez des cables, cables de puissance et adaptateurs respectant les normes locales et les conditions de securite y compris les tailles de cables et les prises electriques appropries. L'utilisation d'autres cables et adaptateurs peut provoquer un dysfonctionnement ou un incendie. Appareils électroménagers et la Loi sur la Sécurité Matériel interdit l'utilisation de câbles certifies- UL ou CSA (qui ont UL ou CSA indiqué sur le code) pour tous les autres appareils électriques sauf les produits désignés par Supermicro seulement.

AC ימאתמו סיילמשח סילבכ

!הרהזא

רזוצל ומאתוה וא ושכרנ רשא AC סימאתמו סיקפס ,סילבכב שמתשהל שי ,רצומה תא סיניקתמ רשאכ לכב שומיש . עקתהו לבכה לש הנוכנ הדימ ללוכ ,תוימוקמה תוחיטבה תושירדל ומאתוה רשאו ,הנקתהה למשחה יריש כמב שומישה יקוחל סאתהב .ילמשח רצק וא הלקתל סורגל לולע ,רחא גוסמ סאתמ וא לבכ לש דוק סהילע עיפומ רשאכ) CSA-ב וא UL -ב סיכמסומה סילבכב שמתשהל רוסיא סייק ,תוחיטבה יקוחו .דבלב Supermicro י"ע סאתוה רשא רצומב קר אלא ,רחא ילמשח רצומ לכ רובע UL/CSA)

عند تركيب المنتج، قم باستخدام التوصيلات المتوفرة أو المحددة أو قم بشراء الكابلات الكهربائية ومحولات التيار المتردد مع الالتزام بقوانين ومتطلبات السلامة المحلية بما في ذلك حجم الموصل والقابس السليم. استخدام أي كابلات ومحولات أخرى قد يتسبب في عطل أو حريق. يحظر قانون السلامة للأجهزة الكهربائية والمعدات استخدام الكابلات المعتمدة من قبل UL أو CSA والتي تحمل علامة (UL/CSA) مع أي معدات أخرى غير المنتجات المعينة والمحددة من قبل Supermicro.

전원 케이블 및 AC 어댑터

경고! 제품을 설치할 때 현지 코드 및 적절한 굵기의 코드와 플러그를 포함한 안전 요구 사항을 준수하여 제공되거나 지정된 연결 혹은 구매 케이블, 전원 케이블 및 AC 어댑터를 사용하십시오.

다른 케이블이나 어댑터를 사용하면 오작동이나 화재가 발생할 수 있습니다. 전기 용품 안전법은 UL 또는 CSA 인증 케이블 (코드에 UL / CSA가 표시된 케이블)을 Supermicro 가 지정한 제품 이외의 전기 장치에 사용하는 것을 금지합니다.

Stroomkabel en AC-Adapter

Waarschuwing! Bij het aansluiten van het Product uitsluitend gebruik maken van de geleverde Kabels of een andere geschikte aan te schaffen Aansluitmethode, deze moet altijd voldoen aan de lokale voorschriften en veiligheidsnormen, inclusief de juiste kabeldikte en stekker. Het gebruik van niet geschikte Kabels en/of Adapters kan een storing of brand veroorzaken. Wetgeving voor Elektrische apparatuur en Materiaalveiligheid verbied het gebruik van UL of CSA -gecertificeerde Kabels (met UL/CSA in de code) voor elke andere toepassing dan de door Supermicro hiervoor beoogde Producten.

Appendix C

System Specifications

Processors

Dual Intel® Xeon® 81xx/61xx/51xx/41xx/31xx and 82xx/62xx/52xx/42xx/32xx series processors in a Socket P type socket
Note: Please refer to the motherboard specifications pages on our website for updates to supported processors.

Chipset

Intel C622 chipset

BIOS

256 Mb AMI® Flash ROM

Memory

Sixteen DIMM slots support up to 4 TB of Registered DIMM (RDIMM), Load Reduced DIMM (LRDIMM), 3D LRDIMM or Non-Volatile DIMM (NV-DIMM) DDR4-2933/2666 MHz speed ECC memory
Note: See the memory section in Chapter 3 for details and our website for updates to supported memory.

SATA Controller

On-chip (Intel C622) controller

Drive Bays

Supports up to 12 hot-swap 3.5" hard drives

PCI Expansion Slots

Four PCI-Express 3.0 x8 slots supported by CPU1 (Slots 1, 3, 6, 7)
Three PCI-Express 3.0 x16 slots supported by CPU2 (Slots 2, 4, 5)

Motherboard

X11DPH-T; E-ATX form factor (W x L) 13" x 12" (330 mm x 305 mm)

Chassis

SC829HE1C4-R1K62LPB; 2U Rackmount, (WxHxD) 17.2 x 3.5 x 25.5 in. (437 x 89 x 647-mm)

System Cooling

Three 8-cm counter-rotating hot-swap fans, space for two optional additional fans available

Power Supply

Redundant 1600W power supply modules (PWS-1K62A-1R)
AC Input Voltages: 100-240 VAC
Rated Input Current: 100-127V: 15-12A, 200-240V: 8.5-7A
Rated Input Frequency: 50-60 Hz
Rated Output Power: 1600W
Rated Output Voltages: +12V (83A max. for 100-127A, 100A max. for 200-240A), +5Vsb (4A max.)

Operating Environment

Operating Temperature: 10º to 35º C (50º to 95º F)
Non-operating Temperature: -40º to 60º C (-40º to 140º F)
Operating Relative Humidity: 8% to 90% (non-condensing)
Non-operating Relative Humidity: 5% to 95% (non-condensing)

Regulatory Compliance

Electromagnetic Emissions: FCC Class A, EN 55032 Class A, EN 61000-3-2/3-3, CISPR 32 Class A
Electromagnetic Immunity: EN 55024/CISPR 24, (EN 61000-4-2, EN 61000-4-3, EN 61000-4-4, EN 61000-4-5, EN 61000-4-6, EN 61000-4-8, EN 61000-4-11), CNS14336-1, CNS13438, GB4943.1-2011, GB9254-2008(Class A) and GB17625.1-2012
Safety: CSA/EN/IEC/UL 60950-1 Compliant, UL or CSA Listed (USA and Canada), CE Marking (Europe)
Other: VCCI-CISPR 32 and AS/NZS CISPR 32
Environmental: Directive 2011/65/EU and Delegated Directive (EU) 2015/863 and Directive 2012/19/EU

Perchlorate Warning

California Best Management Practices Regulations for Perchlorate Materials: This Perchlorate warning applies only to products containing CR (Manganese Dioxide) Lithium coin cells. “Perchlorate Material-special handling may apply. See www.dtsc.ca.gov/hazardouswaste/perchlorate”

Appendix D

UEFI BIOS Recovery

Warning: Do not upgrade the BIOS unless your system has a BIOS-related issue. Flashing the wrong BIOS can cause irreparable damage to the system. In no event shall Supermicro be liable for direct, indirect, special, incidental, or consequential damages arising from a BIOS update. If you need to update the BIOS, do not shut down or reset the system while the BIOS is updating to avoid possible boot failure.

D.1 Overview

The Unified Extensible Firmware Interface (UEFI) provides a software-based interface between the operating system and the platform firmware in the pre-boot environment. The UEFI specification supports an architecture-independent mechanism that will allow the UEFI OS loader stored in an add-on card to boot the system. The UEFI offers clean, hands-off management to a computer during system boot.

D.2 Recovering the UEFI BIOS Image

A UEFI BIOS flash chip consists of a recovery BIOS block and a main BIOS block (a main BIOS image). The boot block contains critical BIOS codes, including memory detection and recovery codes for the user to flash a new BIOS image if the original main BIOS image is corrupted. When the system power is first turned on, the boot block codes execute first. Once this process is completed, the main BIOS code will continue with system initialization and the remaining POST (Power-On Self-Test) routines.

Note 1: Follow the BIOS recovery instructions below for BIOS recovery when the main BIOS boot crashes.

Note 2: When the BIOS boot block crashes, you will need to follow the procedures to make a Returned Merchandise Authorization (RMA) request. (For a RMA request, please see section 3.5 for more information). Also, you may use the Supermicro Update Manager (SUM) Out-of-Band (OOB) (https://www.supermicro.com.tw/products/nfo/SMS_SUM.cfm) to reflash the BIOS.

D.3 Recovering the BIOS Block with a USB Device

This feature allows the user to recover a BIOS image using a USB-attached device without additional utilities used. A USB flash device such as a USB Flash Drive, or a USB CD/DVD ROM/RW device can be used for this purpose. However, a USB Hard Disk drive cannot be used for BIOS recovery at this time.

The file system supported by UEFI is FAT (including FAT12, FAT16, and FAT32), which is installed on a bootable or non-bootable USB-attached device. However, the BIOS might need several minutes to locate the SUPER.ROM file if the media size becomes too large due to the huge volumes of folders and files stored in the device.

To perform UEFI BIOS recovery using a USB-attached device, follow the instructions below.

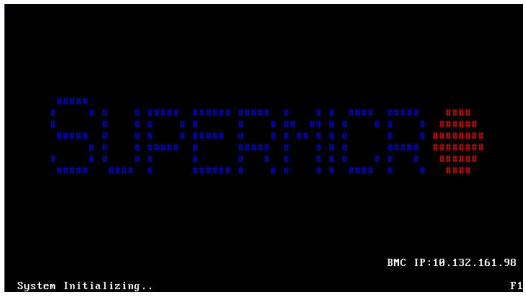
1. Using a different machine, copy the "Super.ROM" binary image file into the disc Root "\" directory of a USB device or a writable CD/DVD.

   Note: If you cannot locate the "Super.ROM" file in your driver disk, visit our website at www.supermicro.com to download the BIOS image into a USB flash device and rename it to "Super.ROM" for BIOS recovery use.

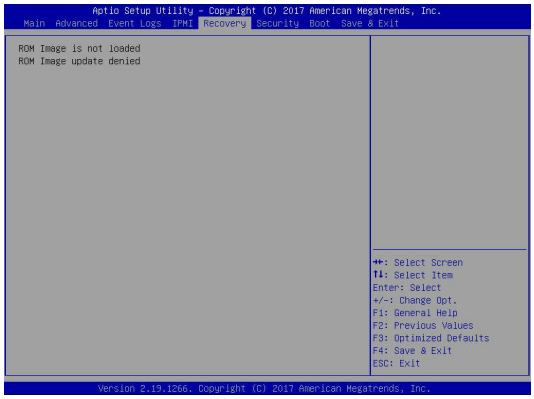
2. Insert the USB device that contains the new BIOS image ("Super.ROM") into your USB drive and power on the system

3. While powering on the system, please keep pressing <Ctrl> and <Home> simultaneously on your keyboard *until the following screen (or a screen similar to the one below) displays*.

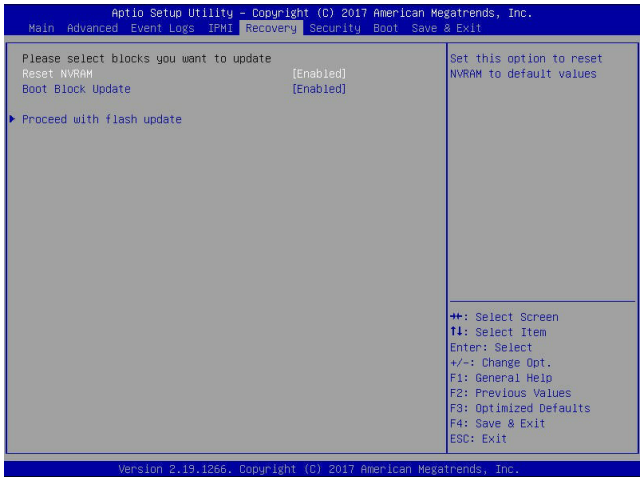
Warning: Please **stop** pressing the <Ctrl> and <Home> keys immediately when you see the screen (or a similar screen) below; otherwise, it will trigger a system reboot.



Note: On the other hand, if the following screen displays, please load the "Super. ROM" file to the root folder and connect this folder to the system. (You can do so by inserting a USB device that contains the new "Super.ROM" image to your machine for BIOS recovery.)



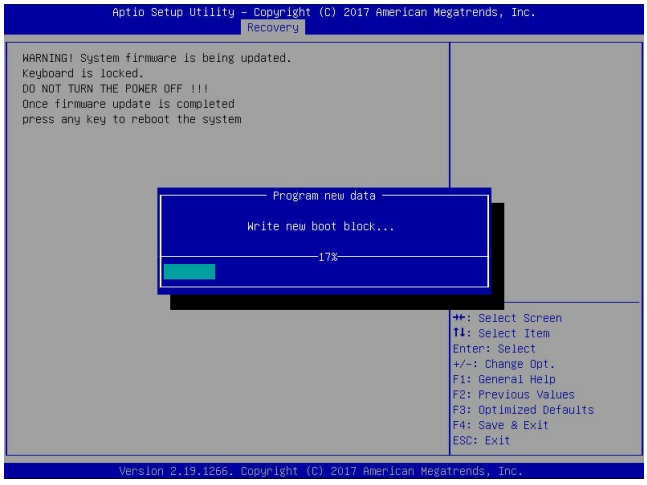
4. After locating the new BIOS binary image, the system will enter the BIOS Recovery menu as shown below.



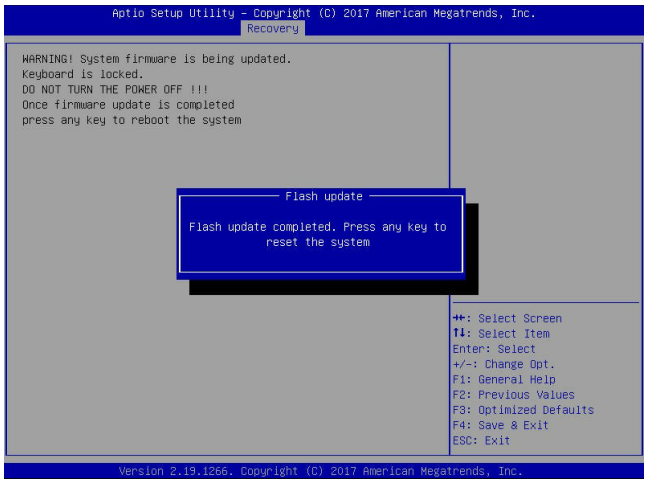
Note: At this point, you may decide if you want to start the BIOS recovery. If you decide to proceed with BIOS recovery, follow the procedures below.

5. When the screen as shown above displays, use the arrow keys to select the item "Proceed with flash update" and press the <Enter> key. You will see the BIOS recovery progress as shown in the screen below.

Note: *Do not interrupt the BIOS flashing process until it has completed*.

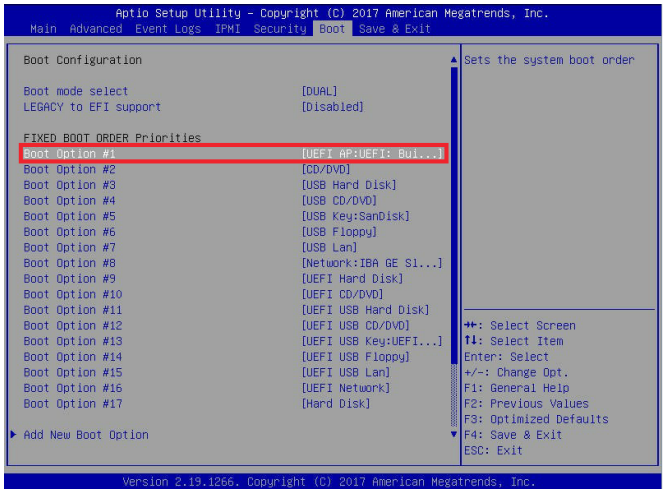


6. After the BIOS recovery process is completed, press any key to reboot the system.

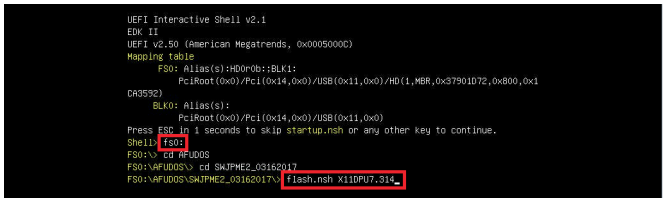


7. Using a different system, extract the BIOS package into a USB flash drive.

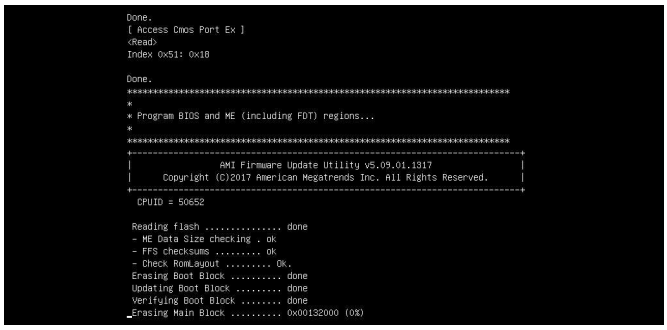
8. Press <Del> continuously during system boot to enter the BIOS setup utility. From the top of the tool bar, click on Boot and press <Enter> to enter the submenu. From the submenu list, select Boot Option #1 as shown below. Then, boot Option #1 to [UEFI AP:UEFI: Built-in EFI Shell]. Press <F4> to save the settings and exit the BIOS setup utility.



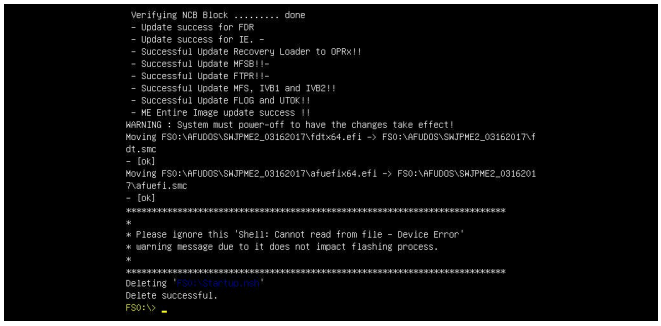
9. When the UEFI Shell prompt appears, type fs# to change the device directory path. Go to the directory that contains the BIOS package you extracted earlier from Step 7. Enter flash.nsh BIOSname.### at the prompt to start the BIOS update process.



Note: *Do not interrupt this process* until the BIOS flashing is complete.



10. The screen above indicates that the BIOS update process is completed. When you see the screen above, unplug the AC power cable from the power supply, clear CMOS, and plug the AC power cable in the power supply again to power on the system.



11. Press <Del> continuously to enter the BIOS setup utility.

12. Press <F3> to load the default settings.

13. After loading the default settings, press <F4> to save the settings and exit the BIOS setup utility.

Appendix E

BSMI RoHS

限用物質含有情況標示聲明書

Declaration of the Presence Condition of the Restricted Substances Marking

設備名稱：伺服器/ Server
Equipment name

型號（型式）：829H-X11 ，系列型號: SG-6029P-E1CR16T
Type designation (Type)

單元 Unit	Restricted substances and its chemical symbols 限用物質及其化學符號					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr^{+6})	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
機殼 (Chassis)	○	○	○	○	○	○
機殼風扇 (Chassis Fan)	-	○	○	○	○	○
線材 (Cable)	○	○	○	○	○	○
主機板 (Motherboard)	-	○	○	○	○	○
電源供應器 (Power Supply)	-	○	○	○	○	○
硬碟 (Hard Disk)	-	○	○	○	○	○
電源背板 (PDB)	-	○	○	○	○	○
附加卡 (Add-on Card)	-	○	○	○	○	○

備考1.〝超出0.1 wt %〞及〝超出0.01 wt %〞係指限用物質之百分比含量超出百分比含量基準值。
Note 1：“Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.

Note 2：“○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.
備考2.〝○〞係指該項限用物質之百分比含量未超出百分比含量基準值。

Note 3：The “–” indicates that the restricted substance corresponds to the exemption.
備考3.〝-〞係指該項限用物質為排除項目。

警告使用者：
這是甲類的資訊產品，在居住的環境中使用時，可能會造成
射頻干擾，在這種情況下，使用者會被要求採取某些適當的對策

* 輸入額定 ：

100-127V ~, 60-50Hz, 12-9A
200-240V ~, 60-50Hz, 10-8A

* 使用者不能任意拆除或替換內部配備

* 報驗義務人之姓名或名稱: